# TMS320VC5501 Fixed-Point Digital Signal Processor

# Data Manual

Literature Number: SPRS206 December 2002

PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.







#### **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third—party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Mailing Address:

Texas Instruments Post Office Box 655303 Dallas, Texas 75265

Copyright © 2002, Texas Instruments Incorporated

# **REVISION HISTORY**

| REVISION | DATE          | PRODUCT STATUS  | HIGHLIGHTS |  |  |
|----------|---------------|-----------------|------------|--|--|
| *        | December 2002 | Product Preview | Original   |  |  |

# **Contents**

| Se | ection       |                     |   | Page |  |  |  |
|----|--------------|---------------------|---|------|--|--|--|
| 1  | TMS32        | S320VC5501 Features |   |      |  |  |  |
| 2  | Introduction |                     |   |      |  |  |  |
|    | 2.1          | Descript            | ion   | 2    |  |  |  |
|    | 2.2          |                     | gnments                                     | 3    |  |  |  |
|    |              | 2.2.1               | Ball Grid Array (GGW)                       | 3    |  |  |  |
|    |              | 2.2.2               | Low-Profile Quad Flatpack (PGF)             | 5    |  |  |  |
|    | 2.3          | Signal D            | Descriptions                                | 7    |  |  |  |
| 3  | Functi       | onal Ove            | erview                                      | 17   |  |  |  |
| •  | 3.1          |                     |   | 18   |  |  |  |
|    | • • •        | 3.1.1               | On-Chip ROM                                 | 18   |  |  |  |
|    |              | 3.1.2               | On-Chip Dual-Access RAM (DARAM)             | 19   |  |  |  |
|    |              | 3.1.3               | Memory Map                                  | 20   |  |  |  |
|    |              | 3.1.4               | Boot Configuration                          | 21   |  |  |  |
|    | 3.2          | _                   | rals  | 21   |  |  |  |
|    | 3.3          | •                   | rable External Ports and Signals            | 22   |  |  |  |
|    |              | 3.3.1               | Parallel Port Mux                           | 22   |  |  |  |
|    |              | 3.3.2               | Host Port Mux                               | 24   |  |  |  |
|    |              | 3.3.3               | External Bus Selection Register (XBSR)      | 25   |  |  |  |
|    | 3.4          |                     |   | 26   |  |  |  |
|    |              | 3.4.1               | Timer Signal Selection Register (TSSR)      | 27   |  |  |  |
|    | 3.5          |                     | al Asynchronous Receiver/Transmitter (UART) | 29   |  |  |  |
|    | 3.6          |                     | egrated Circuit (I <sup>2</sup> C) Module   | 31   |  |  |  |
|    | 3.7          |                     | rt Interface (HPI)                          | 32   |  |  |  |
|    | 3.8          |                     | lemory Access (DMA) Controller              | 33   |  |  |  |
|    |              | 3.8.1               | DMA Channel 0 Control Register (DMA_CCR0)   | 33   |  |  |  |
|    | 3.9          |                     | Clock Generator                             | 35   |  |  |  |
|    |              | 3.9.1               | Input Clock Source                          | 35   |  |  |  |
|    |              | 3.9.2               | Clock Groups                                | 37   |  |  |  |
|    |              | 3.9.3               | EMIF Input Clock Selection                  | 37   |  |  |  |
|    |              | 3.9.4               | Changing the Clock Group Frequencies        | 38   |  |  |  |
|    |              | 3.9.5               | PLL Control Registers                       | 40   |  |  |  |
|    |              | 3.9.6               | Reset Sequence                              | 50   |  |  |  |
|    | 3.10         | Idle Con            | trol  | 51   |  |  |  |
|    |              | 3.10.1              | Clock Domains                               | 51   |  |  |  |
|    |              | 3.10.2              | IDLE Procedures                             | 51   |  |  |  |
|    |              | 3.10.3              | Module Behavior at Entering IDLE State      | 54   |  |  |  |
|    |              | 3.10.4              | Wake-Up Procedure                           | 55   |  |  |  |
|    |              | 3.10.5              | Auto-Wakeup/Idle Function for McBSP and DMA | 58   |  |  |  |
|    |              | 3.10.6              | Clock State of Multiplexed Modules          | 58   |  |  |  |
|    |              | 3.10.7              | IDLE Control and Status Registers           | 58   |  |  |  |
|    | 3.11         |                     | -Purpose I/O (GPIO)                         | 65   |  |  |  |
|    |              | 3.11.1              | General-Purpose I/O Port                    | 65   |  |  |  |
|    |              | 3.11.2              | Parallel Port General-Purpose I/O (PGPIO)   | 67   |  |  |  |

| Se | ection | F  |
|----|--------|--|
|    | 3.12   | External Bus Control Register  |
|    |        | 3.12.1 External Bus Control Register (XBCR)                                  |
|    | 3.13   | Internal Ports and System Registers  |
|    |        | 3.13.1 XPORT Interface   |
|    |        | 3.13.2 DPORT Interface   |
|    |        | 3.13.3 IPORT Interface   |
|    |        | 3.13.4 System Configuration Register (CONFIG)                                |
|    |        | 3.13.5 Time-Out Control Register (TOCR)                                      |
|    | 3.14   | CPU Memory-Mapped Registers  |
|    | 3.15   | Peripheral Registers   |
|    | 3.16   | Interrupts   |
|    |        | 3.16.1 IFR and IER Registers   |
|    |        | 3.16.2 Interrupt Timing  |
|    |        | 0.10.2 Interrupt rinning   |
| 4  | Docur  | nentation Support  |
| •  | Docui  | mentation dupport  |
| 5  | Dovice | e and Development-Support Tool Nomenclature                                  |
| J  | Device | s and Development-Support 1001 Nomenciature                                  |
| 6  | Electr | ical Specifications  |
| •  | 6.1    | Absolute Maximum Ratings   |
|    | 6.2    | Electrical Specifications  |
|    | 6.3    | Recommended Operating Conditions   |
|    | 6.4    | Electrical Characteristics Over Recommended Operating Case Temperature Range |
|    | 0.4    | (Unless Otherwise Noted)   |
|    | 6.5    | Package Thermal Resistance Characteristics                                   |
|    | 6.6    | Timing Parameter Symbology   |
|    | 6.7    | Clock Options  |
|    | 0      | 6.7.1 Clock Generation in Bypass Mode (APLL Disabled)                        |
|    |        | 6.7.2 Clock Generation in PLL Mode   |
|    |        | 6.7.3 EMIF Clock Options   |
|    | 6.8    | EMIF Asynchronous Memory Timing  |
|    | 6.9    | Programmable Synchronous Interface Timing                                    |
|    | 6.10   | Synchronous DRAM Timing  |
|    | 6.11   | HOLD/HOLDA Timing  |
|    | 6.12   |  |
|    | 6.13   | Reset Timings  |
|    | 6.14   | ,                                      |
|    |        | XF Timing  |
|    | 6.15   | General-Purpose Input/Output (GPIOx)Timing                                   |
|    | 6.46   | • • • • • • • • • • • • • • • • • • •  |
|    | 6.16   | Multichannel Buffered Serial Port (McBSP) Timing                             |
|    |        | 6.16.1 McBSP Transmit and Receive Timings                                    |
|    |        | 6.16.2 McBSP General-Purpose I/O Timing                                      |
|    | 0.4-   | 6.16.3 McBSP as SPI Master or Slave Timing                                   |
|    | 6.17   | HPI Timings  |
|    | 6.18   | I <sup>2</sup> C Timing  |
|    | 6.19   | UART Timing  |



SPRS206

vii

| Se | ection |   | Page |
|----|--------|---|------|
| 7  | Mech   | anical Data                               | 145  |
|    | 7.1    | Ball Grid Array Mechanical Data           | 145  |
|    | 72     | Low-Profile Ouad Flatnack Machanical Data | 1/16 |

# **List of Figures**

| Figure |  | Page |
|--------|--|------|
| 2–1    | 176-Terminal GGW Ball Grid Array (Bottom View)     | 3    |
| 2–2    | 176-Pin PGF Low-Profile Quad Flatpack (Top View)   | 5    |
| 3–1    | Block Diagram of the TMS320VC5501                  | 17   |
| 3–2    | TMS320VC5501 Memory Map                            | 20   |
| 3–3    | External Bus Selection Register Layout (0x6C00)    | 25   |
| 3–4    | Timer Signal Selection Register Layout (0x8000)    | 27   |
| 3–5    | Watchdog Timer Hook-Up                             | 28   |
| 3–6    | UART Functional Block Diagram                      | 30   |
| 3–7    | I <sup>2</sup> C Module Block Diagram              | 31   |
| 3–8    | DMA Channel 0 Control Register Layout (0x0C01)     | 33   |
| 3–9    | PLL and Clock Generator Logic                      | 35   |
| 3–10   | Internal System Oscillator External Crystal        | 36   |
| 3–11   | Clock Generator (PLL) Registers                    | 38   |
| 3–12   | PLL Control/Status Register Layout (0x1C80)        | 40   |
| 3–13   | PLL Multiplier Control Register Layout (0x1C88)    | 42   |
| 3–14   | PLL Divider 0 Register Layout (0x1C8A)             | 43   |
| 3–15   | PLL Divider 1 Register Layout (0x1C8C)             | 44   |
| 3–16   | PLL Divider 2 Register Layout (0x1C8E)             | 44   |
| 3–17   | PLL Divider 3 Register Layout (0x1C90)             | 45   |
| 3–18   | Oscillator Divider1 Register Layout (0x1C92)       | 46   |
| 3–19   | Oscillator Wakeup Control Register Layout (0x1C98) | 47   |
| 3–20   | CLKOUT3 Select Register Layout (0x1C82)            | 48   |
| 3–21   | CLKOUT Selection Register Layout (0x8400)          | 48   |
| 3–22   | Clock Mode Control Register Layout (0x8C00)        | 49   |
| 3–23   | IDLE Configuration Register Layout (0x0001)        | 58   |
| 3–24   | IDLE Status Register Layout (0x0002)               | 60   |
| 3–25   | Peripheral IDLE Control Register Layout (0x9400)   | 61   |
| 3–26   | Peripheral IDLE Status Register Layout (0x9401)    | 63   |
| 3–27   | Master IDLE Control Register Layout (0x9402)       | 64   |
| 3–28   | Master IDLE Status Register Layout (0x9403)        | 65   |
| 3–29   | GPIO Direction Register Layout (0x3400)            | 66   |
| 3–30   | GPIO Data Register Layout (0x3401)                 | 66   |
| 3–31   | Parallel GPIO Enable Register 0 Layout (0x4400)    | 68   |
| 3–32   | Parallel GPIO Direction Register 0 Layout (0x4401) | 68   |
| 3–33   | Parallel GPIO Data Register 0 Layout (0x4402)      | 69   |
| 3-34   | Parallel GPIO Enable Register 1 Layout (0x4403)    | 70   |
| 3-35   | Parallel GPIO Direction Register 1 Layout (0x4404) | 70   |
| 3-36   | Parallel GPIO Data Register 1 Layout (0x4405)      | 71   |
| 3–37   | Parallel GPIO Enable Register 2 Layout (0x4406)    | 72   |

| Figure |   |
|--------|---|
| 3–38   | Parallel GPIO Direction Register 2 Layout (0x4407)                                |
| 3–39   | Parallel GPIO Data Register 2 Layout (0x4408)                                     |
| 3–40   | External Bus Control Register Layout (0x6C01)                                     |
| 3–41   | XPORT Configuration Register Layout (0x0100)                                      |
| 3–42   | XPORT Bus Error Register Layout (0x0102)  |
| 3–43   | DPORT Configuration Register Layout (0x0200)                                      |
| 3–44   | DPORT Bus Error Register Layout (0x0202)  |
| 3–45   | IPORT Bus Error Register Layout (0x0302)  |
| 3–46   | System Configuration Register Layout (0x07FD)                                     |
| 3–47   | Time-Out Control Register Layout (0x9000)   |
| 3–48   | IFR0, IER0, DBIFR0, and DBIER0 Registers Layout                                   |
| 3–49   | IFR1, IER1, DBIFR1, and DBIER1 Registers Layout                                   |
| 6–1    | 3.3-V Test Load Circuit   |
| 6–2    | Bypass Mode Clock Timing  |
| 6–3    | External Multiply-by-N Clock Timing   |
| 6–4    | ECLKIN Timing for EMIF  |
| 6–5    | ECLKOUT1 Timing for EMIF Module   |
| 6–6    | ECLKOUT2 Timing for the EMIF Module   |
| 6–7    | Asynchronous Memory Read Timing for EMIF  |
| 6–8    | Asynchronous Memory Write Timing for EMIF   |
| 6–9    | Programmable Synchronous Interface Read Timing for EMIF (With Read Latency = 2)   |
| 6–10   | Programmable Synchronous Interface Write Timing for EMIF (With Write Latency = 0) |
| 6–11   | Programmable Synchronous Interface Write Timing for EMIF (With Write Latency = 1) |
| 6–12   | SDRAM Read Command (CAS Latency 3) for EMIF                                       |
| 6–13   | SDRAM Write Command for EMIF  |
| 6–14   | SDRAM ACTV Command for EMIF   |
| 6–15   | SDRAM DCAB Command for EMIF   |
| 6–16   | SDRAM DEAC Command for EMIF   |
| 6–17   | SDRAM REFR Command for EMIF   |
| 6–18   | SDRAM MRS Command for EMIF  |
| 6–19   | SDRAM Self-Refresh Timing for EMIF  |
| 6–20   | HOLD/HOLDA Timing for EMIF  |
| 6–21   | Reset Timing  |
| 6–22   | External Interrupt Timing   |
| 6–23   | External Interrupt Acknowledge Timing   |
| 6–24   | XF Timing   |
| 6–25   | General-Purpose Input/Output (GPIOx) Signal Timings                               |
| 6–26   | TIM0/TIM1/WDTOUT Timings When Configured as Inputs                                |
| 6–27   | TIM0/TIM1/WDTOUT Timings When Configured as Outputs                               |
| 6–28   | McBSP Receive Timings   |
| 6–29   | McBSP Transmit Timings  |
|        |   |

SPRS206

хi

| Figure |   | Page |
|--------|---|------|
| 6–30   | McBSP General-Purpose I/O Timings                                   | 132  |
| 6–31   | McBSP Timing as SPI Master or Slave: CLKSTP = 10b, CLKXP = 0        | 134  |
| 6–32   | McBSP Timing as SPI Master or Slave: CLKSTP = 11b, CLKXP = 0        | 135  |
| 6–33   | McBSP Timing as SPI Master or Slave: CLKSTP = 10b, CLKXP = 1        | 136  |
| 6–34   | McBSP Timing as SPI Master or Slave: CLKSTP = 11b, CLKXP = 1        | 137  |
| 6–35   | Multiplexed Read Timings Using HAS                                  | 139  |
| 6–36   | Multiplexed Read Timings With HAS Held High                         | 140  |
| 6–37   | Multiplexed Write Timings Using HAS                                 | 141  |
| 6–38   | Multiplexed Write Timings With HAS Held High                        | 142  |
| 6–39   | HINT Timing   | 142  |
| 6–40   | I <sup>2</sup> C Timings  | 143  |
| 6–41   | UART Timings  | 144  |
| 7–1    | TMS320VC5501 176-Ball MicroStar BGA Plastic Ball Grid Array Package | 145  |
| 7–2    | TMS320VC5501 176-Pin Low-Profile Quad Flatpack                      | 146  |

# **List of Tables**

| Table        |   | Page     |
|--------------|---|----------|
| 2–1          | 176-Terminal GGW Ball Grid Array Ball Assignments                 | 4        |
| 2–2          | 176-Pin PGF Low-Profile Quad Flatpack Pin Assignments             | 6        |
| 2–3          | Signal Descriptions   | 7        |
| 3–1          | On-Chip ROM Layout  | 18       |
| 3–2          | DARAM Blocks  | 19       |
| 3–3          | Boot Configuration Selection Via the BOOTM[2:0] Pins              | 21       |
| 3–4          | TMS320VC5501 Routing of Parallel Port Mux Signals                 | 23       |
| 3–5          | TMS320VC5501 Routing of Host Port Mux Signals                     | 24       |
| 3–6          | External Bus Selection Register Bit Field Description             | 26       |
| 3–7          | Timer Signal Selection Register Bit Field Description             | 27       |
| 3–8          | Synchronization Control Function                                  | 34       |
| 3–9          | PLL Control Registers   | 40       |
| 3–10         | PLL Control/Status Register Bit Field Description                 | 41       |
| 3–11         | PLL Multiplier Control Register Bit Field Description             | 42       |
| 3–12         | PLL Divider 0 Register Bit Field Description                      | 43       |
| 3–13         | PLL Divider 1 Register Bit Field Description                      | 44       |
| 3–14         | PLL Divider 2 Register Bit Field Description                      | 45       |
| 3–15         | PLL Divider3 Register Bit Field Description                       | 45       |
| 3–16         | Oscillator Divider1 Register Bit Field Description                | 46       |
| 3–17         | Oscillator Wakeup Control Register Bit Field Description          | 47       |
| 3–18         | CLKOUT3 Select Register Bit Field Description                     | 48       |
| 3–19         | CLKOUT Selection Register Bit Field Description                   | 49       |
| 3–20         | Clock Mode Control Register Bit Field Description                 | 49       |
| 3–21         | Number of Reference Clock Cycles Needed Until Program Flow Begins | 50       |
| 3–22         | Peripheral Behavior at Entering IDLE State                        | 54       |
| 3–23         | Wake-Up Procedures  | 57       |
| 3–24         | Clock Domain Memory-Mapped Registers                              | 58       |
| 3–25         | IDLE Configuration Register Bit Field Description                 | 59       |
| 3–26         | IDLE Status Register Bit Field Description                        | 60       |
| 3–27         | Peripheral IDLE Control Register Bit Field Description            | 61       |
| 3–28         | Peripheral IDLE Status Register Bit Field Description             | 63       |
| 3–29         | Master IDLE Control Register Bit Field Description                | 64       |
| 3–30         | Master IDLE Status Register Bit Field Description                 | 65       |
| 3–31         | GPIO Direction Register Bit Field Description                     | 66       |
| 3–32         | GPIO Data Register Bit Field Description                          | 66       |
| 3–33<br>3–34 | TMS320VC5501 PGPIO Cross-Reference                                | 67       |
| 3–35         | Parallel GPIO Enable Register 0 Bit Field Description             | 68<br>68 |
| 3–36         | Parallel GPIO Data Register 0 Bit Field Description               | 69       |
| 3–36         | Parallel GPIO Data Register 1 Bit Field Description               | 70       |
| 3–38         | Parallel GPIO Direction Register 1 Bit Field Description          | 70<br>70 |
| 3–39         | Parallel GPIO Data Register 1 Bit Field Description               | 70<br>71 |
| 3–40         | Parallel GPIO Enable Register 2 Bit Field Description             | 71       |
| 3–40         | Parallel GPIO Direction Register 2 Bit Field Description          | 73       |
| 3–42         | Parallel GPIO Data Register 2 Bit Field Description               | 73       |
| J 72         | raiding of to bata register 2 bit i loa bescription               | 13       |

| Table |   | Page |
|-------|---|------|
| 3–43  | Pins With Pullups, Pulldowns, and Bus Holders                         | 74   |
| 3–44  | External Bus Control Register Bit Field Description                   | 75   |
| 3–45  | I/O Addresses Under Scope of XPORT                                    | 76   |
| 3–46  | XPORT Configuration Register Bit Field Description                    | 77   |
| 3–47  | XPORT Bus Error Register Bit Field Description                        | 78   |
| 3–48  | DPORT Configuration Register Bit Field Description                    | 79   |
| 3–49  | DPORT Bus Error Register Bit Field Description                        | 80   |
| 3-50  | IPORT Bus Error Register Bit Field Description                        | 81   |
| 3–51  | System Configuration Register Bit Field Description                   | 82   |
| 3–52  | Time-Out Control Register Bit Field Description                       | 83   |
| 3-53  | CPU Memory-Mapped Registers   | 84   |
| 3–54  | Peripheral Bus Controller Configuration Registers                     | 86   |
| 3–55  | External Memory Interface Registers                                   | 87   |
| 3–56  | DMA Configuration Registers   | 88   |
| 3–57  | Instruction Cache Registers   | 91   |
| 3–58  | Trace FIFO  | 91   |
| 3–59  | Timer Signal Selection Register                                       | 91   |
| 3-60  | Timers  | 91   |
| 3–61  | Multichannel Serial Port #0   | 93   |
| 3–62  | Multichannel Serial Port #1   | 94   |
| 3–63  | HPI   | 95   |
| 3-64  | GPIO  | 95   |
| 3–65  | Device Revision ID  | 96   |
| 3–66  | I <sup>2</sup> C  | 96   |
| 3–67  | UART  | 97   |
| 3–68  | External Bus Selection  | 97   |
| 3–69  | Clock Mode Register   | 97   |
| 3–70  | CLKOUT Selector Register  | 97   |
| 3–71  | Clock Controller Registers  | 98   |
| 3–72  | IDLE Control Registers  | 98   |
| 3–73  | Interrupt Table   | 99   |
|       |   |      |
| 6–1   | Thermal Resistance Characteristics                                    | 106  |
| 6–2   | CLKIN in Bypass Mode Timing Requirements                              | 107  |
| 6–3   | CLKOUT in Bypass Mode Switching Characteristics                       | 107  |
| 6–4   | CLKIN in Lock Mode Timing Requirements                                | 108  |
| 6–5   | CLKOUT in Lock Mode Switching Characteristics                         | 108  |
| 6–6   | EMIF Timing Requirements for ECLKIN                                   | 109  |
| 6–7   | EMIF Switching Characteristics for ECLKOUT1                           | 109  |
| 6–8   | EMIF Switching Characteristics for ECLKOUT2                           | 110  |
| 6–9   | EMIF Asynchronous Memory Cycle Timing Requirements for ECLKIN         | 111  |
| 6–10  | EMIF Asynchronous Memory Cycle Switching Characteristics for ECLKOUT1 | 111  |
| 6–11  | EMIF Programmable Synchronous Interface Timing Requirements           | 114  |
| 6–12  | EMIF Programmable Synchronous Interface Switching Characteristics     | 114  |
| 6–13  | EMIF Synchronous DRAM Cycle Timing Requirements                       | 118  |
| 6–14  | EMIF Synchronous DRAM Cycle Switching Characteristics                 | 118  |
| 6–15  | EMIF HOLD/HOLDA Timing Requirements                                   | 123  |

ΧV

| Table |  | Page |
|-------|--|------|
| 6–16  | EMIF HOLD/HOLDA Switching Characteristics  | 123  |
| 6–17  | Reset Timing Requirements  | 124  |
| 6–18  | Reset Switching Characteristics  | 124  |
| 6–19  | External Interrupt and Interrupt Acknowledge Timing Requirements                 | 125  |
| 6–20  | External Interrupt and Interrupt Acknowledge Switching Characteristics           | 125  |
| 6–21  | XF Switching Characteristics   | 126  |
| 6–22  | GPIO Pins Configured as Inputs Timing Requirements                               | 127  |
| 6–23  | GPIO Pins Configured as Inputs Switching Characteristics                         | 127  |
| 6–24  | TIM0/TIM1/WDTOUT Pins Configured as Inputs Timing Requirements                   | 128  |
| 6–25  | TIM0/TIM1/WDTOUT Pins Configured as Outputs Switching Characteristics            | 128  |
| 6–26  | McBSP Transmit and Receive Timing Requirements                                   | 129  |
| 6–27  | McBSP Transmit and Receive Switching Characteristics                             | 130  |
| 6–28  | McBSP General-Purpose I/O Timing Requirements                                    | 132  |
| 6–29  | McBSP General-Purpose I/O Switching Characteristics                              | 132  |
| 6-30  | McBSP as SPI Master or Slave Timing Requirements (CLKSTP = 10b, CLKXP = 0)       | 133  |
| 6–31  | McBSP as SPI Master or Slave Switching Characteristics (CLKSTP = 10b, CLKXP = 0) | 133  |
| 6–32  | McBSP as SPI Master or Slave Timing Requirements (CLKSTP = 11b, CLKXP = 0)       | 135  |
| 6–33  | McBSP as SPI Master or Slave Switching Characteristics (CLKSTP = 11b, CLKXP = 0) | 135  |
| 6-34  | McBSP as SPI Master or Slave Timing Requirements (CLKSTP = 10b, CLKXP = 1)       | 136  |
| 6–35  | McBSP as SPI Master or Slave Switching Characteristics (CLKSTP = 10b, CLKXP = 1) | 136  |
| 6–36  | McBSP as SPI Master or Slave Timing Requirements (CLKSTP = 11b, CLKXP = 1)       | 137  |
| 6–37  | McBSP as SPI Master or Slave Switching Characteristics (CLKSTP = 11b, CLKXP = 1) | 137  |
| 6–38  | HPI Timing Requirements  | 138  |
| 6–39  | HPI Switching Characteristics  | 138  |
| 6–40  | I <sup>2</sup> C Signals (SDA and SCL) Switching Characteristics                 | 143  |
| 6–41  | UART Timing Requirements   | 144  |
| 6-42  | UART Switching Characteristics   | 144  |

#### 1 TMS320VC5501 Features

- High-Performance, Low-Power, Fixed-Point TMS320C55x™ Digital Signal Processor (DSP)
  - 3.33-ns Instruction Cycle Time for 300-MHz Clock Rate
  - 16K-Byte Instruction Cache (I-Cache)
  - One/Two Instructions Executed per Cycle
  - Dual Multipliers [Up to 600 Million Multiply-Accumulates Per Second (MMACS)]
  - Two Arithmetic/Logic Units (ALUs)
  - One Program Bus, Three Internal Data/Operand Read Buses, and Two Internal Data/Operand Write Buses
- 16K x 16-Bit On-Chip RAM That is Composed of Four Blocks of 4K × 16-Bit Dual-Access RAM (DARAM) (32K Bytes)
- 16K × 16-Bit One-Wait-State On-Chip ROM (32K Bytes)
- 4M × 16-Bit Maximum Addressable External Memory Space
- 16-Bit External Parallel Bus Memory Supporting External Memory Interface (EMIF) With General-Purpose Input/Output (GPIO) Capabilities and Glueless Interface to:
  - Asynchronous Static RAM (SRAM)
  - Asynchronous EPROM
  - Synchronous DRAM (SDRAM)
  - Synchronous Burst RAM (SBRAM)
- Emulation/Debug Trace Capability Saves Last 16 Program Counter (PC)
   Discontinuities and Last 32 PC Values

- Programmable Low-Power Control of Six Device Functional Domains
- On-Chip Peripherals
  - Six-Channel Direct Memory Access (DMA) Controller
  - Two Multichannel Buffered Serial Ports (McBSPs)
  - Programmable Analog Phase-Locked Loop (APLL) Clock Generator
  - General-Purpose I/O (GPIO) Pins and a Dedicated Output Pin (XF)
  - 8-Bit Parallel Host-Port Interface (HPI)
  - Four Timers
    - Two 64-Bit General-Purpose Timers
    - 64-Bit Programmable Watchdog Timer
    - 64-Bit DSP/BIOS™ Counter
  - Inter-Integrated Circuit (I<sup>2</sup>C) Interface
  - Universal Asynchronous Receiver/ Transmitter (UART)
- On-Chip Scan-Based Emulation Logic
- IEEE Std 1149.1<sup>†</sup> (JTAG) Boundary Scan Logic
- Packages:
  - 176-Terminal LQFP (Low-Profile Quad Flatpack) (PGF Suffix)
  - 176-Terminal MicroStar BGA™ (Ball Grid Array) (GGW Suffix)
- 3.3-V I/O Supply Voltage
- 1.26-V Core Supply Voltage

TMS320C55x, DSP/BIOS, and MicroStar BGA are trademarks of Texas Instruments. Other trademarks are the property of their respective owners.

† IEEE Standard 1149.1-1990 Standard-Test-Access Port and Boundary Scan Architecture.



1

#### 2 Introduction

This section describes the main features of the TMS320VC5501 and gives a brief description of the device.

**NOTE:** This document is designed to be used in conjunction with the *TMS320C55x™ DSP Functional Overview* (literature number SPRU312) and the *TMS320C55x DSP CPU Reference Guide* (literature number SPRU371).

#### 2.1 Description

The TMS320VC5501 (5501) fixed-point digital signal processor (DSP) is based on the TMS320C55x™ DSP generation CPU processor core. The C55x™ DSP architecture achieves high performance and low power through increased parallelism and total focus on reduction in power dissipation. The CPU supports an internal bus structure that is composed of one program bus, three data read buses, two data write buses, and additional buses dedicated to peripheral and DMA activity. These buses provide the ability to perform up to three data reads and two data writes in a single cycle. In parallel, the DMA controller can perform data transfers independent of the CPU activity.

The C55x™ CPU provides two multiply-accumulate (MAC) units, each capable of 17-bit x 17-bit multiplication in a single cycle. A central 40-bit arithmetic/logic unit (ALU) is supported by an additional 16-bit ALU. Use of the ALUs is under instruction set control, providing the ability to optimize parallel activity and power consumption. These resources are managed in the Address Unit (AU) and Data Unit (DU) of the C55x CPU.

The C55x DSP generation supports a variable byte width instruction set for improved code density. The Instruction Unit (IU) performs 32-bit program fetches from internal or external memory and queues instructions for the Program Unit (PU). The Program Unit decodes the instructions, directs tasks to AU and DU resources, and manages the fully protected pipeline. Predictive branching capability avoids pipeline flushes on execution of conditional instructions.

The 5501 peripheral set includes an external memory interface (EMIF) that provides glueless access to asynchronous memories like EPROM and SRAM, as well as to high-speed, high-density memories such as synchronous DRAM and synchronous burst RAM. Additional peripherals include UART, watchdog timer, and an I-Cache. Two full-duplex multichannel buffered serial ports (McBSPs) provide glueless interface to a variety of industry-standard serial devices, and multichannel communication with up to 128 separately enabled channels. The host-port interface (HPI) is an 8-bit parallel interface used to provide host processor access to 16K words of internal memory on the 5501. The HPI operates in multiplexed mode to provide glueless interface to a wide variety of host processors. The DMA controller provides data movement for six independent channel contexts without CPU intervention. Two general-purpose timers, eight dedicated general-purpose I/O (GPIO) pins, and analog phase-locked loop (APLL) clock generation are also included.

The 5501 is supported by the industry's award-winning eXpressDSP™, Code Composer Studio™ Integrated Development Environment (IDE), DSP/BIOS™, Texas Instruments' algorithm standard, and the industry's largest third-party network. The Code Composer Studio™ IDE features code generation tools that include a C Compiler, Visual Linker, simulator, RTDX™, XDS510™ emulation device drivers, and evaluation modules. The 5501 is also supported by the C55x™ DSP Library, which features more than 50 foundational software kernels (FIR filters, IIR filters, FFTs, and various math functions) as well as chip and board support libraries.

C55x, eXpressDSP, Code Composer Studio, RTDX, and XDS510 are trademarks of Texas Instruments.



#### 2.2 Pin Assignments

#### 2.2.1 Ball Grid Array (GGW)

Figure 2–1 illustrates the ball locations for the 176-pin ball grid array (BGA) package and Table 2–1 lists the signal names and terminal numbers.

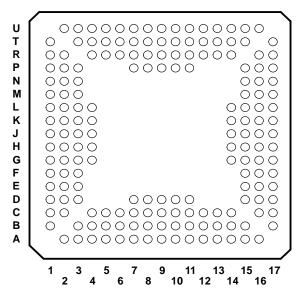


Figure 2–1. 176-Terminal GGW Ball Grid Array (Bottom View)

Table 2–1. 176-Terminal GGW Ball Grid Array Ball Assignments<sup>†‡</sup>

| BALL NO. | SIGNAL NAME      |
|----------|------------------|----------|------------------|----------|------------------|----------|------------------|
| BALL NO. | GPIO6            | U2       | HCNTL1           | T17      | A19              | A16      | PGPIO4           |
| C2       | GPIO6<br>GPIO4   | T3       | HCNTL1           | R16      | A19<br>A18       | B15      | PGP104<br>D15    |
| C1       | GPIO4<br>GPIO2   | U3       |                  | R17      |                  | A15      | D15              |
| D3       | GPIO2<br>GPIO1   | R4       | VSS<br>HR/W      | P15      | VSS<br>A17       | C14      | D13              |
|          |                  |          |                  |          |                  |          |                  |
| D2       | GPIO0            | T4       | HDS2             | P16      | A16              | B14      | D12              |
| D1       | TIM1             | U4       | CV <sub>DD</sub> | P17      | DV <sub>DD</sub> | A14      | D11              |
| E3       | TIMO             | R5       | HDS1             | N15      | A15              | C13      | D10              |
| E2       | ĪNT0             | T5       | HRDY             | N16      | A14              | B13      | D9               |
| E1       | CV <sub>DD</sub> | U5       | DV <sub>DD</sub> | N17      | V <sub>SS</sub>  | A13      | DV <sub>DD</sub> |
| F3       | INT1             | R6       | CLKOUT           | M15      | A13              | C12      | D8               |
| F2       | INT2             | T6       | XF               | M16      | A12              | B12      | D7               |
| F1       | DV <sub>DD</sub> | U6       | V <sub>SS</sub>  | M17      | CVDD             | A12      | V <sub>SS</sub>  |
| G4       | INT3             | P7       | C15              | L14      | A11              | D11      | D6               |
| G3       | NMI/WDTOUT       | R7       | C14              | L15      | A10              | C11      | D5               |
| G2       | IACK             | T7       | HINT             | L16      | A9               | B11      | D4               |
| G1       | V <sub>SS</sub>  | U7       | $PV_{DD}$        | L17      | A8               | A11      | CV <sub>DD</sub> |
| H1       | CLKR0            | U8       | PSENSE           | K17      | $DV_DD$          | A10      | D3               |
| H4       | DR0              | P8       | X1               | K14      | A7               | D10      | D2               |
| H3       | FSR0             | R8       | X2/CLKIN         | K15      | A6               | C10      | D1               |
| H2       | CLKX0            | T8       | EMIFCLKS         | K16      | A5               | B10      | D0               |
| J1       | CV <sub>DD</sub> | U9       | V <sub>SS</sub>  | J17      | V <sub>SS</sub>  | A9       | V <sub>SS</sub>  |
| J4       | DX0              | P9       | C13              | J14      | A4               | D9       | EMU1/OFF         |
| J3       | FSX0             | R9       | C12              | J15      | A3               | C9       | EMU0             |
| J2       | CLKR1            | Т9       | C11              | J16      | A2               | B9       | TDO              |
| K1       | DR1              | U10      | C10              | H17      | CV <sub>DD</sub> | A8       | V <sub>SS</sub>  |
| K2       | FSR1             | T10      | C9               | H16      | PGPIO19          | B8       | TDI              |
| K4       | DX1              | P10      | C8               | H14      | PGPIO18          | D8       | TRST             |
| K3       | CLKX1            | R10      | C7               | H15      | PGPIO17          | C8       | TCK              |
| L1       | V <sub>SS</sub>  | U11      | V <sub>SS</sub>  | G17      | V <sub>SS</sub>  | A7       | TMS              |
| L2       | FSX1             | T11      | ECLKIN           | G16      | PGPIO16          | B7       | RESET            |
| L3       | TEST             | R11      | ECLKOUT2         | G15      | PGPIO15          | C7       | HPIENA           |
| L4       | NC               | P11      | ECLKOUT1         | G14      | PGPIO14          | D7       | HD7              |
| M1       | CV <sub>DD</sub> | U12      | CV <sub>DD</sub> | F17      | CV <sub>DD</sub> | A6       | CV <sub>DD</sub> |
| M2       | RX               | T12      | C6               | F16      | PGPIO13          | B6       | HD6              |
| МЗ       | GPIO5            | R12      | C5               | F15      | PGPIO12          | C6       | HD5              |
| N1       | $DV_DD$          | U13      | $DV_DD$          | E17      | $DV_DD$          | A5       | $DV_DD$          |
| N2       | TX               | T13      | C4               | E16      | PGPIO11          | B5       | HD4              |
| N3       | GPIO3            | R13      | C3               | E15      | PGPIO10          | C5       | HD3              |
| P1       | V <sub>SS</sub>  | U14      | V <sub>SS</sub>  | D17      | PGPIO9           | A4       | CV <sub>DD</sub> |
| P2       | SCL              | T14      | C2               | D16      | PGPIO8           | B4       | HD2              |
| P3       | SDA              | R14      | C1               | D15      | PGPIO7           | C4       | HD1              |
| R1       | HC1              | U15      | C0               | C17      | V <sub>SS</sub>  | A3       | V <sub>SS</sub>  |
| R2       | HC0              | T15      | A21              | C16      | PGPIO6           | В3       | HD0              |
| T1       | HCS              | U16      | A20              | B17      | PGPIO5           | A2       | GPIO7            |

 $<sup>^\</sup>dagger$  CV\_DD is core VDD, DVDD is I/O VDD, and PVDD is PLL VDD. PSENSE must be left unconnected.  $^\ddagger$  NC indicates "no connect".

# 2.2.2 Low-Profile Quad Flatpack (PGF)

Figure 2–2 illustrates the pin locations for the 176-pin low-profile quad flatpack (LQFP) and Table 2–2 provides a numerical list (by pin number) of the pin assignments.

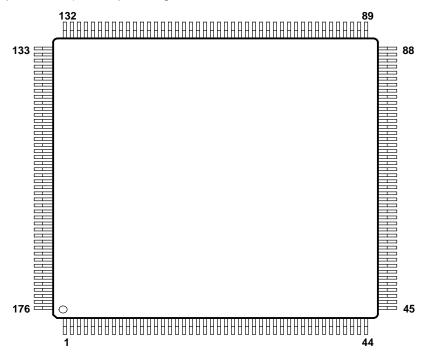


Figure 2–2. 176-Pin PGF Low-Profile Quad Flatpack (Top View)

Table 2–2. 176-Pin PGF Low-Profile Quad Flatpack Pin Assignments<sup>†‡</sup>

| PIN NO. | SIGNAL NAME      |
|---------|------------------|---------|------------------|---------|------------------|---------|------------------|
| 1       | GPIO6            | 45      | HCNTL1           | 89      | A19              | 133     | PGPIO4           |
| 2       | GPIO4            | 46      | HCNTL0           | 90      | A18              | 134     | D15              |
| 3       | GPIO2            | 47      | Vss              | 91      | V <sub>SS</sub>  | 135     | D14              |
| 4       | GPIO1            | 48      | HR/W             | 92      | A17              | 136     | D13              |
| 5       | GPIO0            | 49      | HDS2             | 93      | A16              | 137     | D12              |
| 6       | TIM1             | 50      | CV <sub>DD</sub> | 94      | DV <sub>DD</sub> | 138     | D11              |
| 7       | TIMO             | 51      | HDS1             | 95      | A15              | 139     | D10              |
| 8       | ĪNT0             | 52      | HRDY             | 96      | A14              | 140     | D9               |
| 9       | CV <sub>DD</sub> | 53      | DV <sub>DD</sub> | 97      | V <sub>SS</sub>  | 141     | DV <sub>DD</sub> |
| 10      | INT1             | 54      | CLKOUT           | 98      | A13              | 142     | D8               |
| 11      | ĪNT2             | 55      | XF               | 99      | A12              | 143     | D7               |
| 12      | DV <sub>DD</sub> | 56      | V <sub>SS</sub>  | 100     | CV <sub>DD</sub> | 144     | Vss              |
| 13      | INT3             | 57      | C15              | 101     | A11              | 145     | D6               |
| 14      | NMI/WDTOUT       | 58      | C14              | 102     | A10              | 146     | D5               |
| 15      | IACK             | 59      | HINT             | 103     | A9               | 147     | D4               |
| 16      | VSS              | 60      | $PV_{DD}$        | 104     | A8               | 148     | CV <sub>DD</sub> |
| 17      | CLKR0            | 61      | PSENSE           | 105     | $DV_DD$          | 149     | D3               |
| 18      | DR0              | 62      | X1               | 106     | A7               | 150     | D2               |
| 19      | FSR0             | 63      | X2/CLKIN         | 107     | A6               | 151     | D1               |
| 20      | CLKX0            | 64      | EMIFCLKS         | 108     | A5               | 152     | D0               |
| 21      | CV <sub>DD</sub> | 65      | Vss              | 109     | Vss              | 153     | V <sub>SS</sub>  |
| 22      | DX0              | 66      | C13              | 110     | A4               | 154     | EMU1/OFF         |
| 23      | FSX0             | 67      | C12              | 111     | A3               | 155     | EMU0             |
| 24      | CLKR1            | 68      | C11              | 112     | A2               | 156     | TDO              |
| 25      | DR1              | 69      | C10              | 113     | C∨ <sub>DD</sub> | 157     | V <sub>SS</sub>  |
| 26      | FSR1             | 70      | C9               | 114     | PGPIO19          | 158     | TDI              |
| 27      | DX1              | 71      | C8               | 115     | PGPIO18          | 159     | TRST             |
| 28      | CLKX1            | 72      | C7               | 116     | PGPIO17          | 160     | TCK              |
| 29      | V <sub>SS</sub>  | 73      | V <sub>SS</sub>  | 117     | V <sub>SS</sub>  | 161     | TMS              |
| 30      | FSX1             | 74      | ECLKIN           | 118     | PGPIO16          | 162     | RESET            |
| 31      | TEST             | 75      | ECLKOUT2         | 119     | PGPIO15          | 163     | HPIENA           |
| 32      | NC               | 76      | ECLKOUT1         | 120     | PGPIO14          | 164     | HD7              |
| 33      | CV <sub>DD</sub> | 77      | CV <sub>DD</sub> | 121     | CV <sub>DD</sub> | 165     | CV <sub>DD</sub> |
| 34      | RX               | 78      | C6               | 122     | PGPIO13          | 166     | HD6              |
| 35      | GPIO5            | 79      | C5               | 123     | PGPIO12          | 167     | HD5              |
| 36      | DV <sub>DD</sub> | 80      | DV <sub>DD</sub> | 124     | DV <sub>DD</sub> | 168     | DV <sub>DD</sub> |
| 37      | TX               | 81      | C4               | 125     | PGPIO11          | 169     | HD4              |
| 38      | GPIO3            | 82      | C3               | 126     | PGPIO10          | 170     | HD3              |
| 39      | V <sub>SS</sub>  | 83      | V <sub>SS</sub>  | 127     | PGPIO9           | 171     | CV <sub>DD</sub> |
| 40      | SCL              | 84      | C2               | 128     | PGPIO8           | 172     | HD2              |
| 41      | SDA              | 85      | C1               | 129     | PGPIO7           | 173     | HD1              |
| 42      | HC1              | 86      | C0               | 130     | V <sub>SS</sub>  | 174     | V <sub>SS</sub>  |
| 43      | HC0              | 87      | A21              | 131     | PGPIO6           | 175     | HD0              |
| 44      | HCS              | 88      | A20              | 132     | PGPIO5           | 176     | GPIO7            |

 $<sup>^\</sup>dagger$  CV\_DD is core VDD, DVDD is I/O VDD, and PVDD is PLL VDD. PSENSE must be left unconnected.  $^\ddagger$  NC indicates "no connect".

#### 2.3 Signal Descriptions

Table 2–3 lists each signal, function, and operating mode(s) grouped by function. See Section 2.2, Pin Assignments, for exact pin locations based on package type.

Table 2-3. Signal Descriptions

| Pin<br>Name | Multiplexed<br>Signal Name | Pin<br>Type†                 | Other‡ | Function   |
|-------------|----------------------------|------------------------------|--------|--|
|             |                            |                              |        | Parallel Bus   |
| A[21:18]    |                            | I/O/Z<br>C, D, F,<br>G, H, M |        | These pins serve one of two functions: EMIF address bus EMIF.A[21:18] or PGPIO[3:0]. At reset, GPIO6 is sampled. If GPIO6 is low, the address bus A[21:18] is set to GPIO with all pins set as inputs. If GPIO6 is high, the EMIF mode is enabled and all address pins are set as outputs.  The address bus includes a bus holder feature that eliminates passive components and the power dissipation associated with them. The bus holder keeps the address bus at the previous logic level when the bus went into a high-impedance state. These pins also include Schmitt-trigger inputs. |
|             | PGPIO[3:0]                 | I/O/Z                        |        | Parallel general-purpose I/O. PGPIO[3:0] is selected when GPIO6 is low at reset.   |
|             | EMIF.A[21:18]              | O/Z                          |        | <b>EMIF address bus.</b> EMIF.A[21:18] is selected when GPIO6 is high at reset, enabling EMIF mode and the EMIF address bus drives the Parallel Port Mux address bus.  |
| A[17:2]     | 7:2] I/O/Z C, D, F,        |                              |        | These pins serve one of two functions: EMIF address bus EMIF.A[17:2] or reserved pins. At reset, GPIO6 is sampled. If GPIO6 is low, A[17:2] become reserved pins with no function. If GPIO6 is high, the EMIF mode is enabled and all address pins are set as outputs.  The address bus includes a bus holder feature that eliminates passive components and the power dissipation associated with them. The bus holder keeps the address bus at the previous logic level when the bus went into a high-impedance state. These pins also include Schmitt trigger inputs.                     |
|             | Reserved                   | Ī                            |        | Reserved pins. These pins are reserved when GPIO6 is low at reset.   |
|             | EMIF.A[17:2]               | O/Z                          |        | <b>EMIF address bus.</b> EMIF.A[17:2] is selected when GPIO6 is high at reset, enabling EMIF mode and the EMIF address bus drives the Parallel Port Mux address bus.   |

<sup>†</sup> I = Input, O = Output, S = Supply, Z = High impedance

- A Internal pullup (always enabled)
- B Internal pulldown (always enabled)
- C Hysteresis input
- D Pin has bus holder enabled through the External Bus Control Register (XBCR).
- E Pin is high impedance in HOLD mode (due to HOLD pin).
- F Pin is high impedance in OFF mode (due to EMU1/OFF pin).
- G Pin can be configured as a general-purpose input.
- H Pln can be configured as a general-purpose output.
- J Internal pullup enabled through the External Bus Control Register (XBCR)
- K Internal pulldown enabled through the External Bus Control Register (XBCR)
- L Fail-safe pin
- M Pin is in high-impedance during reset (RESET pin is low)

7

<sup>‡</sup> Other Pin Characteristics:

#### Table 2–3. Signal Descriptions (Continued)

| Pin<br>Name | Multiplexed<br>Signal Name  | Pin<br>Type† | Other‡        | Function  |  |  |
|-------------|-----------------------------|--------------|---------------|---|--|--|
|             | Parallel Bus (Continued)    |              |               |   |  |  |
|             |                             |              |               | The 16 data pins, D[15:0], are used to transfer data between the core CPU and external data/program memory or I/O devices. At reset, GPIO6 is sampled. If GPIO6 is low, then D[15:0] become reserved pins and have no function. If GPIO6 is high, the EMIF mode is enabled and all data pins are set as data inputs.  |  |  |
| D[15:0]     |                             | I/O/Z        | C, D, F,<br>M | The data bus includes bus holders to reduce the static power dissipation caused by floating, unused pins. The bus holders also eliminate the need for external bias resistors on unused pins. When the data bus is not being driven by the CPU, the bus holders keep the pins at the logic level that were most recently driven. The data bus holders are disabled at reset, and can be enabled/disabled under software control.  At reset, the bus is in a high-impedance state. |  |  |
|             | Reserved                    | I/O/Z        |               | Reserved pins. These pins are reserved when GPIO6 is low at reset.  |  |  |
|             | EMIF.D[15:0]                | I/O/Z        |               | <b>EMIF data bus.</b> EMIF.D[15:0] is selected when GPIO6 is high. This setting enables the EMIF mode and the EMIF data bus drives the Parallel Port Mux data bus.  |  |  |
| CO          |                             | I/O/Z        | C, D, F,      | EMIF control function [asynchronous memory read-enable (ARE) multiplexed with synchronous memory address strobe (SADS), SDRAM column-address strobe (SDCAS), and synchronous read enable (SRE) (selected when by RENEN in CE Secondary Control Register 1)] or PGPIO20. At reset, GPIO6 is sampled. If GPIO6 is low, C0 is set to PGPIO20 input. If GPIO6 is high, the full EMIF mode is enabled and C0 is set to EMIF control I/O.   |  |  |
|             | EMIF.ARE/SADS/<br>SDCAS/SRE | O/Z          | G, H, M       | <b>EMIF control pin.</b> Asynchronous memory read-enable (EMIF.ARE) / synchronous memory address strobe (EMIF.SADS)/SDRAM column-address strobe (EMIF.SDCAS)/synchronous read enable (EMIF.SRE) selected when GPIO6 is high at reset.   |  |  |
|             | PGPIO20                     | I/O/Z        |               | Parallel general-purpose I/O 20. PGPIO20 is selected when GPIO6 is low at reset.  |  |  |
| C1          |                             | I/O/Z        | C, D, F,      | EMIF control function [asynchronous memory output-enable (AOE) multiplexed with synchronous memory output-enable (SOE) and SDRAM row address strobe (SDRAS)] or PGPIO21. At reset, GPIO6 is sampled. If GPIO6 is low, C1 is set to PGPIO21 input. If GPIO6 is high, the full EMIF mode is enabled and C1 is set to EMIF control output in high-impedance mode.  |  |  |
|             | EMIF.AOE/SOE/<br>SDRAS      | O/Z          | G, H, M       | <b>EMIF control pin.</b> Asynchronous memory output-enable (EMIF.AOE)/ synchronous memory output-enable (EMIF.SOE)/SDRAM row address strobe (EMIF.SDRAS) selected when GPIO6 is high at reset.  |  |  |
|             | PGPIO21                     | I/O/Z        |               | Parallel general-purpose I/O21. PGPIO21 is selected when GPIO6 is low at reset.   |  |  |

<sup>†</sup> I = Input, O = Output, S = Supply, Z = High impedance

- A Internal pullup (always enabled)
- B Internal pulldown (always enabled)
- C Hysteresis input
- D Pin has bus holder enabled through the External Bus Control Register (XBCR).
- E Pin is high impedance in HOLD mode (due to HOLD pin).
- F Pin is high impedance in OFF mode (due to EMU1/OFF pin).
- G Pin can be configured as a general-purpose input.
- H PIn can be configured as a general-purpose output.
- J Internal pullup enabled through the External Bus Control Register (XBCR)
- K Internal pulldown enabled through the External Bus Control Register (XBCR)
- L Fail-safe pin

SPRS206

M – Pin is in high-impedance during reset (RESET pin is low)

<sup>&</sup>lt;sup>‡</sup>Other Pin Characteristics:

Table 2-3. Signal Descriptions (Continued)

| Pin<br>Name | Multiplexed<br>Signal Name | Pin<br>Type† | Other‡   | Function  |
|-------------|----------------------------|--------------|----------|---|
| Name        | Signal Name                | Турет        |          | Parallel Bus (Continued)  |
| C2          |                            | I/O/Z        | C, D, F, | EMIF control function [Asynchronous memory write-enable (AWE) multiplexed with synchronous memory write-enable (SWE) and SDRAM write-enable (SDWE)] or PGPIO22. At reset, GPIO6 is sampled. If GPIO6 is low, C2 is set to PGPIO22 input. If GPIO6 is high, the full EMIF mode is enabled and C2 is set to EMIF control output in high-impedance mode. |
|             | EMIF.AWE/<br>SWE/SDWE      | O/Z          | G, H, M  | <b>EMIF control pin.</b> Asynchronous memory write-enable (EMIF.AWE)/ synchronous memory write-enable (EMIF.SWE)/SDRAM write-enable (EMIF.SDWE) selected when GPIO6 is high at reset.   |
|             | PGPIO22                    | I/O/Z        |          | Parallel general-purpose I/O22. PGPIO22 is selected when GPIO6 is low at reset.   |
| C3          |                            | I/O/Z        | D, F, G, | EMIF data ready input or PGPIO23. At reset, GPIO6 is sampled. If GPIO6 is low, C3 is set to PGPIO23 input. If GPIO6 is high, the full EMIF mode is enabled and C3 is set to EMIF.ARDY input.  |
|             | EMIF.ARDY                  | ı            | H, J, M  | <b>EMIF data ready.</b> Input used to insert wait states for slow memories. EMIF.ARDY is selected when GPIO6 is high at reset.  |
|             | PGPIO23                    | I/O/Z        | 1        | Parallel general-purpose I/O23. PGPIO23 is selected when GPIO6 is low at reset.   |
| C4          |                            | I/O/Z        | C, D, F, | EMIF chip-select for memory space CE0 or PGPIO24. At reset, GPIO6 is sampled. If GPIO6 is low, C4 is set to PGPIO24 input. If GPIO6 is high, the full EMIF mode is enabled and C4 is set to EMIF.CE0 input.   |
|             | EMIF.CE0                   | O/Z          | G, H, M  | <b>EMIF chip-select for memory space CE0.</b> EMIF. CE0 is selected when GPIO6 is high at reset.  |
|             | PGPIO24                    | I/O/Z        |          | Parallel general-purpose I/O24. PGPIO24 is selected when GPIO6 is low at reset.   |
| C5          |                            | I/O/Z        | C, D, F, | EMIF chip-select for memory space CE1 or PGPIO25. At reset, GPIO6 is sampled. If GPIO6 is low, C5 is set to PGPIO25 input. If GPIO6 is high, the full EMIF mode is enabled and C5 is set to EMIF.CE1 input.   |
|             | EMIF.CE1                   | O/Z          | G, H, M  | <b>EMIF chip-select for memory space CE1.</b> EMIF. CE1 is selected when GPIO6 is high at reset.  |
|             | PGPIO25                    | I/O/Z        |          | Parallel general-purpose I/O 25. PGPIO25 is selected when GPIO6 is low at reset.  |
| C6          |                            | I/O/Z        | C, D, F, | EMIF chip-select for memory space CE2 or PGPIO26. At reset, GPIO6 is sampled. If GPIO6 is low, C6 is set to PGPIO26 input. If GPIO6 is high, the full EMIF mode is enabled and C6 is set to EMIF.CE2 input.   |
|             | EMIF.CE2                   | O/Z          | G, H, M  | <b>EMIF chip-select for memory space CE2.</b> EMIF. CE2 is selected when GPIO6 is high at reset.  |
|             | PGPIO26                    | I/O/Z        |          | Parallel general-purpose I/O 26. PGPIO26 is selected when GPIO6 is low at reset.  |

<sup>†</sup> I = Input, O = Output, S = Supply, Z = High impedance

- A Internal pullup (always enabled)
- B Internal pulldown (always enabled)
- C Hysteresis input
- D Pin has bus holder enabled through the External Bus Control Register (XBCR).
- E Pin is high impedance in HOLD mode (due to HOLD pin).
- F Pin is high impedance in OFF mode (due to EMU1/OFF pin).
- G Pin can be configured as a general-purpose input.
- H Pln can be configured as a general-purpose output.
- J Internal pullup enabled through the External Bus Control Register (XBCR)
- K Internal pulldown enabled through the External Bus Control Register (XBCR)
- L Fail-safe pin
- M Pin is in high-impedance during reset (RESET pin is low)

<sup>‡</sup> Other Pin Characteristics:

Table 2–3. Signal Descriptions (Continued)

| Pin<br>Name | Multiplexed<br>Signal Name | Pin<br>Type† | Other‡   | Function  |  |  |  |
|-------------|----------------------------|--------------|----------|---|--|--|--|
|             | Parallel Bus (Continued)   |              |          |   |  |  |  |
| C7          |                            |              | C, D, F, | EMIF chip-select for memory space CE3 or PGPIO27. At reset, GPIO6 is sampled. If GPIO6 is low, C7 is set to PGPIO27 input. If GPIO6 is high, the full EMIF mode is enabled and C7 is set to EMIF.CE3 input. |  |  |  |
|             | EMIF.CE3                   | O/Z          | G, H, M  | <b>EMIF chip-select for memory space CE3.</b> EMIF. CE3 is selected when If GPIO6 is high at reset.   |  |  |  |
|             | PGPIO27                    | I/O/Z        |          | Parallel general-purpose I/O 27. PGPIO27 is selected when GPIO6 is low at reset.  |  |  |  |
| C8          |                            | I/O/Z        | C, D, F, | EMIF byte-enable 0 or PGPIO28. At reset, GPIO6 is sampled. If GPIO6 is low, C8 is set to PGPIO28 input. If GPIO6 is high, the full EMIF mode is enabled and C8 is set to EMIF.BE0 output.                   |  |  |  |
|             | EMIF.BE0                   | O/Z          | G, H, M  | EMIF byte-enable 0 control. EMIF. BE0 is selected when GPIO6 is high at reset.  |  |  |  |
|             | PGPIO28                    | I/O/Z        |          | Parallel general-purpose I/O 28. PGPIO28 is selected when GPIO6 is low at reset.  |  |  |  |
| C9          |                            | I/O/Z        | C, D, F, | EMIF byte-enable 1 or PGPIO29. At reset, GPIO6 is sampled. If GPIO6 is low, C9 is set to PGPIO29 input. If GPIO6 is high, the full EMIF mode is enabled and C9 is set to EMIF.BE1 output.                   |  |  |  |
|             | EMIF.BE1                   | O/Z          | G, H, M  | EMIF byte-enable 1 control. EMIF.BE1 is selected when GPIO6 is high at reset.   |  |  |  |
|             | PGPIO29                    | I/O/Z        |          | Parallel general-purpose I/O 29. PGPIO29 is selected when GPIO6 is low at reset.  |  |  |  |
| C10         |                            | I/O/Z        | C, D, F, | EMIF byte-enable 2 or PGPIO30. At reset, GPIO6 is sampled. If GPIO6 is low, C10 is set to PGPIO30 input. If GPIO6 is high, the full EMIF mode is enabled and C10 is set to EMIF.BE2 output.                 |  |  |  |
|             | NC                         | O/Z          | G, H, M  | No connect. This pin has no functionality; it should be left unconnected.   |  |  |  |
|             | PGPIO30                    | I/O/Z        |          | Parallel general-purpose I/O 30. PGPIO30 is selected when GPIO6 is low at reset.  |  |  |  |
| C11         |                            | I/O/Z        | C, D, F, | EMIF byte-enable 3 or PGPIO31. At reset, GPIO6 is sampled. If GPIO6 is low, C11 is set to PGPIO31 input. If GPIO6 is high, the full EMIF mode is enabled and C11 is set to EMIF.BE3 output.                 |  |  |  |
|             | NC                         | O/Z          | G, H, M  | No connect. This pin has no functionality; it should be left unconnected.   |  |  |  |
|             | PGPIO31                    | I/O/Z        |          | Parallel general-purpose I/O 31. PGPIO31 is selected when GPIO6 is low at reset.  |  |  |  |
| C12         |                            | I/O/Z        | C, D, F, | EMIF SDRAM clock-enable or PGPIO32. At reset, GPIO6 is sampled. If GPIO6 is low, C12 is set to PGPIO32 input. If GPIO6 is high, the full EMIF mode is enabled and C12 is set to EMIF.SDCKE output.          |  |  |  |
|             | EMIF.SDCKE                 | O/Z          | G, H, M  | EMIF SDRAM clock-enable. EMIF.SDCKE is selected when GPIO6 is high at reset.  |  |  |  |
|             | PGPIO32                    | I/O/Z        |          | Parallel general-purpose I/O32. PGPIO32 is selected when GPIO6 is low at reset.   |  |  |  |

<sup>†</sup> I = Input, O = Output, S = Supply, Z = High impedance

- A Internal pullup (always enabled)
- B Internal pulldown (always enabled)
- C Hysteresis input
- D Pin has bus holder enabled through the External Bus Control Register (XBCR).
- E Pin is high impedance in HOLD mode (due to HOLD pin).
- F Pin is high impedance in OFF mode (due to EMU1/OFF pin).
- G Pin can be configured as a general-purpose input.
- H Pln can be configured as a general-purpose output.
- J Internal pullup enabled through the External Bus Control Register (XBCR)
- K Internal pulldown enabled through the External Bus Control Register (XBCR)
- L Fail-safe pin

SPRS206

M – Pin is in high-impedance during reset (RESET pin is low)

<sup>‡</sup> Other Pin Characteristics:

Table 2-3. Signal Descriptions (Continued)

| Pin<br>Name | Multiplexed<br>Signal Name | Pin<br>Type† | Other‡              | Function  |  |  |
|-------------|----------------------------|--------------|---------------------|---|--|--|
|             | Parallel Bus (Continued)   |              |                     |   |  |  |
| C13         |                            | I/O/Z        | C, D, F,            | EMIF synchronous memory output-enable for CE3 or PGPIO33. At reset, GPIO6 is sampled. If GPIO6 is low, C13 is set to PGPIO33 input. If GPIO6 is high, the full EMIF mode is enabled and C13 is set to EMIF. SOE3 output.                          |  |  |
|             | EMIF.SOE3                  | O/Z          | G, H, M             | <b>EMIF synchronous memory output-enable for CE3</b> (intended for glueless FIFO interface). EMIF.SOE3 is selected when GPIO6 is high at reset.   |  |  |
|             | PGPIO33                    | I/O/Z        |                     | Parallel general-purpose I/O 33. PGPIO33 is selected when GPIO6 is low at reset.  |  |  |
| C14         |                            | I/O/Z        | F, G, H,            | EMIF memory interface Hold request from a host or PGPIO34. At reset, GPIO6 is sampled. If GPIO6 is low, C14 is set to PGPIO34 input. If GPIO6 is high, the full EMIF mode is enabled and C14 is set to EMIF.HOLD input.                           |  |  |
|             | EMIF.HOLD                  | O/Z          | J, M                | Memory interface Hold request. EMIF. HOLD is selected when GPIO6 is high at reset.  |  |  |
|             | PGPIO34                    | I/O/Z        |                     | Parallel general-purpose I/O 34. PGPIO34 is selected when GPIO6 is low at reset.  |  |  |
| C15 I/O/Z   |                            | I/O/Z        | C, D, F,            | EMIF memory interface Hold Acknowledge from the C55x to a Host or PGPIO35. At reset, GPIO6 is sampled. If GPIO6 is low, C15 is set to <u>PGPIO</u> 35 input. If GPIO6 is high, the full EMIF mode is enabled and C15 is set to EMIF.HOLDA output. |  |  |
|             | EMIF.HOLDA                 | O/Z          | G, H, M             | <b>Memory interface Hold Acknowledge.</b> EMIF. HOLDA is selected when GPIO6 is high at reset.  |  |  |
|             | PGPIO35                    | I/O/Z        |                     | Parallel general-purpose I/O 35. PGPIO35 is selected when GPIO6 is low at reset.  |  |  |
| ECLKIN      |                            | 1            | C, L                | <b>External EMIF input clock.</b> When EMIFCLKS = 1 during reset, this pin is configured as the input clock to the EMIF.  |  |  |
| ECLKOUT     | Τ1                         | O/Z          | F, M                | <b>EMIF output clock.</b> Drives EMIF input clock by default. Can be held low or set to high-impedance through the EMIF Global Control Register.  |  |  |
| ECLKOUT     | Т2                         | O/Z          | F                   | <b>EMIF output clock.</b> Set to high-impedance by default. Can be enabled to drive EMIF input clock divided by a factor of 1, 2, or 4 through the EMIF Global Control Register.  |  |  |
| EMIFCLK     | S                          | 1            | C, L                | <b>EMIF input clock source select.</b> If EMIFCLKS = 0 during reset, the internal clock is used by EMIF. If EMIFCLKS = 1 during reset, ECLKIN is used by EMIF.  |  |  |
|             |                            |              |                     | HPI Data Pins   |  |  |
| HD[7:0]     |                            | I/O/Z        | 0.5.5               | HPI data pins HPI.HD[7:0] or PGPIO[43:36]. At reset, GPIO6 is sampled. If GPIO6 is low, HD[7:0] are set to PGPIO[43:36]. If GPIO6 is high, HD[7:0] are set to HPI.HD[7:0].  |  |  |
|             | HPI.HD[7:0]                | O/Z          | C, D, F,<br>G, H, M | Data pins for HPI. HPI.HD[7:0] are selected when GPIO6 is high at reset.  |  |  |
|             | PGPIO[43:36]               | I/O/Z        | G, FI, M            | Parallel general-purpose I/O [43:36]. PGPIO[43:36] are selected when GPIO6 is low at reset.   |  |  |

<sup>†</sup> I = Input, O = Output, S = Supply, Z = High impedance

- A Internal pullup (always enabled)
- B Internal pulldown (always enabled)
- C Hysteresis input
- D Pin has bus holder enabled through the External Bus Control Register (XBCR).
- E Pin is high impedance in HOLD mode (due to HOLD pin).
- F Pin is high impedance in OFF mode (due to EMU1/OFF pin).
- G Pin can be configured as a general-purpose input.
- H Pln can be configured as a general-purpose output.
- J Internal pullup enabled through the External Bus Control Register (XBCR)
- K Internal pulldown enabled through the External Bus Control Register (XBCR)
- L Fail-safe pin
- M Pin is in high-impedance during reset (RESET pin is low)

<sup>&</sup>lt;sup>‡</sup> Other Pin Characteristics:

Table 2–3. Signal Descriptions (Continued)

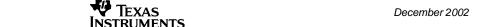
| Pin<br>Name      | Multiplexed<br>Signal Name | Pin<br>Type† | Other‡        | Function   |  |
|------------------|----------------------------|--------------|---------------|--|--|
| HPI Control Pins |                            |              |               |  |  |
| HC0              |                            | I/O/Z        | C, F, G,      | Host address strobe or PGPIO44. At reset, GPIO6 is sampled. If GPIO6 is low, HC0 is set to PGPIO44 input. If GPIO6 is high, HC0 is set to HPI.HAS input.   |  |
|                  | HPI.HAS                    | I            | H, J, M       | Host address strobe. HPI.HAS is selected when GPIO6 is high at reset.  |  |
|                  | PGPIO44                    | I/O/Z        |               | Parallel general-purpose I/O 44. PGPIO44 is selected when GPIO6 is low at reset.   |  |
| HC1              |                            | I/O/Z        | F, G, H,      | HPI host byte identification or PGPIO45. At reset, GPIO6 is sampled. If GPIO6 is low, HC1 is set to PGPIO45 input. If GPIO6 is high, HC1 is set to HPI.HBIL input.   |  |
|                  | HPI.HBIL                   | 1            | K, M          | Host byte identification. HPI.HBIL is selected when GPIO6 is high at reset.  |  |
|                  | PGPIO45                    | I/O/Z        |               | Parallel general-purpose I/O 45. PGPIO45 is selected when GPIO6 is low at reset.   |  |
| HCNTL0           |                            | I/O/Z        | F, J, M       | HPI host control 0   |  |
| HCNTL1           |                            | I/O/Z        | F, J, M       | HPI host control 1   |  |
| HCS              |                            | I/O/Z        | C, F, J,<br>M | HPI host chip-select   |  |
| HR/W             |                            | I/O/Z        | F, J, M       | HPI host read- or write-select   |  |
| HDS1             |                            | 1            | C, J          | Host data strobe 1   |  |
| HDS2             |                            | 1            | C, J          | Host data strobe 2   |  |
| HRDY             |                            | O/Z          | F, J, M       | Host ready   |  |
| HINT O/2         |                            | O/Z          | F, J, M       | Host interrupt   |  |
| HPIENA           |                            | ı            | C, K          | <b>HPI enable.</b> HPIENA must be pulled high and kept high in systems that use the HPI. If the HPI is not needed, HPIENA can be pulled low. An internal pulldown resistor is active on this pin.  |  |
|                  |                            | •            | lni           | tialization, Interrupt, and Reset Pins   |  |
| INT[3:0]         |                            | ı            | C, L          | External user interrupt. INT0–INT3 are maskable interrupts. They are prioritized by the Interrupt Enable Register (IER) and the interrupt mode bit. INT[3:0] can be polled and reset by way of the interrupt flag register.  |  |
| NMI/WDTOUT       |                            | I/O/Z        | C, F, J,<br>M | Non-maskable interrupt input and/or Watchdog Timer output. The function of this pin is controlled by the Timer Signal Selection Register.  |  |
| IACK             |                            | O/Z          | F, M          | Interrupt acknowledge  |  |
| RESET            |                            | ı            | C, L          | Reset. RESET causes the digital signal processor (DSP) to terminate current program execution. When RESET is brought to a high level, program execution begins by fetching the reset interrupt service routine vector at the reset vector address FFFF00h (IVPD:FFFFh). RESET affects various registers and status bits. |  |

<sup>†</sup> I = Input, O = Output, S = Supply, Z = High impedance

- A Internal pullup (always enabled)
- B Internal pulldown (always enabled)
- C Hysteresis input
- D Pin has bus holder enabled through the External Bus Control Register (XBCR).
- E Pin is high impedance in HOLD mode (due to HOLD pin).
- F Pin is high impedance in OFF mode (due to EMU1/OFF pin).
- G Pin can be configured as a general-purpose input.
- H Pln can be configured as a general-purpose output.
- J Internal pullup enabled through the External Bus Control Register (XBCR)
- K Internal pulldown enabled through the External Bus Control Register (XBCR)
- L Fail-safe pin

SPRS206

M – Pin is in high-impedance during reset (RESET pin is low)



<sup>‡</sup> Other Pin Characteristics:

Table 2-3. Signal Descriptions (Continued)

| Pin<br>Name              | Multiplexed<br>Signal Name | Pin<br>Type† | Other‡              | Function  |  |  |
|--------------------------|----------------------------|--------------|---------------------|---|--|--|
|                          | Bit I/O Signals            |              |                     |   |  |  |
| GPIO[7:0]                |                            | I/O/Z        | F, G, H,<br>M       | General-purpose I/O. Eight input/output lines that can be individually configured as inputs or outputs, and can also be individually set or reset when configured as outputs. At reset, the eight pins (GPIO[7:0]) are configured as inputs. These pins are latched with the rising edge of RESET and their state is used to determine the mode of the 5501 (EMIF/HPI mode or PGPIO mode) and boot mode of the bootloader.  GPIO[0–2] are used for boot-mode selection of the bootloader. The GPIO[2:0] pins are sampled at reset and are stored in the BOOT_MOD (0x000F) register.  GPIO4 is used as a function of the clock mode pin. At reset, if GPIO4 is high, the PLL is bypassed with clock running at input clock rate and the oscillator disabled. If GPIO4 is low, the PLL is bypassed with clock rate running at input clock rate and the oscillator enabled. GPIO4 is also used as an output for handshaking purposes on some of the boot modes. Although this pin is not involved in boot mode selection, users should be aware that this pin will become active as an output during the bootload process and should design accordingly. After the bootload is complete, the loaded application may change the function of the GPIO4 pin.  GPIO6 is used to set the modes for the 5501. At reset, if GPIO6 is low, the 5501 is |  |  |
|                          |                            |              |                     | configured in PGPIO mode (the EMIF and HPI are disabled). If GPIO6 is high, the 5501 is configured in EMIF/HPI mode (PGPIO is not available in this mode).  |  |  |
| PGPIO[19                 | :4]                        |              | C, D, F,<br>G, H, M | PGPIO[19:4] or reserved. At reset, if GPIO6 is low at reset, these pins are used as PGPIO[19:4]. If GPIO6 is high, these pins are reserved.   |  |  |
|                          | Reserved                   | I/O/Z        |                     | Reserved pins. These pins are reserved when GPIO6 is low at reset.  |  |  |
|                          | PGPIO[19:4]                |              |                     | Parallel general-purpose I/O. PGPIO[19:4] is selected when GPIO6 is low at reset.   |  |  |
| XF                       |                            | O/Z          | F                   | <b>External output</b> (latched software-programmable signal). XF is set high by the BSET XF instruction, set low by BCLR XF instruction, or by loading ST1. XF is used for signaling other processors in multiprocessor configurations or used as a general-purpose output pin.  |  |  |
| Oscillator/Clock Signals |                            |              |                     |   |  |  |
| CLKOUT                   |                            | O/Z          | F                   | <b>Master clock output signal.</b> CLKOUT can be set to reflect the clock of fast peripherals (DMA, HPI,), slow peripherals (I <sup>2</sup> C, UART,0), or EMIF clock.  |  |  |
| X2/CLKIN                 |                            | I            |                     | Clock/oscillator input. If the internal oscillator is not being used, X2/CLKIN functions as the clock input.  |  |  |
| X1                       |                            | 0            |                     | Output pin from the internal oscillator for the crystal. If the internal oscillator is not used, X1 should be left unconnected.   |  |  |

<sup>†</sup> I = Input, O = Output, S = Supply, Z = High impedance

- A Internal pullup (always enabled)
- B Internal pulldown (always enabled)
- C Hysteresis input
- D Pin has bus holder enabled through the External Bus Control Register (XBCR).
- E Pin is high impedance in HOLD mode (due to HOLD pin).
- F Pin is high impedance in OFF mode (due to EMU1/OFF pin).
- G Pin can be configured as a general-purpose input.
- H PIn can be configured as a general-purpose output.
- J Internal pullup enabled through the External Bus Control Register (XBCR)
- K Internal pulldown enabled through the External Bus Control Register (XBCR)
- L Fail-safe pin
- M Pin is in high-impedance during reset (RESET pin is low)

<sup>&</sup>lt;sup>‡</sup> Other Pin Characteristics:

Table 2-3. Signal Descriptions (Continued)

| Pin<br>Name | Multiplexed<br>Signal Name | Pin<br>Type†  | Other‡  | Function   |  |  |  |
|-------------|----------------------------|---------------|---|--|--|--|--|
|             | Timer Signals              |               |   |  |  |  |  |
| TIMO        |                            | I/O/Z         | F, G, H,<br>M   | Input/Output terminal from Timer 0. When configured as an output, TIMO signals a pulse or a change of state when the on-chip timer count matches its period. When configured as an input, TIMO provides the clock source for the internal timer module. At reset, this pin is configured as input. This pin can also be used as general-purpose I/O. |  |  |  |
| 1 1 IM1     |                            | F, G, H,<br>M | <b>Input/Output terminal from Timer 1.</b> When configured as an output, TIM1 signals a pulse or a change of state when the on-chip timer count matches its period. When configured as an input, TIM1 provides the clock source for the internal timer module. At reset, this pin is configured as input. This pin can also be used as general-purpose I/O. |  |  |  |  |
|             |                            |               | Mult  | cichannel Buffered Serial Port Signals   |  |  |  |
| CLKR0       |                            | I/O/Z         | C, F, G,<br>H, M  | Receive clock input of McBSP0  |  |  |  |
| DR0         |                            | I             | L, G  | Serial data receive input of McBSP0  |  |  |  |
| FSR0        |                            | I/O/Z         | F, G, H,<br>M   | Frame synchronization pulse for receive input of McBSP0  |  |  |  |
| CLKX0       |                            | I/O/Z         | C, F, G,<br>H, M  | Transmit clock of McBSP0   |  |  |  |
| DX0         |                            | O/Z           | F, H, M   | Serial data transmit output of McBSP0  |  |  |  |
| FSX0        |                            | I/O/Z         | F, G, H,<br>M   | Frame synchronization pulse for transmit output of McBSP0  |  |  |  |
| CLKR1       |                            | I/O/Z         | C, G,<br>H, M   | Receive clock input of McBSP1  |  |  |  |
| DR1         |                            | I             | L, G  | Serial data receive input of McBSP1  |  |  |  |
| FSR1        |                            | I/O/Z         | F, G, H,<br>M   | Frame synchronization pulse for receive input of McBSP1  |  |  |  |
| DX1         |                            | O/Z           | F, H, M   | Serial data transmit output of McBSP1  |  |  |  |
| CLKX1       |                            | I/O/Z         | C, F, G,<br>H, M  | Transmit clock of McBSP1   |  |  |  |
| FSX1        |                            | I/O/Z         | F, G, H,<br>M   | Frame synchronization pulse for transmit output of McBSP1  |  |  |  |

<sup>†</sup> I = Input, O = Output, S = Supply, Z = High impedance

- A Internal pullup (always enabled)
- B Internal pulldown (always enabled)
- C Hysteresis input
- D Pin has bus holder enabled through the External Bus Control Register (XBCR).
- E Pin is high impedance in HOLD mode (due to HOLD pin).
- F Pin is high impedance in OFF mode (due to EMU1/OFF pin).
- G Pin can be configured as a general-purpose input.
- H PIn can be configured as a general-purpose output.
- J Internal pullup enabled through the External Bus Control Register (XBCR)
- K Internal pulldown enabled through the External Bus Control Register (XBCR)
- L Fail-safe pin

SPRS206

M – Pin is in high-impedance during reset (RESET pin is low)

<sup>&</sup>lt;sup>‡</sup>Other Pin Characteristics:

Table 2-3. Signal Descriptions (Continued)

| Pin<br>Name | Multiplexed<br>Signal Name  | Pin<br>Type†   | Other‡  | Function   |  |  |  |
|-------------|---|--|---|--|--|--|--|
|             | UART  |  |   |  |  |  |  |
| TX          | X O UART transmit data output   |  | UART transmit data output   |  |  |  |  |
| RX          |   | I  |   | UART receive data input  |  |  |  |
|             |   |  |   | I <sup>2</sup> C Pins  |  |  |  |
| SCL         |   | I/O/Z  | C, F, M   | I <sup>2</sup> C clock bidirectional port. (Open collector I/O)  |  |  |  |
| SDA         |   | I/O/Z  | C, F, M   | I <sup>2</sup> C data bidirectional port. (Open collector I/O)   |  |  |  |
|             |   |  |   | Supply Pins  |  |  |  |
| $V_{SS}$    |   | S  |   | Digital Ground. Dedicated ground for the device.   |  |  |  |
| $CV_{DD}$   |   | S  |   | <b>Digital Power, + V</b> <sub>DD</sub> . Dedicated power supply for the core CPU.   |  |  |  |
| $PV_{DD}$   |   | S  |   | <b>Digital Power, + V</b> <sub>DD</sub> . Dedicated power supply for the PLL module.   |  |  |  |
| PSENSE      |   |  |   | For test purposes only. Must be left unconnected.  |  |  |  |
| $DV_{DD}$   | V <sub>DD</sub> S <b>Digital Power</b> , + V <sub>DD</sub> . Dedicated power supply for the I/O pins. |  | Digital Power, + V <sub>DD</sub> . Dedicated power supply for the I/O pins. |  |  |  |  |
|             |   |  |   | Test Pins  |  |  |  |
| тск         |   | I  | C, J  | IEEE standard 1149.1 test clock. TCK is normally a free-running clock signal with a 50% duty cycle. The changes on test access port (TAP) of input signals TMS and TDI are clocked into the TAP controller, instruction register, or selected test data register on the rising edge of TCK. Changes at the TAP output signal (TDO) occur on the falling edge of TCK. |  |  |  |
| TDI         |   | IEEE standard 1149.1 test data input. Pin with internal pullup device. TDI is clocked into |   | <b>IEEE standard 1149.1 test data input.</b> Pin with internal pullup device. TDI is clocked into the selected register (instruction or data) on a rising edge of TCK.   |  |  |  |
| TDO         |   | O/Z  |   | <b>IEEE standard 1149.1 test data output.</b> The contents of the selected register (instruction or data) are shifted out of TDO on the falling edge of TCK. TDO is in the high-impedance state except when the scanning of data is in progress.   |  |  |  |
| TMS         |   | I  | J   | <b>IEEE standard 1149.1 test mode select.</b> Pin with internal pullup device. This serial control input is clocked into the TAP controller on the rising edge of TCK.   |  |  |  |
| TRST        |   | I  | C, L, K   | <b>IEEE standard 1149.1 test reset.</b> TRST, when high, gives the IEEE standard 1149.1 scan system control of the operations of the device. If TRST is not connected or driven low, the device operates in its functional mode, and the IEEE standard 1149.1 signals are ignored. Pin with internal pulldown device.  |  |  |  |

 $<sup>^{\</sup>dagger}$ I = Input, O = Output, S = Supply, Z = High impedance

- A Internal pullup (always enabled)
- B Internal pulldown (always enabled)
- C Hysteresis input
- D Pin has bus holder enabled through the External Bus Control Register (XBCR).
- E Pin is high impedance in HOLD mode (due to HOLD pin).
- F Pin is high impedance in OFF mode (due to EMU1/OFF pin).
- G Pin can be configured as a general-purpose input.
- H PIn can be configured as a general-purpose output.
- J Internal pullup enabled through the External Bus Control Register (XBCR)
- K Internal pulldown enabled through the External Bus Control Register (XBCR)
- L Fail-safe pin
- M Pin is in high-impedance during reset (RESET pin is low)

<sup>‡</sup> Other Pin Characteristics:

#### Table 2-3. Signal Descriptions (Continued)

| Pin<br>Name                           | Multiplexed<br>Signal Name | Pin<br>Type†  | Other‡ | Function  |
|---------------------------------------|----------------------------|---|--------|---|
|                                       |                            |   |        | Test Pins (Continued)   |
| · · · · · · · · · · · · · · · · · · · |                            | Emulator 0 pin. When TRST is driven low, EMU0 must be high for activation of the OFF condition. When TRST is driven high, EMU0 is used as an interrupt to or from the emulator system and is defined as I/O by way of the IEEE standard 1149.1 scan system. |        |   |
| EMU1/OFI                              | ₹                          | I/O/Z   | J      | Emulator 1 pin/disable all outputs. When TRST is driven high, EMU1/OFF is used as an interrupt to or from the emulator system and is defined as I/O by way of IEEE standard 1149.1 scan system. When TRST is driven low, EMU1/OFF is configured as OFF. The EMU1/OFF signal, when active (low), puts all output drivers into the high-impedance state. Note that OFF is used exclusively for testing and emulation purposes (not for multiprocessing applications). Therefore, for the OFF condition, the following apply:  TRST = low,  EMU0 = high,  EMU1/OFF = low |

 $<sup>\</sup>dagger$  I = Input, O = Output, S = Supply, Z = High impedance

- A Internal pullup (always enabled)
- B Internal pulldown (always enabled)
- C Hysteresis input
- D Pin has bus holder enabled through the External Bus Control Register (XBCR).
- E Pin is high impedance in HOLD mode (due to HOLD pin).
- F Pin is high impedance in OFF mode (due to EMU1/OFF pin).
- G Pin can be configured as a general-purpose input.
- H Pln can be configured as a general-purpose output.
- J Internal pullup enabled through the External Bus Control Register (XBCR)
- K Internal pulldown enabled through the External Bus Control Register (XBCR)
- L Fail-safe pin
- M Pin is in high-impedance during reset (RESET pin is low)



<sup>&</sup>lt;sup>‡</sup>Other Pin Characteristics:

## 3 Functional Overview

The following functional overview is based on the block diagram in Figure 3–1.

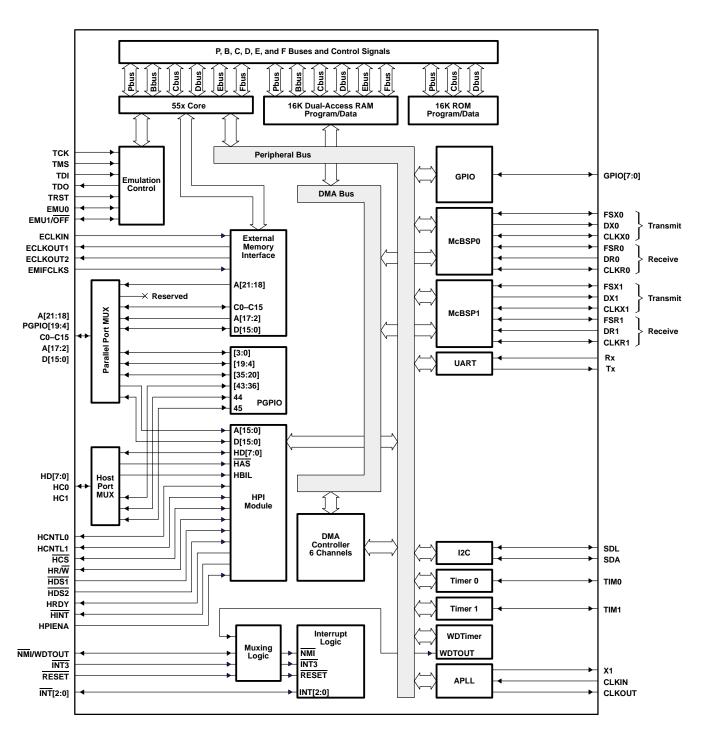


Figure 3-1. Block Diagram of the TMS320VC5501

#### 3.1 Memory

The 5501 supports a unified memory map (program and data accesses are made to the same physical space). The total on-chip memory is 32K words (16K 16-bit words of RAM and 16K 16-bit words of ROM).

#### 3.1.1 On-Chip ROM

TMS320VC5501 incorporates 16K x16-bit of on-chip, one-wait-state maskable ROM that can be mapped into program memory space. The ROM contains a bootloader program to facilitate system initialization. This bootloader can be used to automatically transfer user code from an external source to anywhere in the program memory at power up. The ROM can be masked.

The on-chip ROM is located at the byte address range FF8000h–FFFFFFh when bit MP/MC = 0. It can be accessed by the program bus and the three read data buses P, C, and D. The on-chip ROM is a one-cycle-per-word memory access, except for the first word access, which requires two cycles.

When MP/MC = 1 at reset, the on-chip ROM is disabled and not present in the memory map, and byte address range FF8000h–FFFFFFh is directed to external memory space. The status of the MP/MC bit (located in the ST3\_55 status register) is determined by the logic level on the BOOTM[2:0] pins when sampled at reset. If BOOTM[2:0] is set to 00h, the MP/MC bit is set to 1 and the on-chip ROM is disabled. Otherwise, the MP/MC bit is cleared to 0 and the on-chip ROM is enabled. These pins are not sampled again until the next hardware reset. The software reset instruction does not affect the MP/MC bit. Software can also be used to set or clear the MP/MC bit.

The Bootloader mode selection is determined by the logic level on the GPIO[2:0] pins when sampled at reset. A branch instruction to the start of the Bootloader program is contained at FF8000h. TMS320VC5501 provides different ways to download the code to accommodate various system requirements:

- Parallel boot from 16-bit asynchronous memory connected to the EMIF at 200000h
- Serial boot from McBSP0 (McBSP0 in SPI mode or standard mode)
- Host-port interface boot load in multiplexed mode
- I<sup>2</sup>C boot load
- UART boot load

The standard on-chip ROM layout is shown in Table 3-1.

Table 3-1. On-Chip ROM Layout

| STARTING BYTE ADDRESS | CONTENTS               |
|-----------------------|------------------------|
| FF_8000h              | Bootloader program     |
| FF_ECB0h              | Boot Mode Branch Table |
| FF_ED00h              | Sine Table             |
| FF_EF00h              | Factory Test Code      |
| FF_FF00h              | Interrupt Vector Table |
| FF_FFFCh              | ID Code                |

## 3.1.2 On-Chip Dual-Access RAM (DARAM)

TMS320VC5501 features 16K x 16-bit (32K bytes) of on-chip dual-access RAM. This memory enhances system performance, since the C55x CPU can access a DARAM block twice per machine cycle. The DARAM is composed of 4 blocks of 4K x 16-bit each (see Table 3–2). Each block in the DARAM can support two reads in one cycle, a read and a write in one cycle, or two writes in one cycle. The dual-access RAM is located in the (byte) address range 000000h–00FFFFh, it can be accessed by the program, data and DMA buses. The HPI has NO access to the DARAM block when device is in reset.

Table 3-2. DARAM Blocks

| BYTE ADDRESS RANGE | MEMORY BLOCK |
|--------------------|--------------|
| 000000h – 001FFFh  | DARAM 0      |
| 002000h – 003FFFh  | DARAM 1      |
| 004000h – 005FFFh  | DARAM 2      |
| 006000h - 007FFFh  | DARAM 3      |

# 3.1.3 Memory Map

| 000000h | DARAM0<br>(8K Bytes)                                     | 000000h  | DARAM0<br>(8K Bytes)                                     |
|---------|--|----------|--|
| 002000h | DARAM1<br>(8K Bytes)                                     | 002000h  | DARAM1<br>(8K Bytes)                                     |
| 004000h | DARAM2<br>(8K Bytes)                                     | 004000h  | DARAM2<br>(8K Bytes)                                     |
| 006000h | DARAM3<br>(8K Bytes)                                     | 006000h  | DARAM3<br>(8K Bytes)                                     |
| 008000h |  | 008000h  |  |
| 010000h | Reserved   | 010000h  | Reserved   |
| •••••   | External CE0 Space<br>(4M minus 64K Bytes <sup>†</sup> ) | 01000011 | External CE0 Space<br>(4M minus 64K Bytes <sup>†</sup> ) |
| 400000h | External CE1 Space<br>(4M Bytes)                         | 400000h  | External CE1 Space<br>(4M Bytes)                         |
| 800000h | External CE2 Space<br>(4M Bytes)                         | 800000h  | External CE2 Space<br>(4M Bytes)                         |
| C00000h | External CE3 Space<br>(4M Bytes Minus 32K Bytes)‡        | C00000h  | External CE3 Space                                       |
| FF8000h | ROM<br>(32K Bytes)                                       |          | (4M Bytes)   |
| •       | MP/MC = 0  | -        | MP/MC = 1  |

<sup>†</sup> The lower 64K bytes in CE0 Space include 32K bytes of DARAM space and 32K bytes of reserved space. ‡ The 32K bytes are for on-chip ROM block.

20

SPRS206

Figure 3-2. TMS320VC5501 Memory Map

#### 3.1.4 Boot Configuration

The on-chip bootloader provides a way to transfer application code and tables from an external source to the on-chip RAM at power up. The 5501 provides several options to download the code to accommodate varying system requirements. These options include:

- Host-port interface (HPI) boot in multiplexed mode
- External memory boot (via EMIF) from 16-bit asynchronous memory
- Serial port boot (from McBSP0) with 16-bit element length
- SPI EPROM boot (from McBSP0) supporting EPROMs with 24-bit addresses
- I<sup>2</sup>C EPROM boot (from I<sup>2</sup>C) supporting EPROMs larger than 512K bits
- UART boot
- Direct execution (no boot) from 16-bit external asynchronous memory

The external pins BOOTM2, BOOTM1, and BOOTM0 select the boot configuration. The values of BOOTM[2:0] are latched with the rising edge of the RESET input. BOOTM2 is shared with GPIO2, BOOTM1 is shared with GPIO1, and BOOTM0 is shared with GPIO0.

The boot configurations available are summarized in Table 3–3.

Table 3–3. Boot Configuration Selection Via the BOOTM[2:0] Pins

| BOOTM[2:0] | BOOT PROCESS  |
|------------|---|
| 000        | Direct execution from 16-bit external asynchronous memory       |
| 001        | SPI EPROM boot  |
| 010        | Serial port boot (from McBSP0)                                  |
| 011        | External memory boot (via EMIF) from 16-bit asynchronous memory |
| 100        | Reserved  |
| 101        | HPI boot  |
| 110        | I <sup>2</sup> C EPROM boot                                     |
| 111        | UART boot   |

#### 3.2 Peripherals

The 5501 includes the following on-chip peripherals:

- An external memory interface (EMIF)<sup>†</sup> supporting a 16-bit interface to asynchronous memory, SDRAM, and SBSRAM
- An 8-bit host-port interface (HPI)
- A six-channel direct memory access (DMA) controller
- Two multichannel buffered serial ports (McBSPs)
- A programmable analog phase-locked loop (APLL) clock generator
- General-purpose I/O (GPIO) pins and a dedicated output pin (XF)

- EMIF/HPI mode: 16-bit external memory interface with 8-bit (multiplexed) host-port interface
- PGPIO mode: PGPIO support with no external memory interface and no host-post interface

<sup>†</sup> The 5501 can be configured as follows:

- Four timers
  - Two 64-bit general-purpose timers
  - A programmable watchdog timer
  - A DSP/BIOS timer
- An Inter-integrated Circuit (I<sup>2</sup>C) multi-master and slave interface
- A Universal Asynchronous Receiver/Transmitter (UART)

For detailed information on the C55x DSP peripherals, see the following documents:

- TMS320C55x™ DSP Functional Overview (literature number SPRU312)
- TMS320C55x DSP Peripherals Reference Guide (literature number SPRU317)

## 3.3 Configurable External Ports and Signals

A number of pins on the 5501 have two functions, a feature that allows system designers to choose an appropriate media interface for his/her application without the need for a large pin-count package. Two muxes are included in the 5501 to control the configuration of these dual-function pins: the Parallel Port Mux and the Host Port Mux. The state of these muxes is set at reset based on the state of the GPIO6 pin. The External Bus Selection Register (XBSR) shows the configuration of these muxes after the 5501 comes out of reset.

#### 3.3.1 Parallel Port Mux

The Parallel Port Mux of the 5501 controls the function of 20 address signals (pins A[21:2]), 16 data signals (pins D[15:0]), and 16 control signals (pins C0 through C15). The Parallel Port Mux supports two different modes:

- **Full EMIF mode:** The EMIF is enabled and its 20 address, 16 data, and 16 control signals are routed to their corresponding pins on the Parallel Port Mux.
- Parallel general-purpose I/O mode: The EMIF and HPI are disabled and 16 control and 4 address pins
  of the Parallel Port Mux are set to parallel general-purpose I/O (PGPIO).

The mode of the Parallel Port Mux is determined by the state of the GPIO6 pin at reset. If GPIO6 is low, the EMIF and the HPI will be disabled: pins A[17:2] and pins D[15:0] will become reserved pins. All other pins in the Parallel Port Mux are set to parallel general-purpose I/O. The Parallel/Host Port Mux Mode bit field in the External Bus Selection Register (XBSR) will also be set to 0 to reflect the PGPIO mode of the Parallel Port Mux.

If GPIO6 is high at reset, the HPI will be enabled in multiplexed mode and the EMIF will be fully enabled: pins A[21:2] are set to EMIF.A[21:2], pins D[15:0] are set to EMIF[31:0], and pins C[15:0] are set to their corresponding EMIF operation. The Parallel/Host Port Mux Mode bit field in the XBSR will be set to 1 to reflect the full EMIF mode of the Parallel Port Mux. Note that in multiplexed mode, the HPI will use the HD[7:0] pins to strobe in address and data information (see Section 3.7, Host-Port Interface (HPI), for more information on the operation of the HPI in multiplexed mode).



Table 3–4 lists the individual routing of the EMIF and PGPIO signals to the external parallel address, data, and control buses.

Table 3-4. TMS320VC5501 Routing of Parallel Port Mux Signals

| PIN         | PARALLEL PORT MUX MODE = 0 (PGPIO) | PARALLEL PORT MUX MODE = 1<br>(FULL EMIF) |  |  |  |  |
|-------------|------------------------------------|---|--|--|--|--|
| Address Bus |                                    |   |  |  |  |  |
| A[17:2]     | Reserved                           | EMIF.A[17:2]                              |  |  |  |  |
| A[21:18]    | PGPIO[3:0]                         | EMIF.A[21:18]                             |  |  |  |  |
| Data Bus    |                                    |   |  |  |  |  |
| D[15:0]     | Reserved                           | EMIF.D[15:0]                              |  |  |  |  |
| Control Bus |                                    |   |  |  |  |  |
| C0          | PGPIO20                            | EMIF.ARE/SADS/SDCAS/SRE                   |  |  |  |  |
| C1          | PGPIO21                            | EMIF.AOE/SOE/SDRAS                        |  |  |  |  |
| C2          | PGPIO22                            | EMIF.AWE/SWE/SDWE                         |  |  |  |  |
| C3          | PGPIO23                            | EMIF.ARDY                                 |  |  |  |  |
| C4          | PGPIO24                            | EMIF.CE0                                  |  |  |  |  |
| C5          | PGPIO25                            | EMIF.CE1                                  |  |  |  |  |
| C6          | PGPIO26                            | EMIF.CE2                                  |  |  |  |  |
| C7          | PGPIO27                            | EMIF.CE3                                  |  |  |  |  |
| C8          | PGPIO28                            | EMIF.BE0                                  |  |  |  |  |
| C9          | PGPIO29                            | EMIF.BE1                                  |  |  |  |  |
| C10         | PGPIO30                            | EMIF.BE2                                  |  |  |  |  |
| C11         | PGPIO31                            | EMIF.BE3                                  |  |  |  |  |
| C12         | PGPIO32                            | EMIF.SDCKE                                |  |  |  |  |
| C13         | PGPIO33                            | EMIF.SOE3                                 |  |  |  |  |
| C14         | PGPIO34                            | EMIF.HOLD                                 |  |  |  |  |
| C15         | PGPIO35                            | EMIF.HOLDA                                |  |  |  |  |

#### 3.3.2 Host Port Mux

The 5501 Host Port Mux controls the function of 8 data signals (pins HD[7:0]) and 2 control signals (pins HC0 and HC1). The Host Port Mux supports two different modes:

- 8-bit multiplexed mode: The HPI's 8 data and 2 control signals are routed to their corresponding pins on the Host Port Mux.
- Parallel general-purpose I/O mode: All pins on the Host Port Mux are routed to PGPIO. The HPI and EMIF are disabled.

The mode of the Host Port Mux is determined by the state of the GPIO6 pin at reset. If GPIO6 is low, the pins of the Host Port Mux will be set to PGPIO. In this mode, the EMIF and the HPI will be disabled. The Parallel/Host Port Mux Mode bit of the External Bus Control Register will be set to 0 to reflect the PGPIO mode of the Host Port Mux.

If GPIO6 is high, the HPI will be enabled in 8-bit (multiplexed) mode: pins HD[7:0] are set to HPI.HD[7:0], and HC0 and HC1 are set to HPI.HAS and HPI.HBIL, respectively. The Parallel/Host Port Mux Mode bit field in the XBSR will be set to 1 to reflect the HPI multiplexed mode of the Host Port Mux. See Section 3.7, Host-Port Interface (HPI), for more information on the operation of the HPI in multiplexed mode.

Table 3–5 lists the individual routing of the HPI and PGPIO signals to the Host Port Mux pins.

Table 3–5. TMS320VC5501 Routing of Host Port Mux Signals

| PIN         | HOST PORT MUX MODE = 0<br>(PGPIO) | HOST PORT MUX MODE = 1<br>(8-BIT HPI MULTIPLEXED) |  |  |
|-------------|-----------------------------------|---|--|--|
| Data Bus    |                                   |   |  |  |
| HD[7:0]     | PGPIO[43:36]                      | HPI.HD[7:0]                                       |  |  |
| Control Bus |                                   |   |  |  |
| HC0         | PGPIO44                           | HPI.HAS   |  |  |
| HC1         | PGPIO45                           | HPI.HBIL  |  |  |

# 3.3.3 External Bus Selection Register (XBSR)

The External Bus Selection Register controls the mode of the Parallel Port Mux and Host Port Mux. The Parallel Port Mux can be configured to support the 16-bit EMIF or to support parallel general-purpose I/O. The Host Port Mux can be configured to support the HPI in 8-bit (multiplexed) mode or parallel general-purpose I/O (PGPIO).

The XBSR configures the Parallel Port Mux and the Host Port Mux at reset based on the state of the GPIO6 pin at reset. When GPIO6 is high at reset, the Parallel Port Mux will be configured to support the 16-bit EMIF and the Host Port Mux will be configured to support the HPI in 8-bit (multiplexed) mode. When GPIO6 is low at reset, both the Parallel Port Mux and the Host Port Mux will be configured to support parallel general-purpose I/O; the EMIF and HPI will be disabled in this mode. The Paralle/Host Port Mux Mode bit of the XBSR will reflect the mode selected for the Parallel and Host Port Muxes.†

The clock to the EMIF module is disabled automatically when this module is not selected through the External Bus Selection Register. Note that any accesses to disabled modules will result in a bus error if the PERITOEN bit of the Time-Out Control Register is set to 1.

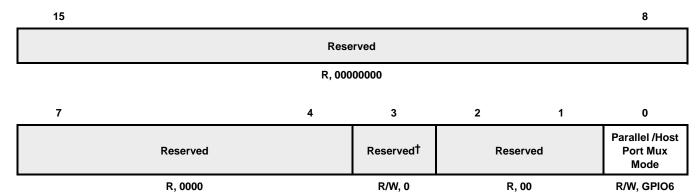


Figure 3-3. External Bus Selection Register Layout (0x6C00)

<sup>†</sup>This reserved bit must be kept as zero during any writes to XBSR.

<sup>†</sup> Modifying the XBSR to change the mode of the Parallel Port Mux and Host Port Mux after the 5501 has been brought out of reset is *not* recommended.

Table 3-6. External Bus Selection Register Bit Field Description

| BIT NAME                       | BIT NO. | ACCESS | RESET VALUE | DESCRIPTION  |  |
|--------------------------------|---------|--------|-------------|--|--|
| Reserved                       | 15–4    | R      | 00000000000 | Reserved   |  |
| Reserved                       | 3       | R/W    | 0           | Reserved. This reserved bit must be kept as zero during any write to XBSR.   |  |
| Reserved                       | 2–1     | R      | 00          | Reserved   |  |
| Parallel/Host Port<br>Mux Mode | 0       | R/W    | GPIO6       | Parllel/Host Port Mux Mode bit. Determines the mode of the Parallel Port Mux and the Host Port Mux.  Parallel/Host Port Mux Mode = 0: The Parallel Port Mux is configured to support PGPIO. In this mode, the HPI and EMIF cannot be used. The Host Port Mux is configured to support PGPIO. In this mode, the Host Port Mux pins will be routed to PGPIO.  Parallel/Host Port Mux Mode = 1: The Parallel Port Mux is configured to support the 16-bit EMIF. In this mode, the EMIF is enabled and its 20 address, 16 data, and 16 control signals are routed to their corresponding pins on the Parallel Port Mux. The Host Port Mux is configured to support the HPI in 8-bit (multiplexed) mode. In this mode, the HPI is enabled and its eight data/address and two control signals are routed to their corresponding pins on the Host Port Mux. |  |

### 3.4 Timers

The 5501 has four 64-bit timers: Timer 0, Timer 1, Watchdog Timer (WDT), and Timer 3. The input/output pin of Timer 0, Timer 1, and the Watchdog Timer can be configured as an input or an output via the Timer Signal Selection Register (TSSR). Furthermore, the TSSR can be used to connect the Watchdog Timer output to NMI, RESET, or INT3.

- The first two timers, Timer 0 and Timer 1, are mainly used as general-purpose timers.
- The third timer, the Watchdog Timer, can be used as either a general-purpose timer or a watchdog timer. The output pin of the Watchdog Timer, WDTOUT, is multiplexed with the NMI input pin; its function can be controlled via the NMI/WDTOUT\_CFG bit of the TSSR. If the NMI/WDTOUT pin is configured as the Watchdog Timer pin, it can be configured as an input or an output via the WDT\_MODE bit of the TSSR. The Watchdog Timer output can also be internally connected to the NMI, RESET, and NT3 signals of the 5501 via the IWCON bits of the TSSR.
- The fourth timer is reserved as a DSP/BIOS counter. This timer has no input or output pin. No interrupts are needed from this timer; therefore, the timer output is not internally connected to the CPU interrupt logic.

# 3.4.1 Timer Signal Selection Register (TSSR)

The Timer Signal Selection Register (TSSR) controls several pin characteristics for Timer 0, Timer 1, and the Watchdog Timer. The TSSR can be used to specify whether the pins of Timer 0, Timer 1, and the Watchdog Timer are input or output. The TSSR also determines how the output signal of the Watchdog Timer is connected internally and sets the function for the  $\overline{\text{NMI}}/\text{WDTOUT}$  pin of the 5501. By default, all the timer pins (TIM0, TIM1, and  $\overline{\text{NMI}}/\text{WDTOUT}$ ) are set as inputs, the output of the Watchdog Timer is not internally connected to anything, and the  $\overline{\text{NMI}}/\text{WDTOUT}$  pin has the function of the  $\overline{\text{NMI}}$  signal.

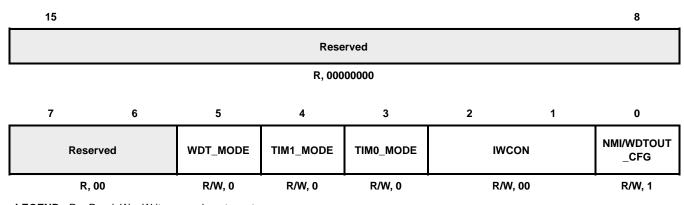


Figure 3-4. Timer Signal Selection Register Layout (0x8000)

Table 3-7. Timer Signal Selection Register Bit Field Description

| BIT NAME  | BIT NO. | ACCESS | RESET VALUE | DESCRIPTION  |
|-----------|---------|--------|-------------|--|
| Reserved  | 15–6    | R      | 000000000   | Reserved   |
| WDT_MODE  | 5       | R/W    | 0           | WDT pin mode   |
|           |         |        |             | WDT_MODE = 0: WDTOUT pin is used as the timer input pin.   |
|           |         |        |             | WDT_MODE = 1: WDTOUT pin is used as the timer output pin.  |
| TIM1_MODE | 4       | R/W    | 0           | TIM1 pin mode  |
|           |         |        |             | TIM1_MODE = 0: TIM1 pin is used as the timer input pin. TIM1_MODE = 1: TIM1 pin is used as the timer output pin. |
| TIM0_MODE | 3       | R/W    | 0           | TIM0 pin mode  |
|           |         |        |             | TIM0_MODE = 0: TIM0 pin is used as the timer input pin. TIM0_MODE = 1: TIM0 pin is used as the timer output pin. |

<sup>†</sup> If NMI/WDTOUT\_CFG = 1 and IWCON = 10, only the WDTOUT signal will drive the NMI signal; the external source driving the NMI/WDTOUT pin will be ignored (see Figure 3–5).

Table 3-7. Timer Signal Selection Register Bit Field Description (Continued)

| BIT NAME       | BIT NO. | ACCESS | RESET VALUE | DESCRIPTION  |
|----------------|---------|--------|-------------|--|
| IWCON          | 2:1     | R/W    | 00          | Internal WDT output signal connection  |
|                |         |        |             | IWCON = 00: Internal watchdog timer output signal has no internal connection.              |
|                |         |        |             | IWCON = 01: Internal watchdog timer output signal has an internal connection to RESET pin. |
|                |         |        |             | IWCON = 10: Internal watchdog timer output signal has an internal connection to NMI pin.†  |
|                |         |        |             | IWCON = 11: Internal watchdog timer output signal has an internal connection to INT3 pin.  |
| NMI/WDTOUT_CFG | 0       | R/W    | 1           | NMI/WDTOUT configuration   |
|                |         |        |             | NMI/WDTOUT_CFG = 0: NMI/WDTOUT pin is used as the WDTOUT pin.                              |
|                |         |        |             | NMI/WDTOUT_CFG = 1: $\frac{\overline{NMI}}{\overline{NMI}}$ input pin. †                   |

<sup>†</sup> If NMI/WDTOUT\_CFG = 1 and IWCON = 10, only the WDTOUT signal will drive the NMI signal; the external source driving the NMI/WDTOUT pin will be ignored (see Figure 3–5).

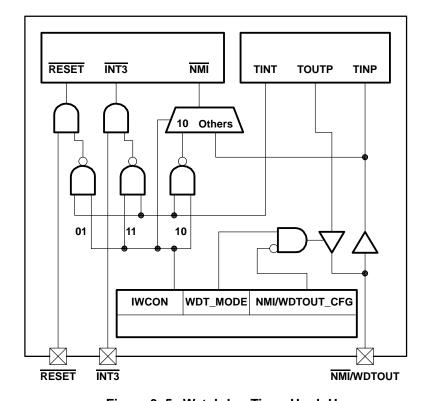


Figure 3-5. Watchdog Timer Hook-Up

# 3.5 Universal Asynchronous Receiver/Transmitter (UART)

The UART peripheral is based on the industry-standard TL16C550B asynchronous communications element, which in turn, is a functional upgrade of the TL16C450. Functionally similar to the TL16C450 on power up (character or TL16C450 mode), the UART can be placed in an alternate FIFO (TL16C550) mode. This relieves the CPU of excessive software overhead by buffering received and transmitted characters. The receiver and transmitter FIFOs store up to 16 bytes, including three additional bits of error status per byte for the receiver FIFO.

The UART performs serial-to-parallel conversions on data received from a peripheral device or modem and parallel-to-serial conversion on data received from the CPU. The CPU can read the UART status at any time. The UART includes control capability and a processor interrupt system that can be configured to minimize software management of the communications link.

The UART includes a programmable baud rate generator capable of dividing the CPU clock by divisors from 1 to 65535 and producing a 16× reference clock for the internal transmitter and receiver logic.

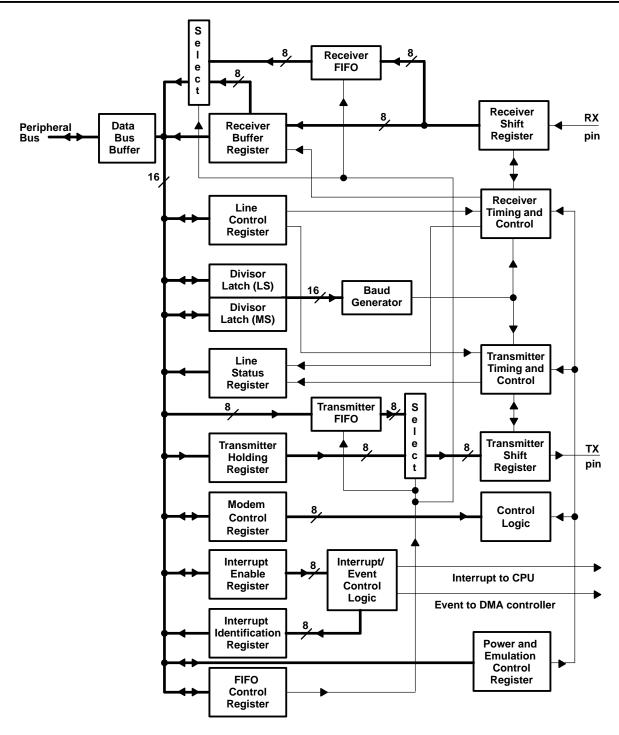


Figure 3-6. UART Functional Block Diagram

# 3.6 Inter-Integrated Circuit (I<sup>2</sup>C) Module

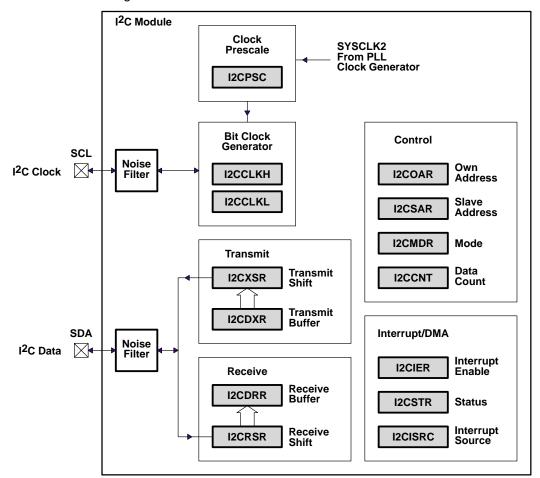
The TMS320VC5501 also includes an I<sup>2</sup>C serial port for control purposes. Features of the I<sup>2</sup>C port include:

- Compatibility with Philips™ I<sup>2</sup>C-Bus™ Specification, Version 2.1 (January 2000)
- Fast mode up to 400 Kbps (no fail-safe I/O buffers)
- Noise filters (on the SDA and SCL pins) to suppress noise of 50 ns or less (I<sup>2</sup>C module clock *must* be in the range of 7 MHz to 12 MHz)
- 7-bit and 10-bit device addressing modes
- Master (transmit/receive) and slave (transmit/receive) functionality
- Events: DMA, interrupt, or polling
- Slew-rate limited open-drain output buffers

The I<sup>2</sup>C module clock *must* be in the range of 7 MHz to 12 MHz. This is necessary for the proper operation of the I<sup>2</sup>C module.

**NOTE:** For additional information, see *TMS320C55x DSP Peripherals Reference Guide* (literature number SPRU317).

Figure 3–7 is a block diagram of the I<sup>2</sup>C module.



NOTE A: Shading denotes control/status registers.

Figure 3-7. I<sup>2</sup>C Module Block Diagram

Philips and I<sup>2</sup>C Bus are trademarks of Koninklijke Philips Electronics N.V.

## 3.7 Host-Port Interface (HPI)

The 5501 HPI provides an 8-bit parallel interface (multiplexed mode) to a host with the following features:

- Host access to on-chip DARAM (excluding CPU memory-mapped registers)
- 16-bit address register with autoincrement capability for faster transfers
- Multiple address/data strobes provide a glueless interface to a variety of hosts
- HRDY signal for handshaking with host

The 5501 HPI can access all of internal DARAM space excluding memory-mapped CPU registers (which are located at word addresses 0x0000–0x0059), but it cannot access peripheral registers or external memory. Note that all memory accesses made through the HPI are word-addressed. The HPI cannot access internal DARAM space when the device is in reset.

The 5501 HPI only supports data transfers in multiplexed 8-bit mode. In multiplexed mode, the host can only send 8 bits of data at a time through the HD[7:0] bus; therefore, some extra steps have to be taken to read/write from the 5501's internal memory [see the *TMS320C55x DSP Peripherals Reference Guide* (literature number SPRU317) for more information on the 5501 HPII.

**NOTE:** No host access should occur when the HPI is placed in IDLE. The host cannot wake up the DSP through the DSP\_INT bit of the HPIC1 register when the DSP is in IDLE mode.

The 5501 HPI has its own register set, therefore the HINT bit of CPU register ST3\_55 is not used for DSP-to-host interrrupts. The HINT bit in the Host Port Control Register (HPIC) should be used for DSP-to-host interrupts.



# 3.8 Direct Memory Access (DMA) Controller

The 5501 DMA provides the following features:

- Four standard ports for the following data resources: two for DARAM, one for Peripherals, and one for External Memory
- Six channels, which allow the DMA controller to track the context of six independent DMA channels
- Programmable low/high priority for each DMA channel
- One interrupt for each DMA channel
- Event synchronization. DMA transfers in each channel can be dependent on the occurrence of selected events.
- Programmable address modification for source and destination addresses
- Idle mode that allows the DMA controller to be placed in a low-power (idle) state under software control

The 5501 has an Auto-wakeup/Idle function for McBSP to DMA to on-chip memory data transfers when the DMA and the McBSP are both set to IDLE. In the case that the McBSP is set to external clock mode and the McBSP and the DMA are set to idle, the McBSP and the DMA can wake up from IDLE state automatically if the McBSP gets a new data transfer. The McBSP and the DMA enter the idle state automatically after data transfer is complete. [The clock generator (PLL) should be active and the PLL core should not be in power-down mode for the Auto-wakeup/Idle function to work.]

The 5501 DMA controller allows transfers to be synchronized to selected events. The 5501 supports 14 separate synchronization events and each channel can be tied to separate synchronization event independent of the other channels. Synchronization events are selected by programming the SYNC field in the channel-specific DMA Channel Control Register (DMA\_CCR).

The 5501 DMA can access all the internal DARAM space as well as all external memory space. The 5501 DMA also has access to the registers for the following peripheral modules: McBSP, UART, GPIO, PGPIO, and I<sup>2</sup>C.

# 3.8.1 DMA Channel 0 Control Register (DMA\_CCR0)

The DMA Channel 0 Control Register (DMA\_CCR0) bit layouts are shown in Figure 3–8. DMA\_CCR1 to DMA\_CCR5 have similar bit layouts. See the TMS320C55x DSP Peripherals Reference Guide (literature number SPRU317) for more information on the DMA Channel n Control Register (n = 0, 1, 2, 3, 4, or 5).

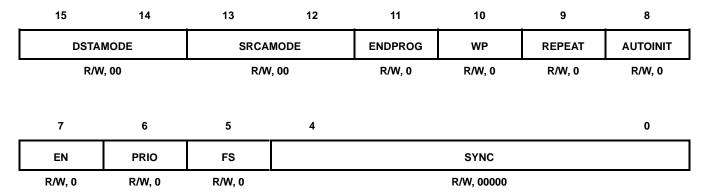


Figure 3–8. DMA Channel 0 Control Register Layout (0x0C01)

The SYNC field (bits[4:0]) of the DMA\_CCR register specifies the event that can initiate the DMA transfer for the corresponding DMA channel. The five bits allow several configurations as listed in Table 3–8. The bits are set to zero upon reset.

Table 3-8. Synchronization Control Function

| SYNC FIELD IN DMA_CCR | SYNCHRONIZATION MODE               |
|-----------------------|------------------------------------|
| 00000b                | No event synchronized              |
| 00001b                | McBSP 0 Receive Event (REVT0)      |
| 00010b                | McBSP 0 Transmit Event (XEVT0)     |
| 00011b                | Reserved (Do not use this value)   |
| 00100b                | Reserved (Do not use this value)   |
| 00101b                | McBSP1 Receive Event (REVT1)       |
| 00110b                | McBSP1 Transmit Event (XEVT1)      |
| 00111b                | Reserved (Do not use this value)   |
| 01000b                | Reserved (Do not use this value)   |
| 01001b                | Reserved (Do not use this value)   |
| 01010b                | Reserved (Do not use this value)   |
| 01011b                | UART Receive Event (UARTREVT)      |
| 01100b                | UART Transmit Event (UARTXEVT)     |
| 01101b                | Timer 0 Event                      |
| 01110b                | Timer 1 Event                      |
| 01111b                | External Interrupt 0               |
| 10000b                | External Interrupt 1               |
| 10001b                | External Interrupt 2               |
| 10010b                | External Interrupt 3               |
| 10011b                | I <sup>2</sup> C Receive Event     |
| 10100b                | I <sup>2</sup> C Transmit Event    |
| Other values          | Reserved (Do not use these values) |

## 3.9 System Clock Generator

The TMS320VC5501 includes a flexible clock generator module consisting of a PLL and oscillator, with several dividers so that different clocks may be generated for different parts of the system (i.e., DSP core, Internal Peripheral Bus, External Memory Interface).

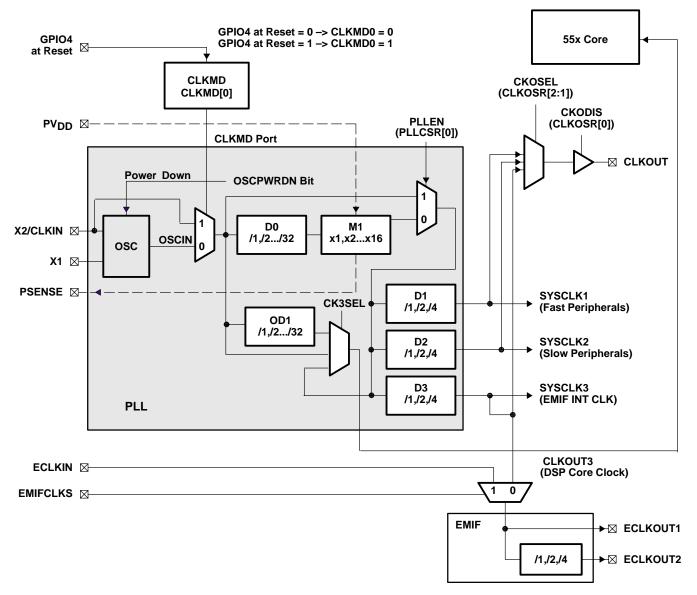


Figure 3-9. PLL and Clock Generator Logic

## 3.9.1 Input Clock Source

The clock input to the 5501 can be sourced from either an externally generated 3.3-V clock input on the X2/CLKIN pin, or from the on-chip oscillator if an external crystal circuit is attached to the device as shown in Figure 3–10. At reset, if GPIO4 is low, the internal oscillator will be enabled and the internal oscillator and an external crystal will generate the input clock. If GPIO4 is high, the internal oscillator will be set to power-down mode and the input clock will be taken from the X2/CLKIN pin. The CLKMD0 bit of the Clock Mode Control Register (CLKMD) will reflect the state of GPIO4 after reset. Please note that after reset, the GPIO4 pin may become active depending on the boot mode selected through the GPIO[2:0] pins.

36

## 3.9.1.1 Internal System Oscillator With External Crystal

The oscillator requires an external crystal or ceramic resonator connected across the X1 and X2/CLKIN pins. If the internal oscillator is not used, an external clock source must be applied to the X2/CLKIN pin and the X1 pin should be left unconnected. Since the internal oscillator can be used as a clock source to the PLL, the crystal oscillation frequency can be multiplied to generate the input clock to the different clock groups.

The crystal should be in fundamental-mode operation, and parallel resonant, with a maximum effective series resistance of 30  $\Omega$  and a power dissipation of 1 mW. The internal oscillator supports fundamental-mode crystals up to 25 MHz. The connection of the required circuit, consisting of the crystal and two load capacitors, is shown in Figure 3–10. The load capacitors, C1 and C2, should be chosen such that the equation below is satisfied.  $C_{\rm L}$  in the equation is the load specified for the crystal, which must be 10 pF.

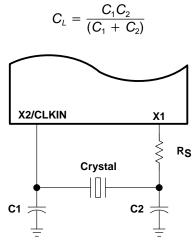


Figure 3–10. Internal System Oscillator External Crystal

The 5501 has internal circuitry that will count down a predetermined number of clock cycles (41,032 reference clock cycles) to allow the oscillator input to become stable after waking up from power-down state or after reset. If a reset is asserted, program flow will start after all stabilization periods have expired; this includes the oscillator stabilization period only if GPIO4 is low at reset. If the oscillator is coming out of power-down mode, program flow will start immediately after the oscillator stabilization period has completed. See Section 3.9.6, Reset Sequence, for more details on program flow after reset or after oscillator power-down. See Section 3.10, Idle Control, for more information on the oscillator power-down mode.

## 3.9.1.2 Clock Generation With PLL Disabled (Bypass Mode, Default)

After reset, the PLL multiplier (M1) and its divider (D0) will be bypassed by default and the input clock to point C in Figure 3–11 will be taken from, depending on the state of the GPIO4 pin after reset, either the internal oscillator or the X2/CLKIN pin. The PLL can be taken out of bypassed mode as described in Section 3.9.4.1, C55x Subsystem Clock Group.



#### 3.9.1.3 Clock Generation With PLL Enabled (PLL Mode)

When not in bypass mode, the frequency of the input clock can be divided down by a programmable divider (D0) by any factor from 1 to 32. The output clock of the divider can be multiplied by any factor from 1 to 16 through a programmable multiplier (M1). The divider factor can be set through the PLLDIV0 bit of the PLL Divider 0 Register. The multiplier factor can be set through the PLLM bits of the PLL Multiplier Control Register. By default, the divider and multiplier factors are set to 1 after reset.

**NOTE:** There is a specific minimum and maximum input clock for the block labeled PLL in Figure 3–9, as well as for the DSP subsystem, peripherals, and EMIF. In addition, there is a maximum output frequency for the PLL. The clock generator must not be configured to exceed any of these constraints (certain combinations of external clock input, internal dividers, and PLL multiply ratios might not be supported).

## 3.9.2 Clock Groups

The TMS320VC5501 has four clock groups: the C55x Subsystem Clock Group, the Fast Peripherals Clock Group, the Slow Peripherals Clock Group, and the External Memory Interface Clock Group. Clock groups allow for lower power and performance optimization since the frequency of groups with no high-speed requirements can be set to 1/4 or 1/2 the frequency of other groups.

### 3.9.2.1 C55x Subsystem Clock Group

The C55x Subsystem Clock Group includes the C55x CPU core, internal memory (DARAM and ROM), the ICACHE, and all CPU-related modules. The input clock to this clock group is taken from the CLKOUT3 signal (as shown in Figure 3–9), the source of which can be controlled through the CLKOUT3 Select Register (CK3SEL). The frequency of CLKOUT3 can be set by adjusting the divider and multiplier values of D0 and M1 through the PLLDIV0 and PLLM registers, respectively.

#### 3.9.2.2 Fast Peripherals Clock Group

The Fast Peripherals Clock Group includes the DMA, HPI, and the timers. The input clock to this clock group is taken from the output of divider 1 (D1) (as shown in Figure 3–9). By default, the divider is set to divide its input clock by four, but the divide value can be changed to divide-by-1 or divide-by-2 by modifying the PLLDIV1 bits of the PLL Divider1 Register (PLLDIV1) through software.

#### 3.9.2.3 Slow Peripherals Clock Group

The Slow Peripherals Clock Group includes the McBSPs, I<sup>2</sup>C, and the UART. The input clock to this clock group is taken from the output of divider 2 (D2). by default, the divider is set to divide its input clock by four, but the divide value can be changed to divide-by-1 or divide-by-2 by modifying the PLLDIV2 bits of the PLL Divider2 Register (PLLDIV2) through software. The clock frequency of the Slow Peripherals Clock Group must be equal to or less than that of the Fast Peripherals Clock Group.

#### 3.9.2.4 External Memory Interface Clock Group

The External Memory Interface Clock Group includes the External Memory Interface (EMIF) module and the external data bridge modules. The input clock to this clock group is taken from the output of divider 3 (D3). By default, the divider is set to divide its input clock by four, but the divide value can be changed to divide-by-1 or divide-by-2 by modifying the PLLDIV3 bits of the PLL Divider3 Register (PLLDIV3) through software. The clock frequency of the External Memory Interface Clock Group must be equal to or less than that of the Fast Peripherals Clock Group.

## 3.9.3 EMIF Input Clock Selection

The EMIF may be clocked from an external asynchronous clock source through the ECLKIN pin if a specific EMIF frequency is needed. The source for the EMIF clock can be specified at reset through the EMIFCLKS pin. If EMIFCLKS is low at reset, then the EMIF will be clocked via the same internal clock that feeds the data bridge module and performance will be optimal. If EMIFCLKS is high at reset, then an external asynchronous clock, which can be taken up to 100 MHz (TBD), will clock the EMIF. The data throughput performance may be degraded due to synchronization issues when an external clock source is used for the EMIF.

# 3.9.4 Changing the Clock Group Frequencies

DSP software can be used to change the clock frequency of each clock group by setting adequate values in the PLL control registers. Figure 3–11 shows which PLL control registers affect the different portions of the clock generator. The following sections describe the procedures for changing the frequencies of each clock group.

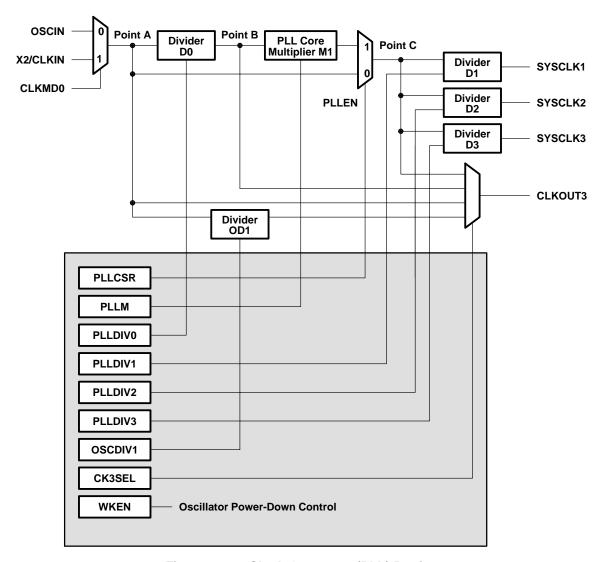


Figure 3-11. Clock Generator (PLL) Registers

#### 3.9.4.1 C55x Subsystem Clock Group

Changes to the PLL Control Register (PLLCSR), the PLL Divider0 Register (PLLDIV0), and the PLL Multiplier Register (PLLM) affect the clock of this clock group. The following procedure must be followed to change or to set the PLL to a specific value:

- 1. Switch to bypass mode by setting the PLLEN bit to 0.
- 2. Set the PLL to its reset state by setting the PLLRST bit to 1.
- 3. Change the PLL setting through the PLLM and PLLDIV0 bits.
- 4. Wait for 1 μs.
- 5. Release the PLL from its reset state by setting PLLRST to 0.
- 6. Wait for the PLL to relock by polling the LOCK bit or by setting up a LOCK interrupt.
- 7. Switch back to PLL mode by setting the PLLEN bit to 1.

The frequency of the C55x Subsystem Clock Group can be up to 300 MHz.

#### 3.9.4.2 Fast Peripherals Clock Group

Changes to the clock of the C55x Subsystem Clock Group affect the clock of the Fast Peripherals Clock Group. The PLLDIV1 value of the PLL Divider1 Register (PLLDIV1) should not be set in a manner that makes the frequency for this clock group greater than 150 MHz. There must be no activity in the modules included in the Fast Peripherals Clock Group when the value of PLLDIV1 is being changed. It is recommended that the fast peripheral modules be put in IDLE mode before changing the PLLDIV1 value.

#### 3.9.4.3 Slow Peripherals Clock Group

Changes to the clock of the C55x Subsystem Clock Group affect the clock of the Slow Peripherals Clock Group. The PLLDIV2 value of the PLL Divider2 Register (PLLDIV2) should not be set in a manner that makes the frequency for this clock group greater than 150 MHz or greater than the frequency of the Fast Peripherals Clock Group. There must be no activity in the modules included in the Slow Peripherals Clock Group when the value of PLLDIV2 is being changed. It is recommended that the slow peripheral modules be put in IDLE mode before changing the PLLDIV2 value.

### 3.9.4.4 External Memory Interface Clock Group

Changes to the clock of the C55x Subsystem Clock Group affect the clock of the External Memory Interface Clock Group. The PLLDIV3 value of the PLL Divider3 Register (PLLDIV3) should not be set in a manner that makes the frequency for this clock group greater than 100 MHz or greater than the frequency of the Fast Peripherals Clock Group, whichever is smaller. If an external clock is used, the EMIF can operate up to 100 MHz as long as the external clock frequency does not exceed the frequency of the internal clock to the data bridge modules or the frequency of the Fast Peripherals Clock Group, whichever is smaller. There must be no external memory accesses when the value of PLLDIV3 is being changed, this means that the value of PLLDIV3 cannot be changed by a program that is being executed from external memory. It is recommended that the EMIF be put in IDLE mode before changing the PLLDIV3 value.

# 3.9.5 PLL Control Registers

The 5501 PLL control registers are accessible via the I/O memory map.

Table 3-9. PLL Control Registers

| ADDRESS | REGISTER |
|---------|----------|
| 1C80h   | PLLCSR   |
| 1C82h   | CK3SEL   |
| 1C88h   | PLLM     |
| 1C8Ah   | PLLDIV0  |
| 1C8Ch   | PLLDIV1  |
| 1C8Eh   | PLLDIV2  |
| 1C90h   | PLLDIV3  |
| 1C92h   | OSCDIV1  |
| 1C98h   | WKEN     |

# 3.9.5.1 PLL Control / Status Register (PLLCSR)

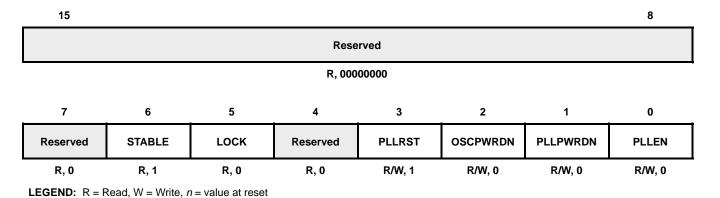


Figure 3–12. PLL Control/Status Register Layout (0x1C80)

Table 3-10. PLL Control/Status Register Bit Field Description

| BIT NAME | BIT NO. | ACCESS | RESET VALUE |   | DESCRIPTION  |
|----------|---------|--------|-------------|---|--|
| Reserved | 15:7    | R      | 000000000   | Reserved. Reads r                       | eturn 0. Writes have no effect.  |
| STABLE   | 6       | R      | 1           | Oscillator input stal has stabilized.   | ble. This bit indicates if the OSCIN/CLKIN input   |
|          |         |        |             | STABLE = 0:<br>STABLE = 1:              | OSCIN/CLKIN input is not yet stable. Oscillator counter is not done counting 41,032 reference clock cycles. OSCIN/CLKIN input is stable. This is true if any one of the three cases is true: a) Oscillator counter has finished counting. b) Oscillator counter is disabled. |
|          |         |        |             |   | c) Test mode.  |
| LOCK     | 5       | R      | 0           | Lock mode indicate is in its lock mode. | or. This bit indicates whether the clock generator   |
|          |         |        |             | LOCK = 0:                               | The PLL is in the process of getting a phase lock.   |
|          |         |        |             | LOCK = 1:                               | The clock generator is in the lock mode. The PLL has a phase lock and the output clock of the PLL has the frequency determined by the PLLM register and PLLDIV0 register.  |
| Reserved | 4       | R      | 0           | Reserved. Reads r                       | eturn 0. Writes have no effect.  |
| PLLRST   | 3       | R/W    | 1           | Asserts RESET to                        | PLL  |
|          |         |        |             | PLLRST = 0:<br>PLLRST = 1:              | PLL reset released<br>PLL reset asserted   |
| OSCPWRDN | 2       | R/W    | 0           | Selects oscillator p                    | ower down  |
|          |         |        |             | OSCPWRDN = 0:<br>OSCPWRDN = 1:          | Oscillator operational Oscillator placed in power-down state   |
| PLLPWRDN | 1       | R/W    | 0           | Selects PLL power                       | down   |
|          |         |        |             | PLLPWRDN = 0:<br>PLLPWRDN = 1:          | PLL operational PLL placed in power-down state   |
| PLLEN    | 0       | R/W    | 0           | PLL mode enable.<br>D1, D2, and D3.     | This bit controls the multiplexer before dividers  |
|          |         |        |             | PLLEN = 0:<br>PLLEN = 1:                | Bypass mode. Divider D1 and PLL are bypassed. SYSCLK1 to 3 divided down directly from input reference clock. PLL mode. Divider D1 and PLL are not  |
|          |         |        |             |   | bypassed. SYSCLK1 to 3 divided down from PLL output.   |

# 3.9.5.2 PLL Multiplier Control Register (PLLM)

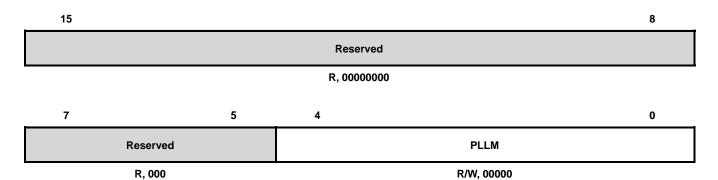


Figure 3–13. PLL Multiplier Control Register Layout (0x1C88)

Table 3-11. PLL Multiplier Control Register Bit Field Description

| BIT NAME | BIT NO. | ACCESS | RESET VALUE |                        | DESCRIPTION               |
|----------|---------|--------|-------------|------------------------|---------------------------|
| Reserved | 15:5    | R      | 0000000000  | Reserved. Reads return | 0. Writes have no effect. |
| PLLM     | 4:0     | R/W    | 00000       | PLL multiplier-select  |                           |
|          |         |        |             | PLLM = 00000-00001:    | Reserved                  |
|          |         |        |             | PLLM = 00010:          | Times 2                   |
|          |         |        |             | PLLM = 00011:          | Times 3                   |
|          |         |        |             | PLLM = 00100:          | Times 4                   |
|          |         |        |             | PLLM = 00101:          | Times 5                   |
|          |         |        |             | PLLM = 00110:          | Times 6                   |
|          |         |        |             | PLLM = 00111:          | Times 7                   |
|          |         |        |             | PLLM = 01000:          | Times 8                   |
|          |         |        |             | PLLM = 01001:          | Times 9                   |
|          |         |        |             | PLLM = 01010:          | Times 10                  |
|          |         |        |             | PLLM = 01011:          | Times 11                  |
|          |         |        |             | PLLM = 01100:          | Times 12                  |
|          |         |        |             | PLLM = 01101:          | Times 13                  |
|          |         |        |             | PLLM = 01110:          | Times 14                  |
|          |         |        |             | PLLM = 01111:          | Times 15                  |
|          |         |        |             | PLLM = 10000-11111:    | Reserved                  |

# 3.9.5.3 PLL Divider 0 Register (PLLDIV0) (Prescaler)

This register controls the value of the PLL prescaler (Divider D0).

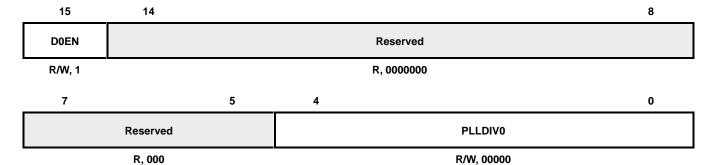


Figure 3-14. PLL Divider 0 Register Layout (0x1C8A)

Table 3-12. PLL Divider 0 Register Bit Field Description

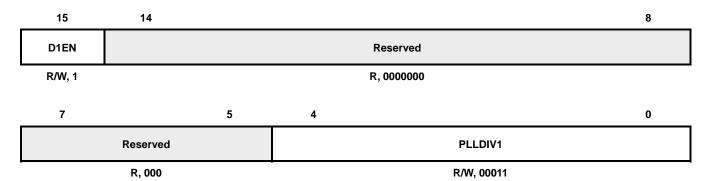
| BIT NO. | ACCESS        | RESET VALUE  | DESCRIPTION  |
|---------|---------------|--|--|
| 15      | R/W           | 1  | Divider D0 enable  |
|         |               |  | D0EN = 0: Divider 0 disabled D0EN = 1: Divider 0 enabled   |
| 14:5    | R             | 0000000000   | Reserved. Reads return 0. Writes have no effect.   |
| 4:0     | R/W           | 00000  | Divider D0 ratio   |
|         |               |  | PLLDIV0 = 00000: Divide by 1 PLLDIV0 = 00001: Divide by 2 PLLDIV0 = 00010: Divide by 3 PLLDIV0 = 00011: Divide by 4 PLLDIV0 = 00100: Divide by 5 PLLDIV0 = 00101: Divide by 6 PLLDIV0 = 00110: Divide by 7 PLLDIV0 = 00111: Divide by 8 PLLDIV0 = 01001: Divide by 9 PLLDIV0 = 01001: Divide by 10 PLLDIV0 = 01010: Divide by 11 PLLDIV0 = 01011: Divide by 12 PLLDIV0 = 01101: Divide by 13 PLLDIV0 = 01101: Divide by 14 PLLDIV0 = 01111: Divide by 15 PLLDIV0 = 01111: Divide by 15 PLLDIV0 = 01111: Divide by 17 PLLDIV0 = 10000: Divide by 17 PLLDIV0 = 10001: Divide by 18 PLLDIV0 = 10011: Divide by 19 PLLDIV0 = 10011: Divide by 20 PLLDIV0 = 10110: Divide by 21 PLLDIV0 = 10110: Divide by 25 PLLDIV0 = 11001: Divide by 26 PLLDIV0 = 11011: Divide by 27 PLLDIV0 = 11011: Divide by 28 PLLDIV0 = 11011: Divide by 28 PLLDIV0 = 11101: Divide by 29 |
|         | BIT NO.<br>15 | BIT NO.         ACCESS           15         R/W           14:5         R | 15 R/W 1<br>14:5 R 0000000000  |

44

SPRS206

## 3.9.5.4 PLL Divider1 Register (PLLDIV1) for SYSCLK1

This register controls the value of the divider D1 for SYSCLK1. It is in both the BYPASS and PLL paths.



**LEGEND:** R = Read, W = Write, n = value at reset

Figure 3–15. PLL Divider 1 Register Layout (0x1C8C)

Table 3-13. PLL Divider 1 Register Bit Field Description

| BIT NAME | BIT NO. | ACCESS | RESET VALUE |  | DESCRIPTION                             |
|----------|---------|--------|-------------|--|---|
| D1EN     | 15      | R/W    | 1           | Divider D1 enable                                |   |
|          |         |        |             | D1EN = 0:<br>D1EN = 1:                           | Divider 1 disabled<br>Divider 1 enabled |
| Reserved | 14:5    | R      | 000000000   | Reserved. Reads return 0. Writes have no effect. |   |
| PLLDIV1  | 4:0     | R/W    | 00011       | Divider D1 ratio (SYSCLK1 divider)               |   |
|          |         |        |             | PLLDIV1 = 00000:                                 | Divide by 1                             |
|          |         |        |             | PLLDIV1 = 00001:                                 | Divide by 2                             |
|          |         |        |             | PLLDIV1 = 00010:                                 | Reserved                                |
|          |         |        |             | PLLDIV1 = 00011:                                 | Divide by 4                             |
|          |         |        |             | PLLDIV1 = 00100–11111:                           | Reserved                                |

### 3.9.5.5 PLL Divider2 Register (PLLDIV2) for SYSCLK2

This register controls the value of the divider D2 for SYSCLK2. It is in both the BYPASS and PLL paths.

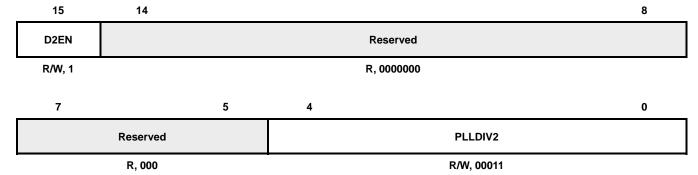


Figure 3–16. PLL Divider 2 Register Layout (0x1C8E)

| BIT NAME | BIT NO. | ACCESS | RESET VALUE |  | DESCRIPTION   |
|----------|---------|--------|-------------|--|---|
| D2EN     | 15      | R/W    | 1           | Divider D2 enable  |   |
|          |         |        |             | D2EN = 0:<br>D2EN = 1:   | Divider 2 disabled<br>Divider 2 enabled               |
| Reserved | 14:5    | R      | 000000000   | Reserved. Reads return 0. Writes have no effect.   |   |
| PLLDIV2  | 4:0     | R/W    | 00011       | Divider D2 ratio (SYSCL  | K2 divider)   |
|          |         |        |             | PLLDIV2 = 00000:<br>PLLDIV2 = 00001:<br>PLLDIV2 = 00010:<br>PLLDIV2 = 00011:<br>PLLDIV2 = 00100-11111: | Divide by 1 Divide by 2 Reserved Divide by 4 Reserved |

# 3.9.5.6 PLL Divider3 Register (PLLDIV3) for SYSCLK3

This register controls the value of the divider D3 for SYSCLK3. It is in both the BYPASS and PLL paths.

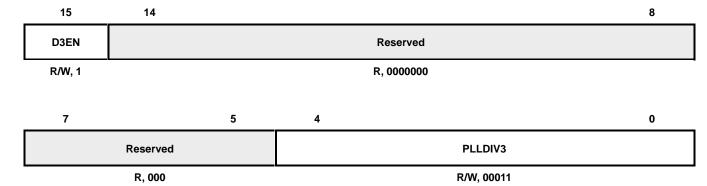


Figure 3–17. PLL Divider 3 Register Layout (0x1C90)

Table 3-15. PLL Divider3 Register Bit Field Description

| BIT NAME | BIT NO. | ACCESS | RESET VALUE | DESCRIPTION                                      |   |
|----------|---------|--------|-------------|--|---|
| D3EN     | 15      | R/W    | 1           | Divider D3 enable                                |   |
|          |         |        |             | D3EN = 0:<br>D3EN = 1:                           | Divider 3 disabled<br>Divider 3 enabled |
| Reserved | 14:5    | R      | 0000000000  | Reserved. Reads return 0. Writes have no effect. |   |
| PLLDIV3  | 4:0     | R/W    | 00011       | Divider D3 ratio (SYSCLK3 divider)               |   |
|          |         |        |             | PLLDIV3 = 00000:                                 | Divide by 1                             |
|          |         |        |             | PLLDIV3 = 00001:                                 | Divide by 2                             |
|          |         |        |             | PLLDIV3 = 00010:                                 | Reserved                                |
|          |         |        |             | PLLDIV3 = 00011:                                 | Divide by 4                             |
|          |         |        |             | PLLDIV3 = 00100-11111:                           | Reserved                                |

# 3.9.5.7 Oscillator Divider1 Register (OSCDIV1) for CLKOUT3

This register controls the value of the divider OD1 for CLKOUT3. It does not go through the PLL path.

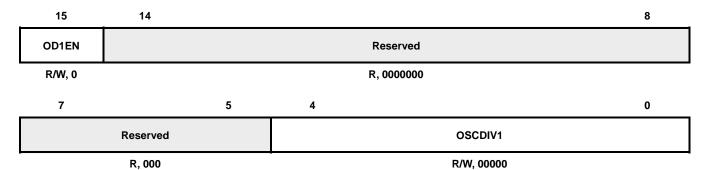


Figure 3–18. Oscillator Divider1 Register Layout (0x1C92)

Table 3-16. Oscillator Divider1 Register Bit Field Description

| BIT NAME | BIT NO. | ACCESS | RESET VALUE | DESCRIPTION                   |                               |
|----------|---------|--------|-------------|-------------------------------|-------------------------------|
| OD1EN    | 15      | R/W    | 0           | Oscillator divider OD1 enable |                               |
|          |         |        |             |                               |                               |
|          |         |        |             | OD1EN = 0:                    | Oscillator divider 1 disabled |
|          |         |        |             | OD1EN = 1:                    | Oscillator divider 1 enabled  |
| Reserved | 14:5    | R      | 000000000   | Reserved. Reads retu          | ırn 0. Writes have no effect. |
| OSCDIV1  | 4:0     | R/W    | 00000       | Divider OD1 ratio (C          | LKOUT3 divider)               |
|          |         |        |             | OSCDIV1 = 00000:              | Divide by 1                   |
|          |         |        |             | OSCDIV1 = 00001:              | Divide by 2                   |
|          |         |        |             | OSCDIV1 = 00010:              | Divide by 3                   |
|          |         |        |             | OSCDIV1 = 00011:              | Divide by 4                   |
|          |         |        |             | OSCDIV1 = 00100:              | Divide by 5                   |
|          |         |        |             | OSCDIV1 = 00101:              | Divide by 6                   |
|          |         |        |             | OSCDIV1 = 00110:              | Divide by 7                   |
|          |         |        |             | OSCDIV1 = 00111:              | Divide by 8                   |
|          |         |        |             | OSCDIV1 = 01000:              | Divide by 9                   |
|          |         |        |             | OSCDIV1 = 01001:              | Divide by 10                  |
|          |         |        |             | OSCDIV1 = 01010:              | Divide by 11                  |
|          |         |        |             | OSCDIV1 = 01011:              | Divide by 12                  |
|          |         |        |             | OSCDIV1 = 01100:              | Divide by 13                  |
|          |         |        |             | OSCDIV1 = 01101:              | Divide by 14                  |
|          |         |        |             | OSCDIV1 = 01110:              | Divide by 15                  |
|          |         |        |             | OSCDIV1 = 01111:              | Divide by 16                  |
|          |         |        |             | OSCDIV1 = 10000:              | Divide by 17                  |
|          |         |        |             | OSCDIV1 = 10001:              | Divide by 18                  |
|          |         |        |             | OSCDIV1 = 10010:              | Divide by 19                  |
|          |         |        |             | OSCDIV1 = 10011:              | Divide by 20                  |
|          |         |        |             | OSCDIV1 = 10100:              | Divide by 21                  |
|          |         |        |             | OSCDIV1 = 10101:              | Divide by 22                  |
|          |         |        |             | OSCDIV1 = 10110:              | Divide by 23                  |
|          |         |        |             | OSCDIV1 = 10111:              | Divide by 24                  |
|          |         |        |             | OSCDIV1 = 11000:              | Divide by 25                  |
|          |         |        |             | OSCDIV1 = 11001:              | Divide by 26                  |
|          |         |        |             | OSCDIV1 = 11010:              | Divide by 27                  |
|          |         |        |             | OSCDIV1 = 11011:              | Divide by 28                  |
|          |         |        |             | OSCDIV1 = 11100:              | Divide by 29                  |
|          |         |        |             | OSCDIV1 = 11101:              | Divide by 30                  |
|          |         |        |             | OSCDIV1 = 11110:              | Divide by 31                  |
|          |         |        |             | OSCDIV1 = 11111:              | Divide by 32                  |

## 3.9.5.8 Oscillator Wakeup Control Register (WKEN)

This register controls whether different events in the system are enabled to wake up the device after entering OSCPWRDN.

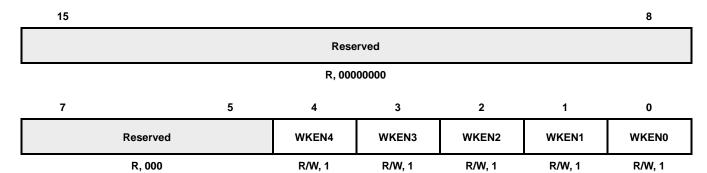


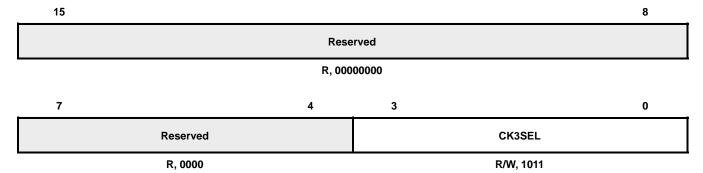
Figure 3-19. Oscillator Wakeup Control Register Layout (0x1C98)

Table 3-17. Oscillator Wakeup Control Register Bit Field Description

| BIT NAME | BIT NO. | ACCESS | RESET VALUE | DESCRIPTION  |
|----------|---------|--------|-------------|--|
| Reserved | 15:5    | R      | 0000000000  | Reserved. Reads return 0. Writes have no effect.   |
| WKEN4    | 4       | R/W    | 1           | Input INT3 can wake up the oscillator when the OSCPWRDN bit in PLLCSR is asserted to logic 1.  WKEN4 = 0: Wake-up enabled. A low-to-high transition on INT3 wakes up the oscillator and clears the OSCPWRDN bit.  WKEN4 = 1: Wake-up disabled. A low-to-high transition on INT3 does not wake up the oscillator. |
| WKEN3    | 3       | R/W    | 1           | Input INT2 can wake up the oscillator when the OSCPWRDN bit in PLLCSR is asserted to logic 1.  WKEN3 = 0: Wake-up enabled. A low-to-high transition on INT2 wakes up the oscillator and clears the OSCPWRDN bit.  WKEN3 = 1: Wake-up disabled. A low-to-high transition on INT2 does not wake up the oscillator. |
| WKEN2    | 2       | R/W    | 1           | Input INT1 can wake up the oscillator when the OSCPWRDN bit in PLLCSR is asserted to logic 1.  WKEN2 = 0: Wake-up enabled. A low-to-high transition on INT1 wakes up the oscillator and clears the OSCPWRDN bit.  WKEN2 = 1: Wake-up disabled. A low-to-high transition on INT1 does not wake up the oscillator. |
| WKEN1    | 1       | R/W    | 1           | Input INTO can wake up the oscillator when the OSCPWRDN bit in PLLCSR is asserted to logic 1.  WKEN1 = 0: Wake-up enabled. A low-to-high transition on INTO wakes up the oscillator and clears the OSCPWRDN bit.  WKEN1 = 1: Wake-up disabled. A low-to-high transition on INTO does not wake up the oscillator. |
| WKEN0    | 0       | R/W    | 1           | Input NMI can wake up the oscillator when the OSCPWRDN bit in PLLCSR is asserted to logic 1.  WKEN0 = 0: Wake-up enabled. A low-to-high transition on NMI wakes up the oscillator and clears the OSCPWRDN bit.  WKEN0 = 1: Wake-up disabled. A low-to-high transition on NMI does not wake up the oscillator.    |

### 3.9.5.9 CLKOUT3 Select Register (CK3SEL)

This register controls which clock is output onto the CLKOUT3 so that it may be used to test and debug the PLL (in addition to its normal function of being a direct input clock divider). Modes other than CK3SEL = 1011 are intended for debug use only and should not be used during normal operation.



**LEGEND:** R = Read, W = Write, n = value at reset

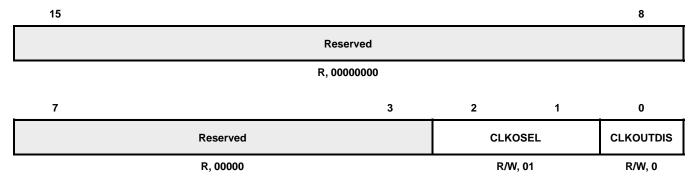
Figure 3–20. CLKOUT3 Select Register Layout (0x1C82)

Table 3–18. CLKOUT3 Select Register Bit Field Description

| BIT NAME | BIT NO. | ACCESS | RESET VALUE | DESCRIPTION   |  |
|----------|---------|--------|-------------|---|--|
| Reserved | 15:4    | R      | 00000000000 | Reserved. Reads return 0. Writes have no effect.  |  |
| CK3SEL   | 3:0     | R/W    | 1011        | Output on CLK3SEL pin   |  |
|          |         |        |             | CK3SEL = 1001 CLKOUT3 becomes point A in Figure 3–11 CK3SEL = 1010 CLKOUT3 becomes point B in Figure 3–11 CK3SEL = 0000–0111 CLKOUT3 becomes oscillator divider output in Figure 3–11 |  |
|          |         |        |             | CK3SEL = 1011 CLKOUT3 becomes point C in Figure 3–11 CK3SEL = Other Not supported   |  |

### 3.9.5.10 CLKOUT Selection Register (CLKOUTSR)

As described in Section 3.9.2, Clock Groups, the 5501 has different clock groups, each of which can be driven by a clock that is different from the CPU clock. The CLKOUT Selection Register determines which clock signal is reflected on the CLKOUT pin.



**LEGEND:** R = Read, W = Write, n = value at reset

Figure 3–21. CLKOUT Selection Register Layout (0x8400)

Table 3-19. CLKOUT Selection Register Bit Field Description

| BIT NAME  | BIT NO. | ACCESS | RESET VALUE   | DESCRIPTION  |  |  |
|-----------|---------|--------|---------------|--|--|--|
| Reserved  | 15–3    | R      | 0000000000000 | Reserved   |  |  |
| CLKOSEL   | 2:1     | R/W    | 01            | CLKOUT source-select   |  |  |
|           |         |        |               | CLKOSEL = 00: Reserved  CLKOSEL = 01: CLKOUT source is SYSCLK1  CLKOSEL = 10: CLKOUT source is SYSCLK2  CLKOSEL = 11: CLKOUT source is SYSCLK3 |  |  |
| CLKOUTDIS | 0       | R/W    | 0             | Disable CLKOUT   |  |  |
|           |         |        |               | CLKOUTDIS = 0: CLKOUT enabled CLKOUTDIS = 1: CLKOUT disabled (driving 0)   |  |  |

# 3.9.5.11 Clock Mode Control Register (CLKMD)

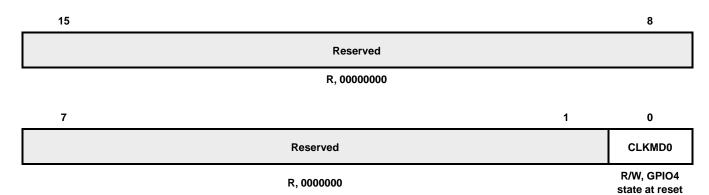


Figure 3–22. Clock Mode Control Register Layout (0x8C00)

Table 3-20. Clock Mode Control Register Bit Field Description

| BIT NAME | BIT NO. | ACCESS | RESET VALUE          | DESCRIPTION  |
|----------|---------|--------|----------------------|--|
| Reserved | 15–1    | R      | 000000000000000      | Reserved   |
| CLKMD0   | 0       | R/W    | GPIO4 state at reset | Clock output source-select   |
|          |         |        |                      | CLKMD0 = 0: OSCIN is selected as clock input source CLKMD0 = 1: X2/CLKIN is selected as clock input source |

## 3.9.6 Reset Sequence

When reset is low, the clock generator is in bypass mode with the input clock set to OSCIN or X2/CLKIN, dependent upon the state of the GPIO4. After reset, the following conditions occur:

- GPIO6 is sampled on the rising edge of the reset signal.
- If GPIO6 is high at reset, the Parallel Port Mux will be configured to support the 16-bit EMIF and the Host Port Mux will be configured to support the HPI in 8-bit (multiplexed) mode. If GPIO6 is low at reset, both the Parallel Port Mux and the Host Port Mux will be configured to support parallel general-purpose I/O; the EMIF and HPI will be disabled in this mode. The Paralle/Host Port Mux Mode bit of the XBSR will reflect the mode selected for the Parallel and Host Port Muxes.†
- If GPIO4 is low, the CLKMD0 bit of the Clock Mode Control Register (CLKMD) is set to zero and the
  oscillator is enabled. Program flow begins after the reset signal has propagated throughout the device and
  the oscillator has stabilized. If GPIO4 is high, the CLKMD0 bit of the CLKMD register is set to one and the
  oscillator is set to power-down mode by setting the OSCPWRDN bit in the PLL Control/Status Register
  (PLLCSR) to one. Program flow begins after the reset signal has propagated throughout the device.

The 5501 has internal circuitry that will count down 70 reference clock cycles to allow reset signals to propagate correctly to all parts of the device after reset (RESET pin goes high). Furthermore, the 5501 also has internal circuitry that will count down 41,032 reference clock cycles to allow the oscillator input to become stable after waking up from power-down state or reset. If a reset is asserted, program flow will start after all stabilization periods have expired; this includes the oscillator stabilization period only if GPIO4 is low at reset. If the oscillator is coming out of power-down mode, program flow will start immediately after the oscillator stabilization period has completed. Table 3–21 summarizes the number of reference clock cycles needed before program flow begins.

Table 3-21. Number of Reference Clock Cycles Needed Until Program Flow Begins

| CONE                        | REFERENCE CLOCK CYCLES |        |
|-----------------------------|------------------------|--------|
| Affice Deces                | Oscillator Not Used    | 70     |
| After Reset                 | Oscillator Used        | 41,102 |
| After Oscillator Power-Down |                        | 41,032 |

All output (O/Z) and input/output (I/O/Z) pins (except for CLKOUT, ECLKOUT2, and XF) will go into high-impedance mode during reset and will come out of high-impedance mode when the stabilization periods have expired. All output (O/Z) and input/output (I/O/Z) pins will retain their value when the device enters a power-down mode such as IDLE3 mode.

At power up, the reset pin must be kept at a low state until the 5501 has been completely powered up to prevent any unexpected behavior.

<sup>†</sup> Modifying the XBSR to change the mode of the Parallel Port Mux and Host Port Mux after the 5501 has been brought out of reset is *not* recommended.



#### 3.10 Idle Control

The Idle function is implemented for low power consumption. The Idle function achieves low power consumption by gating the clock to unused parts of the chip, and/or setting the clock generator (PLL) and the internal oscillator to a power-down mode.

#### 3.10.1 Clock Domains

The 5501 provides six clock domains to power-off the main clock to the portions of the device that are not being used. The six domains are:

- CPU Domain
- Master Port Domain (includes DMA and HPI modules)
- ICACHE
- Peripherals Domain
- Clock Generator Domain
- EMIF Domain

# 3.10.2 IDLE Procedures

Before entering idle mode (executing the IDLE instruction), the user has first to determine which part of the system needs to be disabled and then program the Idle Control Register (ICR) accordingly. When the IDLE instruction is executed, the ICR will be copied into the Idle Status Register (ISTR). The different bits of the ISTR register will be propagated to disable the chosen domains. Special care has to be taken in programming the ICR as some IDLE domain combinations are not valid (for example: CPU on and clock generator off).

#### 3.10.2.1 CPU Domain Idle Procedure

The 5501 CPU can be idled by executing the following procedure.

- 1. Write '1' to the CPUI bit (bit 0 of ICR).
- 2. Execute the IDLE instruction.
- 3. CPU will go to idle state

#### 3.10.2.2 Master Port Domain (DMA/HPI) Idle Procedure

The clock to the DMA module and/or the HPI module will be stopped when the DMA and/or the HPI bit in the MICR is set to 1 and the MPIS bit in the ISTR becomes 1. The DMA will go into idle immediately if there is no data transfer taking place. If there is a data transfer taking place, then it will finish the current transfer and then go into idle. The HPI will go into idle regardless of whether or not there is a data transfer taking place. Software must confirm that the HPI has no activity before setting it to idle.

The 5501 DMA module and the HPI module can be disabled by executing the following procedure.

- 1. Write '1' to the DMA bit and/or the HPI bit in MICR.
- 2. Write '1' to the MPI bit in ICR.
- 3. Execute the IDLE instruction.
- 4. DMA and/or HPI go/goes to idle.

#### 3.10.2.3 Peripheral Modules Idle Procedure

The clock to the modules included in the Peripherals Domain will be stopped when their corresponding bit in the PICR is set to 1 and the PERIS bit in the ISTR becomes 1. Each module in this domain will go into idle immediately if it has no activity. If the module being set to idle has activity, it will wait until the activity completes before going into idle.

Each peripheral module can be idled by executing the following procedure.

- 1. Write '1' to the corresponding bit in PICR for each peripheral to be idled.
- 2. Write '1' to the PERI bit in ICR.
- 3. Execute the IDLE instruction.
- 4. Every peripheral with its corresponding PICR bit set will go to idle.

#### 3.10.2.4 EMIF Module Idle Procedure

The 5501 EMIF can be idled in one of two ways: through the ICR and through the PICR. The EMIF will go into idle immediately if there is no data transfer taking place within the DMA. If there is a data transfer taking place, then the EMIF will wait until the DMA finishes the current transfer and goes into idle before going into idle itself. Please note that while the EMIF is in idle, the SDRAM refresh function of the EMIF will not be available.

The 5501 EMIF can be idled through the ICR only when the following modules are set to idle: CPU, I-Port, ICACHE, DMA, and HPI. To place the EMIF in idle using the ICR, execute the following procedure:

- 1. Write '1' to the DMA and HPI bits in MICR.
- 2. Write '1' to the CPUI, MPI, ICACHEI, EMIFI, and IPORTI bits in ICR.
- 3. Execute the IDLE instruction.
- 4. EMIF and all modules listed in Step 2 will go to idle.

The 5501 EMIF can also be idled through the PICR. To place the EMIF in idle using the PICR, execute the following procedure:

- 1. Write a '1' to the EMIF bit in PICR.
- 2. Write a '1' to the PERI bit in ICR.
- 3. Execute IDLE instruction.
- 4. EMIF will go to IDLE.

#### 3.10.2.5 IDLE2 Mode

In IDLE2 mode, all modules except the CLOCK module are set to idle state. To place the 5501 in IDLE2 mode, perform the following steps.

- 1. Write a '1' to all peripheral module bits in the PICR.
- 2. Write a '1' to the HPI and DMA bits in MICR.
- 3. Write a '1' to all domain bits in the ICR except the CLOCK domain bit (CLKI).
- 4. Execute the IDLE instruction.
- 5. All internal clocks will be disabled, the CLOCK module will remain active.



#### 3.10.2.6 IDLE3 Mode

In IDLE3 mode, all modules (including the CLOCK module) are set to idle state. To place the 5501 in IDLE3 mode, perform the following steps.

- 1. Clear (i.e., set to '0') the PLLEN bit in PLLCSR to place the PLL in bypass mode.
- 2. Set the PLLPWRDN and PLLRST bits in PLLCSR to '1'.
- 3. Write a '1' to all peripheral module bits in PICR.
- 4. Write a '1' to the HPI and DMA bits in MICR.
- 5. Write a '1' to all domain bits in ICR.
- 6. Execute the IDLE instruction.
- 7. PLL core is set to power-down mode and all internal clocks are disabled.

#### 3.10.2.7 IDLE3 Mode With Internal Oscillator Disabled

In this state, all modules (including the CLOCK module) are set to the idle state and the internal oscillator is set to the power-down mode. This is the lowest power-consuming state that 5501 can be placed under.

- 1. Clear (i.e., set to '0') the PLLEN bit in PLLCSR to place the PLL in bypass mode.
- 2. Set the PLLPWRDN, PLLRST, and OSCPWRDN bits in PLLCSR to '1'.
- 3. Set the WKEN register to specify which event will wake up internal oscillator [e.g., set bit 1 to have interrupt 0 (INT0) wake up the oscillator].<sup>†</sup>
- 4. Write a '1' to all peripheral module bits in the PICR.
- 5. Write a '1' to the HPI and DMA bits in MICR.
- 6. Write a '1' to all domain bits in the ICR.
- 7. Execute the IDLE instruction.
- 8. Internal oscillator is set to power-down mode, PLL core is set to power-down mode, and all internal clocks are disabled.

<sup>†</sup> External interrupt being used must be enabled through IER prior to setting the 5501 to IDLE.

# 3.10.3 Module Behavior at Entering IDLE State

All transactions must be completed before entering the IDLE state. Table 3–22 lists the behavior of each module before entering the IDLE state.

Table 3-22. Peripheral Behavior at Entering IDLE State

| 5501 IDLE DOMAIN | MODULES                         | MODULE BEHAVIOR AT ENTERING IDLE STATE (ASSUMING THE IDLE CONTROL IS SET)   |  |
|------------------|---------------------------------|---|--|
|                  | CPU                             | Enter IDLE after CPU stops pipeline.  |  |
|                  | Interrupt Controller            | Enter IDLE after CPU stops.   |  |
|                  | IDLE Controller                 | Enter IDLE after CPU stops.   |  |
|                  | PLL Controller                  | Enter IDLE after CPU stops.   |  |
| CPU              | Bus Selection Register          | Enter IDLE after CPU stops.   |  |
|                  | Timer Signal Selection Register | Enter IDLE after CPU stops.   |  |
|                  | CLKOUT Selection Register       | Enter IDLE after CPU stops.   |  |
|                  | External Bus Control Register   | Enter IDLE after CPU stops.   |  |
|                  | Clock Mode Control Register     | Enter IDLE after CPU stops.   |  |
|                  |                                 | Enter IDLE state after current DMA transfer to internal memory, EMIF, or peripheral, or enter IDLE state immediately if no transfer exists.   |  |
| Master Port      | DMA                             | DMA has function of Auto-wakeup/Idle with McBSP data transfer during IDLE.  |  |
|                  | HPI                             | Enter IDLE state immediately. Software has to take care of HPI activity.  |  |
| ICACHE           | ICACHE                          | Enter IDLE state after current data transfer from EMIF or program fetch from CPU finishes, or enter IDLE state immediately if no transfer and no access exist.                              |  |
|                  | Timer0/1 and WDT                | Enter IDLE state immediately  |  |
|                  | DSP/BIOS Timer                  | Enter IDLE state immediately  |  |
|                  | MCBSP0/1                        | Enter IDLE state after current McBSP activity is finished or enter IDLE state immediately if no activity exists. McBSP has function of Auto-wakeup/Idle with DMA data transfer during IDLE. |  |
| <b>5</b>         | GPIO                            | Enter IDLE state immediately.   |  |
| Peripheral       | DIEID                           | Enter IDLE state immediately.   |  |
|                  | I2C                             | Enter IDLE state after current I <sup>2</sup> C activity is finished or enter IDLE state immediately if no activity exists.   |  |
|                  | UART                            | Enter IDLE state after current UART activity is finished or enter IDLE state immediately if no activity exists.   |  |
|                  | Parallel GPIO                   | Enter IDLE state immediately.   |  |
|                  | PLL divider                     | Enter IDLE state immediately.   |  |
| CLKGEN (PLL)     | PLL core                        | Power-down state if set by software before IDLE   |  |
| ·                | Oscillator                      | Power-down state if set by software before IDLE   |  |
| EMIF             | EMIF                            | Enter IDLE mode after current DMA transfer or enter IDLE mode immediately if no activity exists.  |  |

## 3.10.4 Wake-Up Procedure

It is the user's responsibility to ensure that there exists a valid wake-up procedure before entering idle mode. Keep in mind that a hardware reset will restore all modules to their active state. All wake-up procedures are described in the next sections.

### 3.10.4.1 CPU Domain Wake-up Procedure

The CPU domain can be taken out of idle though an enabled external interrupt or an  $\overline{\text{NMI}}$  signal. External interrupts can be enabled through the use of the IER0 and IER1 registers. Other modules, such as the EMIF module, will be taken out of idle automatically when the CPU wakes up. Please see the wake-up procedures for other modules for more information.

# 3.10.4.2 Master Port Domain (DMA/HPI) Wake-up Procedure

The 5501 DMA module and the HPI module can be taken out of idle simultaneously by executing the following procedure.

- 1. Write '0' to the MPI bit in ICR.
- 2. Execute the IDLE instruction.
- 3. DMA and HPI wake up.

It is also possible to wake up the DMA and HPI modules individually through the use of the Master Idle Control Register. To wake up only the DMA or the HPI module, perform the following steps:

- 1. Write '0' to the DMA bit or the HPI bit in MICR.
- 2. Selected module wakes up.

#### 3.10.4.3 Peripheral Modules Wake-up Procedure

All 5501 peripherals can be taken out of idle simultaneously by executing the following procedure.

- 1. Write '0' to the PERI bit in ICR.
- 2. Execute the IDLE instruction.
- 3. All idled peripherals wake up.

It is also possible to wake up individual peripherals through the use of the Peripheral Idle Control Register by executing the following procedure.

- 1. Write '0' to the idle control bit of peripheral(s) in PICR.
- 2. Idled peripherals with '0' in PICR wake up.

### 3.10.4.4 EMIF Module Wake-up Procedure

If both the CPU and the EMIF are in idle, then the EMIF will come out of idle when the CPU is taken out of idle. The CPU can be taken out of idle through the use of an NMI or an enabled external interrupt. External interrupts can be enabled through the IER0 and IER1 registers.

If the CPU is not in idle, then the EMIF can be taken out of idle through either of the following two procedures:

- 1. Write '0' to the PERI bit in ICR.
- 2. Execute the IDLE instruction.
- 3. All idled peripherals, including the EMIF, wake up.

#### Or:

- 1. Write '0' to the EMIF bit in PICR.
- 2. The EMIF module will wake up.

### 3.10.4.5 IDLE2 Mode Wake-up Procedure

The 5501 can be taken completely out of IDLE2 mode by executing the following procedure.

- 1. CPU wakes up from idle through NMI or enabled external interrupt.
- 2. Write '0' to all bits in the ICR.
- 3. Execute the IDLE instruction.
- 4. All internal clocks are enabled and all modules come out of idle.

#### 3.10.4.6 IDLE3 Mode Wake-up Procedure

The 5501 can be taken completely out of IDLE3 mode by executing the following procedure.

- 1. CPU wakes up from idle through NMI or enabled external interrupt.
- 2. Write '0' to all bits in the ICR.
- 3. Execute the IDLE instruction.
- 4. All internal clocks are enabled and all modules come out of idle.
- 5. Write '0' to the PLLPWRDN and PLLRST bits in PLLCSR.
- 6. Wait for the PLL to relock by polling the LOCK bit or by setting up a LOCK interrupt.
- 7. Set the PLLEN bit in PLLCSR to '1'.
- 8. All internal clocks will now come from the PLL core.

**NOTE:** Step 3 can be modified to only wake up certain modules, see previous sections for more information on the wake-up procedures for the 5501 modules.



#### 3.10.4.7 IDLE3 Mode With Internal Oscillator Disabled Wake-up Procedure

The internal oscillator of the 5501 will be woken up along with the CLOCK module through an NMI or an enabled external interrupt. The source (INT0, INT1, INT2, INT3, or NMI) for the wake-up signal can be selected through the use of the WKEN register. The maskable external interrupts must be enabled through IER0 and IER1 prior to setting the 5501 to Idle 3 mode.

The 5501 has internal circuitry that will count down a predetermined number of clock cycles (41,032 reference clock cycles) to allow the oscillator input to become stable after waking up from power-down state or reset. When waking up from idle mode, program flow will start after the stabilization period of the oscillator has expired.

To take the 5501 (including the internal oscillator) out of the idle 3 state, execute the following procedure:

- 1. External interrupt or NMI occurs (as specified in the WKEN register) and program flow begins after 41,032 reference clock cycles.
- 2. CPU wakes up.
- 3. Write '0' to all bits in the ICR.
- 4. Execute the IDLE instruction.
- 5. All internal clocks are enabled and all modules come out of idle.
- 6. Write '0' to the PLLPWRDN, PLLRST, and OSCPWRDN bits in PLLCSR.
- 7. Wait for the PLL to relock by polling the LOCK bit or by setting up a LOCK interrupt.
- 8. Set the PLLEN bit in PLLCSR to '1'.
- 9. All internal clocks will now come from the PLL core.

**NOTE:** Step 2 can be modified to only wake up certain modules, see previous sections for more information on the wake-up procedures for the 5501 modules.

### 3.10.4.8 Summary of Wake-up Procedures

Table 3–23 summarizes the wake-up procedures.

Table 3–23. Wake-Up Procedures

| ISTR<br>VALUE | CLOCK DOMAIN<br>STATUS                              | EXIT FROM IDLE  | ICR<br>AFTER<br>WAKE-UP                           | ISTR<br>AFTER<br>WAKE-UP   |
|---------------|---|---|---|--|
| xxx0xxx0      | CPU – ON<br>Clock Generator – ON<br>Other – ON/OFF  | DSP software modifies ICR and executes "IDLE" instruction     Reset | Modified value     All "0"                        | Updated to ICR modified value after "IDLE" instruction     All "0"           |
| xxx0xxx1      | CPU – OFF<br>Clock Generator – ON<br>Other – ON/OFF | Unmasked interrupt from external or on-chip module     Reset        | <ol> <li>Not modified</li> <li>All "0"</li> </ol> | CPUIS, CLKIS, and     EMIFIS/XPORTIS/IPORTIS     are set to "0"      All "0" |
| xxx11111      | CPU – OFF<br>Clock Generator – OFF<br>Other – OFF   | Unmasked interrupt from external     Reset                          | Not modified     All "0"                          | CPUIS, CLKIS, and     EMIFIS/XPORTIS/IPORTIS     are set to "0"     All "0"  |

## 3.10.5 Auto-Wakeup/Idle Function for McBSP and DMA

The 5501 has an Auto-wakeup/Idle function for McBSP to DMA to on-chip memory data transfers when the DMA and the McBSP are both set to IDLE. In the case that the McBSP is set to external clock mode and the McBSP and the DMA are set to idle, the McBSP and the DMA can wake up from IDLE state automatically if the McBSP gets a new data transfer. The McBSP and the DMA enter the idle state automatically after data transfer is complete. [The clock generator (PLL) should be active and the PLL core should not be in power-down mode for the Auto-wakeup/Idle function to work.]

## 3.10.6 Clock State of Multiplexed Modules

The clock to the EMIF module is disabled automatically when this module is not selected through the External Bus Selection Register (XBSR). Note that any accesses to disabled modules will result in a bus error.

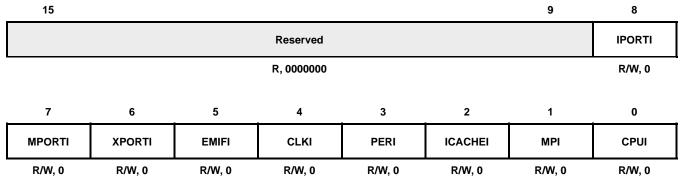
## 3.10.7 IDLE Control and Status Registers

The clock domains are controlled by the IDLE Configuration Register (ICR) that allows the user to place different parts of the device in Idle mode. The IDLE Status Register (ISTR) reflects the portion of the device that remains active. The peripheral domain is controlled by the Peripheral IDLE Control Register (PICR). The Peripheral IDLE Status Register (PISTR) reflects the portion of the peripherals that are in the IDLE state. The PLL Control/Status Register (PLLCSR) is used to power down the PLL core when the IDLE instruction is executed.

| ADDRESS | REGISTER NAME                           |
|---------|---|
| 0x0001  | IDLE Configuration Register (ICR)       |
| 0x0002  | IDLE Status Register (ISTR)             |
| 0x9400  | Peripheral IDLE Control Register (PICR) |
| 0x9401  | Peripheral IDLE Status Register (PISTR) |
| 0x9402  | Master IDLE Control Register (MICR)     |
| 0x9403  | Master IDLE Status Register (MISR)      |

Table 3-24. Clock Domain Memory-Mapped Registers

### 3.10.7.1 IDLE Configuration Register (ICR)



**LEGEND:** R = Read, W = Write, n = value at reset

Figure 3–23. IDLE Configuration Register Layout (0x0001)

Table 3-25. IDLE Configuration Register Bit Field Description

| BIT NAME | BIT NO. | ACCESS | RESET VALUE | DESCRIPTION                             |   |
|----------|---------|--------|-------------|---|---|
| Reserved | 15–9    | R      | 0000000     | Reserved                                |   |
| IPORTI   | 8       | R/W    | 0           | IPORT idle con                          | trol bit. The IPORT is used for all ICACHE transactions.  |
|          |         |        |             | IPORTI = 0:                             | IPORT remains active after execution of an IDLE instruction   |
|          |         |        |             | IPORTI = 1:                             | IPORT is disabled after execution of an IDLE instruction  |
| MPORTI   | 7       | R/W    | 0           | MPORT idle co                           | ntrol bit. The MPORT is used for all DMA transactions.  |
|          |         |        |             | MPORTI = 0:                             | MPORT remains active after execution of an IDLE instruction   |
|          |         |        |             | MPORTI = 1:                             | MPORT is disabled after execution of an IDLE instruction  |
| XPORTI   | 6       | R/W    | 0           | XPORT idle cor transactions.            | ntrol bit. The XPORT is used for all I/O memory   |
|          |         |        |             | XPORTI = 0:                             | XPORT remains active after execution of an IDLE instruction   |
|          |         |        |             | XPORTI = 1:                             | XPORT is disabled after execution of an IDLE instruction  |
| EMIFI    | 5       | R/W    | 0           | External Memor                          | ry Interface (EMIF) idle control bit  |
|          |         |        |             | EMIFI = 0:                              | EMIF module remains active after execution of an IDLE instruction   |
|          |         |        |             | EMIFI = 1:                              | EMIF module is disabled after execution of an IDLE instruction  |
| CLKI     | 4       | R/W    | 0           | Device clock generator idle control bit |   |
|          |         |        |             | CLKI = 0:                               | Device clock generator module remains active after  |
|          |         |        |             | CLKI = 1:                               | execution of an IDLE instruction.  Device clock generator is disabled after execution of an IDLE instruction. Disabling the clock generator provides the lowest level of power reduction by stopping the system clock. When CLKI is set to 1, the CPUI and DPI bits will be set to 1 in order to ensure a proper power-down mode. |
| PERI     | 3       | R/W    | 0           | Peripheral Idle                         | control bit   |
|          |         |        |             | PERI = 0:                               | All peripheral modules become/remain active after execution of an IDLE instruction  |
|          |         |        |             | PERI = 1:                               | All peripheral modules with 1 in PICR are disabled after execution of an IDLE instruction   |
| ICACHEI  | 2       | R/W    | 0           | ICACHE idle co                          | ontrol bit  |
|          |         |        |             | ICACHEI = 0:                            | ICACHE module remains active after execution of an  |
|          |         |        |             | ICACHEI = 1:                            | IDLE instruction ICACHE module is disabled after execution of an IDLE instruction   |
| MPI      | 1       | R/W    | 0           | Master peripher                         | ral (DMA and HPI) idle control bit  |
|          |         |        |             | MPI = 0:                                | DMA and HPI modules remain active after execution of  |
|          |         |        |             | MPI = 1:                                | an IDLE instruction DMA and HPI modules are disabled after execution of an IDLE instruction   |
| CPUI     | 0       | R/W    | 0           | CPU idle contro                         | ol bit  |
|          |         |        |             | CPUI = 0:                               | CPU module remains active after execution of an IDLE  |
|          |         |        |             | CPUI = 1:                               | instruction CPU module is disabled after execution of an IDLE instruction   |

NOTE: For example, writing xxx000001b into the ICR does not indicate that the CPU domain is in IDLE mode; rather, it indicates that after the IDLE instruction, the CPU domain will be in IDLE mode.

# 3.10.7.2 IDLE Status Register (ISTR)

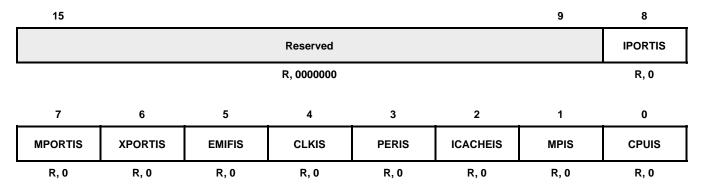


Figure 3-24. IDLE Status Register Layout (0x0002)

Table 3-26. IDLE Status Register Bit Field Description

| BIT NAME | BIT NO. | ACCESS | RESET VALUE | DESCRIPTION   |
|----------|---------|--------|-------------|---|
| Reserved | 15–9    | R      | 0000000     | Reserved  |
| IPORTIS  | 8       | R      | 0           | IPORT idle status bit. The IPORT is used for all ICACHE transactions.  IPORTIS = 0: IPORT is active IPORTIS = 1: IPORT is disabled        |
| MPORTIS  | 7       | R      | 0           | MPORT idle status bit. The MPORT is used for all DMA transactions.  MPORTIS = 0: MPORT is active MPORTIS = 1: MPORT is disabled           |
| XPORTIS  | 6       | R      | 0           | XPORT idle status bit. The XPORT is used for all I/O memory transactions.  XPORTIS = 0: XPORT is active XPORTIS = 1: XPORT is disabled    |
| EMIFIS   | 5       | R      | 0           | External Memory Interface (EMIF) idle status bit  EMIFIS = 0: EMIF module is active  EMIFIS = 1: EMIF module is disabled                  |
| CLKIS    | 4       | R      | 0           | Device clock generator idle status bit  CLKIS = 0: Device clock generator module is active  CLKIS = 1: Device clock generator is disabled |
| PERIS    | 3       | R      | 0           | Peripheral idle status bit  PERIS = 0: All peripheral modules are active  PERIS = 1: All peripheral modules are disabled                  |
| ICACHEIS | 2       | R      | 0           | ICACHE idle status bit  ICACHEIS = 0: ICACHE module is active ICACHEIS = 1: ICACHE module is disabled                                     |
| MPIS     | 1       | R      | 0           | DMA and HPI idle status bit  MPIS = 0: DMA and HPI modules are active  MPIS = 1: DMA and HPI modules are disabled                         |
| CPUIS    | 0       | R      | 0           | CPU idle status bit  CPUIS = 0: CPU module is active  CPUIS = 1: CPU module is disabled   |

### 3.10.7.3 Peripheral IDLE Control Register (PICR)

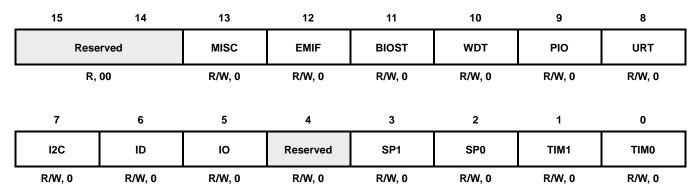


Figure 3-25. Peripheral IDLE Control Register Layout (0x9400)

Table 3-27. Peripheral IDLE Control Register Bit Field Description

| BIT NAME | BIT NO.         | ACCESS | RESET VALUE |                        | DESCRIPTION  |
|----------|-----------------|--------|-------------|------------------------|--|
| Reserved | 15–14           | R      | 00          | Reserved               |  |
| MISC     | 13†             | R/W    | 0           | MISC bit               |  |
|          |                 |        |             | MISC = 0:<br>MISC = 1: | Miscellaneous modules remain active when ISTR.PERIS = 1 and IDLE instruction is executed. MIscellaneous module is disabled when ISTR.PERIS = 1 and IDLE instruction is executed. |
|          |                 |        |             | XBCR, Time             | us modules include the XBSR, TIMEOUT Error Register, or Signal Selection Register, CLKOUT Select Register, lode Control Register.  |
| EMIF     | 12†             | R/W    | 0           | EMIF bit               |  |
|          |                 |        |             | EMIF = 0:              | EMIF module remains active when ISTR.PERIS = 1 and IDLE instruction is executed.   |
|          |                 |        |             | EMIF = 1:              | EMIF module is disabled when ISTR.PERIS = 1 and IDLE instruction is executed.  |
| BIOST    | 11†             | R/W    | 0           | BIOS timer b           | pit  |
|          |                 |        |             | BIOST = 0:             | DSP/BIOS timer remains active when ISTR.PERIS = 1  |
|          |                 |        |             | BIOST = 1:             | and the IDLE instruction is executed.  DSP/BIOS timer is disabled when ISTR.PERIS = 1 and the IDLE instruction is executed.  |
| WDT      | 10 <sup>†</sup> | R/W    | 0           | Watchdog tin           | mer bit  |
|          |                 |        |             | WDT = 0:               | WDT remains active when ISTR.PERIS = 1   |
|          |                 |        |             | WDT = 1:               | and the IDLE instruction is executed. WDT is disabled when ISTR.PERIS = 1 and the IDLE instruction is executed.  |
| PIO      | 9†              | R/W    | 0           | Parallel GPI           | O timer bit  |
|          |                 |        |             | PIO = 0:               | Parallel GPIO remains active when ISTR.PERIS = 1 (ISTR.[3]) and the IDLE instruction is executed.  |
|          |                 |        |             | PIO = 1:               | Parallel GPIO is disabled when ISTR.PERIS = 1 and the IDLE instruction is executed.  |

<sup>†</sup> If the peripheral is already in IDLE, setting PERIS (bit 3 of ISTR) to 0 and executing the IDLE instruction will wake up all peripherals, and PICR bit settings will be ignored. If PERIS = 1, executing the IDLE instruction will wake up the peripheral if the PICR bit is 0.

Table 3-27. Peripheral IDLE Control Register Bit Field Description (Continued)

| BIT NAME | BIT NO. | ACCESS | RESET VALUE |               | DESCRIPTION  |
|----------|---------|--------|-------------|---------------|--|
| URT      | 8†      | R/W    | 0           | UART timer b  | bit  |
|          |         |        |             | URT = 0:      | UART remains active when ISTR.PERIS = 1 and  |
|          |         |        |             | URT = 1:      | the IDLE instruction is executed.  UART is disabled when ISTR.PERIS = 1 and the IDLE instruction is executed.            |
| I2C      | 7†      | R/W    | 0           | I2C timer bit |  |
|          |         |        |             | I2C = 0:      | I <sup>2</sup> C remains active when ISTR.PERIS = 1 and  |
|          |         |        |             | I2C = 1:      | the IDLE instruction is executed. I <sup>2</sup> C is disabled when ISTR.PERIS = 1 and the IDLE instruction is executed. |
| ID       | 6†      | R/W    | 0           | ID timer bit  |  |
|          |         |        |             | ID = 0:       | ID remains active when ISTR.PERIS = 1 and the IDLE instruction is executed.  |
|          |         |        |             | ID = 1:       | ID is disabled when ISTR.PERIS = 1 and the IDLE instruction is executed.   |
| Ю        | 5†      | R/W    | 0           | IO timer bit  |  |
|          |         |        |             | IO = 0:       | GPIO remains active when ISTR.PERIS = 1 and  |
|          |         |        |             | IO = 1:       | the IDLE instruction is executed.  GPIO is disabled when ISTR.PERIS = 1 and the IDLE instruction is executed.            |
| Reserved | 4       | R/W    | 0           | Reserved      |  |
| SP1      | 3†      | R/W    | 0           | McBSP1 time   | er bit   |
|          |         |        |             | SP1 = 0:      | McBSP1 remains active when ISTR.PERIS = 1 and the IDLE instruction is executed.  |
|          |         |        |             | SP1 = 1:      | McBSP1 is disabled when ISTR.PERIS = 1 and the IDLE instruction is executed.   |
| SP0      | 2†      | R/W    | 0           | McBSP0 time   | er bit   |
|          |         |        |             | SP0 = 0:      | McBSP0 remains active when ISTR.PERIS = 1 and the IDLE instruction is executed.  |
|          |         |        |             | SP0 = 1:      | McBSP0 is disabled when ISTR.PERIS = 1 and the IDLE instruction is executed.   |
| TIM1     | 1†      | R/W    | 0           | TIMER1 time   | er bit   |
|          |         |        |             | TIM1 = 0:     | TIMER1 remains active when ISTR.PERIS = 1  |
|          |         |        |             | TIM1 = 1:     | and the IDLE instruction is executed.  TIMER1 is disabled when ISTR.PERIS = 1 and the IDLE instruction is executed.      |
| TIMO     | 0†      | R/W    | 0           | TIMER0 time   | er bit   |
|          |         |        |             | TIM0 = 0:     | TIMER0 remains active when ISTR.PERIS = 1 and the IDLE instruction is executed.  |
|          |         |        |             | TIM0 = 1:     | TIMERO is disabled when ISTR.PERIS = 1 and the IDLE instruction is executed.   |

<sup>†</sup> If the peripheral is already in IDLE, setting PERIS (bit 3 of ISTR) to 0 and executing the IDLE instruction will wake up all peripherals, and PICR bit settings will be ignored. If PERIS = 1, executing the IDLE instruction will wake up the peripheral if the PICR bit is 0.

# 3.10.7.4 Peripheral IDLE Status Register (PISTR)

| 15   | 14       | 13   | 12       | 11    | 10   | 9    | 8    |
|------|----------|------|----------|-------|------|------|------|
| Res  | Reserved |      | EMIF     | BIOST | WDT  | PIO  | URT  |
| R    | , 00     | R, 0 | R, 0     | R, 0  | R, 0 | R, 0 | R, 0 |
| 7    | 6        | 5    | 4        | 3     | 2    | 1    | 0    |
| I2C  | ID       | Ю    | Reserved | SP1   | SP0  | TIM1 | ТІМО |
| R, 0 | R, 0     | R, 0 | R, 0     | R, 0  | R, 0 | R, 0 | R, 0 |

Figure 3–26. Peripheral IDLE Status Register Layout (0x9401)

Table 3-28. Peripheral IDLE Status Register Bit Field Description

| BIT NAME | BIT NO. | ACCESS | RESET VALUE | DESCRIPTION   |
|----------|---------|--------|-------------|---|
| Reserved | 15–14   | R      | 00          | Reserved  |
| MISC     | 13      | R      | 0           | MISC bit  |
|          |         |        |             | MISC = 0: Miscellaneous modules are active MISC = 1: Miscellaneous modules are disabled   |
|          |         |        |             | Miscellaneous modules include the XBSR, TIMEOUT Error Register, XBCR, Timer Signal Selection Register, CLKOUT Select Register, and Clock Mode Control Register. |
| EMIF     | 12      | R      | 0           | EMIF bit  |
|          |         |        |             | EMIF = 0: EMIF module is active<br>EMIF = 1: EMIF module is disabled  |
| BIOST    | 11      | R      | 0           | BIOS timer bit  |
|          |         |        |             | BIOST = 0: DSP/BIOS timer is active<br>BIOST = 1: DSP/BIOS timer is disabled  |
| WDT      | 10      | R      | 0           | Watchdog timer bit  |
|          |         |        |             | WDT = 0: WDT is active<br>WDT = 1: WDT is disabled  |
| PIO      | 9       | R      | 0           | Parallel GPIO timer bit   |
|          |         |        |             | PIO = 0: Parallel GPIO is active<br>PIO = 1: Parallel GPIO is disabled  |
| URT      | 8       | R      | 0           | UART timer bit  |
|          |         |        |             | URT = 0: UART is active URT = 1: UART is disabled   |
| I2C      | 7       | R      | 0           | I2C timer bit   |
|          |         |        |             | $I2C = 0$ : $I^2C$ is active $I^2C = 1$ : $I^2C$ is disabled  |
| ID       | 6       | R      | 0           | ID timer bit  |
|          |         |        |             | ID = 0: ID is active<br>ID = 1: ID is disabled  |
| Ю        | 5       | R      | 0           | IO timer bit  |
|          |         |        |             | IO = 0: GPIO is active<br>IO = 1: GPIO is disabled  |

Table 3-28. Peripheral IDLE Status Register Bit Field Description (Continued)

| BIT NAME | BIT NO. | ACCESS | RESET VALUE | DESCRIPTION  |
|----------|---------|--------|-------------|--|
| Reserved | 4       | R      | 0           | Reserved   |
| SP1      | 3       | R      | 0           | McBSP1 timer bit  SP1 = 0: McBSP1 is active                |
|          |         |        |             | SP1 = 1: McBSP1 is disabled                                |
| SP0      | 2       | R      | 0           | McBSP0 timer bit   |
|          |         |        |             | SP0 = 0: McBSP0 is active<br>SP0 = 1: McBSP0 is disabled   |
| TIM1     | 1       | R      | 0           | TIMER1 timer bit   |
|          |         |        |             | TIM1 = 0: TIMER1 is active TIM1 = 1: TIMER1 is disabled    |
| TIMO     | 0       | R      | 0           | TIMER0 timer bit   |
|          |         |        |             | TIM0 = 0: TIMER0 is active<br>TIM0 = 1: TIMER0 is disabled |

# 3.10.7.5 Master IDLE Control Register (MICR)

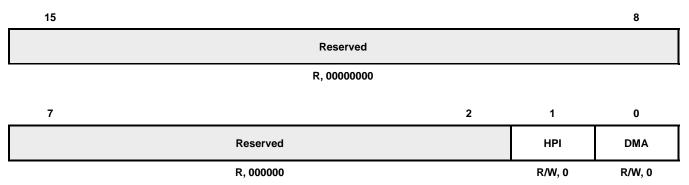
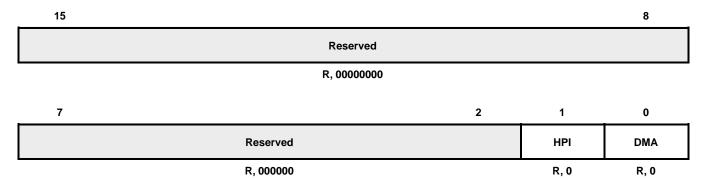


Figure 3–27. Master IDLE Control Register Layout (0x9402)

Table 3-29. Master IDLE Control Register Bit Field Description

| BIT NAME | BIT NO. | ACCESS | RESET VALUE    |                      | DESCRIPTION   |
|----------|---------|--------|----------------|----------------------|---|
| Reserved | 15–2    | R      | 00000000000000 | Reserved             |   |
| HPI      | 1       | R/W    | 0              | HPI bit              |   |
|          |         |        |                | HPI = 0:<br>HPI = 1: | HPI remains active when ISTR.MPIS becomes 1 HPI is disabled when ISTR.MPIS becomes 1    |
| DMA      | 0       | R/W    | 0              | DMA bit              |   |
|          |         |        |                | DMA = 0:<br>DMA = 1: | DMA remains active when ISTR.MPIS becomes 1<br>DMA is disabled when ISTR.MPIS becomes 1 |

#### 3.10.7.6 Master IDLE Status Register (MISR)



**LEGEND:** R = Read, W = Write, n = value at reset

Figure 3–28. Master IDLE Status Register Layout (0x9403)

Table 3-30. Master IDLE Status Register Bit Field Description

| BIT NAME | BIT NO. | ACCESS | RESET VALUE   | DESCRIPTION   |  |  |
|----------|---------|--------|---------------|---|--|--|
| Reserved | 15–2    | R      | 0000000000000 | Reserved  |  |  |
| НРІ      | 1       | R      | 0             | HPI bit  HPI = 0: HPI is active HPI = 1: HPI is in IDLE status  |  |  |
| DMA      | 0       | R      | 0             | DMA bit  DMA = 0: DMA is active  DMA = 1: DMA is in IDLE status |  |  |

### 3.11 General-Purpose I/O (GPIO)

The 5501 includes an 8-bit I/O port solely for general-purpose inputs and outputs. Several dual-purpose (multiplexed) pins complement the dedicated GPIO pins. The following sections describe the 8-bit GPIO port as well as the dual GPIO functions of the Parallel Port Mux and Host Port Mux pins.

#### 3.11.1 General-Purpose I/O Port

The general-purpose I/O port consists of eight individually bit-selectable I/O pins GPIO0 (LSB) through GPIO7 (MSB). The I/O port is controlled using two registers—IODIR and IODATA—that can be accessed by the CPU or by the DMA, via the peripheral bus controller. The General-Purpose I/O Direction Register (IODIR) is mapped at address 0x3400, and the General-Purpose I/O Data Register (IODATA) is mapped at address 0x3401.

Figure 3–29 and Figure 3–30 show the bit layout of IODIR and IODATA, respectively. Table 3–31 and Table 3–32 describe the bit fields of these registers.

#### 3.11.1.1 General-Purpose I/O Direction Register (IODIR)

15 8 Reserved R, 00000000 7 5 0 6 3 2 1 **IO7DIR IO6DIR** IO5DIR **IO4DIR IO3DIR IO2DIR IO1DIR IO0DIR** R/W, 0 R/W, 0

**LEGEND:** R = Read, W = Write, n = value at reset

Figure 3-29. GPIO Direction Register Layout (0x3400)

Table 3-31. GPIO Direction Register Bit Field Description<sup>†</sup>

| RESET VALUE | DESCRIPTION  |
|-------------|--|
| 00000000    | Reserved   |
|             | Data direction bits that configure the GPIO pins as inputs or outputs.  IOXDIR = 0: Configure corresponding GPIO pin as an input IOXDIR = 1: Configure corresponding GPIO pin as an output |
|             | 00000000   |

 $\uparrow$  x = value from 0 to 7

### 3.11.1.2 General-Purpose I/O Data Register (IODATA)

15 8 Reserved R, 00000000 7 6 5 3 2 0 IO7D IO6D IO5D IO4D IO3D IO2D IO1D IO0D R/W, pin R/W, pin

**LEGEND:** R = Read, W = Write, n = value at reset, pin = the reset value depends on the signal level on the corresponding I/O pin.

Figure 3-30. GPIO Data Register Layout (0x3401)

Table 3-32. GPIO Data Register Bit Field Description<sup>†</sup>

| BIT NAME | BIT NO. | ACCESS | RESET VALUE   | DESCRIPTION   |
|----------|---------|--------|---|---|
| Reserved | 15–8    | R      | 00000000  | Reserved  |
| IOxD     | 7–0     | R/W    | Depends on the signal level on<br>the corresponding I/O pin | Data bits that are used to control the level of the I/O pins configured as outputs and to monitor the level of the I/O pins configured as inputs.  If IOxDIR = 0, then: IOxD = 0: Corresponding GPIO pin is read as a low IOxD = 1: Corresponding GPIO pin is read as a high  If IOxDIR = 1, then: IOxD = 0: Set corresponding GPIO pin to low IOxD = 1: Set corresponding GPIO pin to high |

 $\uparrow$  x = value from 0 to 7

### 3.11.2 Parallel Port General-Purpose I/O (PGPIO)

The 4 address signals (EMIF.A[21:18]), 8 host data signals (HD[7:0]), 2 HPI control signals (HC1–HC0), and 16 control signals (C[15:0]) can be individually enabled as PGPIO when the Parallel Port Mux Mode bit field of the External Bus Selection Register (XBSR) is cleared for PGPIO mode. (See Table 3–33.) Sixteen pins, PGPIO[19:4], are dedicated to parallel general-purpose I/O. These pins are controlled by three set of registers: the PGPIO enable registers, the PGPIO direction registers, and the PGPIO data registers.

- The PGPIO enable registers PGPIOEN0–PGPIOEN2 (see Figure 3–31, Figure 3–34, and Figure 3–37) determine if the pin serves as PGPIO or if it is placed in high-impedance state.
- The PGPIO direction registers PGPIODIR0–PGPIODIR2 (see Figure 3–32, Figure 3–35, and Figure 3–38) determine if the pin is an input or output.
- The PGPIO data registers PGPIODAT0-PGPIODAT2 (see Figure 3–33, Figure 3–36, and Figure 3–39) store the value read or written externally.

**NOTE:** The enable registers PGPIOENn cannot override the External Bus Selection Register (XBSR) setting.

Table 3-33. TMS320VC5501 PGPIO Cross-Reference

| PIN         | PARALLEL PORT MUX MODE = 0<br>(PGPIO) | PARALLEL PORT MUX MODE = 1<br>(FULL EMIF) |
|-------------|---------------------------------------|---|
|             | EMIF Address Bus                      |   |
| A[21:18]    | PGPIO[3:0]                            | EMIF.A[21:18]                             |
|             | EMIF Data Bus                         | •   |
| PGPIO[19:4] | PGPIO[19:4]                           | Reserved                                  |
|             | EMIF Control Bus                      | •   |
| C0          | PGPIO20                               | EMIF.ARE/SADS/SDCAS/SRE                   |
| C1          | PGPIO21                               | EMIF.AOE/SOE/SDRAS                        |
| C2          | PGPIO22                               | EMIF.AWE/SWE/SDWE                         |
| C3          | PGPIO23                               | EMIF.ARDY                                 |
| C4          | PGPIO24                               | EMIF.CE0                                  |
| C5          | PGPIO25                               | EMIF.CE1                                  |
| C6          | PGPIO26                               | EMIF.CE2                                  |
| C7          | PGPIO27                               | EMIF.CE3                                  |
| C8          | PGPIO28                               | EMIF.BE0                                  |
| C9          | PGPIO29                               | EMIF.BE1                                  |
| C10         | PGPIO30                               | EMIF.BE2                                  |
| C11         | PGPIO31                               | EMIF.BE3                                  |
| C12         | PGPIO32                               | EMIF.SDCKE                                |
| C13         | PGPIO33                               | EMIF.SOE3                                 |
| C14         | PGPIO34                               | EMIF.HOLD                                 |
| C15         | PGPIO35                               | EMIF.HOLDA                                |
|             | HPI Data Bus                          |   |
| HD[7:0]     | PGPIO[43:36]                          | HPI.HD[7:0]                               |
|             | HPI Control Bus                       | ·   |
| HC0         | PGPIO44                               | HPI.HAS                                   |
| HC1         | PGPIO45                               | HPI.HBIL                                  |

### 3.11.2.1 Parallel GPIO Enable Register 0 (PGPIOEN0)

| 15     | 14     | 13     | 12     | 11     | 10     | 9      | 8      |
|--------|--------|--------|--------|--------|--------|--------|--------|
| IO15EN | IO14EN | IO13EN | IO12EN | IO11EN | IO10EN | IO9EN  | IO8EN  |
| R/W, 0 |
| 7      | 6      | 5      | 4      | 3      | 2      | 1      | 0      |
| IO7EN  | IO6EN  | IO5EN  | IO4EN  | IO3EN  | IO2EN  | IO1EN  | IO0EN  |
| R/W, 0 |

**LEGEND:** R = Read, W = Write, n = value at reset

Figure 3-31. Parallel GPIO Enable Register 0 Layout (0x4400)

Table 3-34. Parallel GPIO Enable Register 0 Bit Field Description<sup>†</sup>

| BIT NAME | BIT NO. | ACCESS | RESET VALUE                             | DESCRIPTION   |
|----------|---------|--------|---|---|
| IOXEN    | 15–0    | R/W    | 000000000000000000000000000000000000000 | Enable or disable GPIO function of the EMIF address bus EMIF.A[21:18] and the EMIF data bus EMIF.D[27:16]. See Table 3–4.  IOxEN = 0: GPIO function of corresponding signal is disabled, i.e., the pin goes into a high-impedance state.  IOxEN = 1: GPIO function of corresponding signal is enabled, i.e., the signal supports its GPIO function. |
|          |         |        |   | Bits [3:0] correspond to EMIF.A[21:18]  |

 $<sup>\</sup>dagger x = \text{value from 0 to 15}$ 

### 3.11.2.2 Parallel GPIO Direction Register 0 (PGPIODIR0)

| 15      | 14      | 13      | 12      | 11      | 10      | 9      | 8      |
|---------|---------|---------|---------|---------|---------|--------|--------|
| IO15DIR | IO14DIR | IO13DIR | IO12DIR | IO11DIR | IO10DIR | IO9DIR | IO8DIR |
| R/W, 0  | R/W, 0 | R/W, 0 |
| 7       | 6       | 5       | 4       | 3       | 2       | 1      | 0      |
| IO7DIR  | IO6DIR  | IO5DIR  | IO4DIR  | IO3DIR  | IO2DIR  | IO1DIR | IO0DIR |
| R/W, 0  | R/W, 0 | R/W, 0 |

**LEGEND:** R = Read, W = Write, n = value at reset

Figure 3-32. Parallel GPIO Direction Register 0 Layout (0x4401)

Table 3-35. Parallel GPIO Direction Register 0 Bit Field Description<sup>†</sup>

|          |         |        |   | -  |
|----------|---------|--------|---|--|
| BIT NAME | BIT NO. | ACCESS | RESET VALUE                             | DESCRIPTION  |
| IOxDIR   | 15–0    | R/W    | 000000000000000000000000000000000000000 | Data direction bits that configure corresponding I/O pins either as inputs or outputs. See Table 3–4.      |
|          |         |        |   | IOxDIR = 0: Configure corresponding pin as an input. IOxDIR = 1: Configure corresponding pin as an output. |
|          |         |        |   | Bits [3:0] correspond to EMIF.A[21:18]   |

 $^{\dagger}$  x = value from 0 to 15

### 3.11.2.3 Parallel GPIO Data Register 0 (PGPIODAT0)

| 15       | 14       | 13       | 12       | 11       | 10       | 9        | 8        |
|----------|----------|----------|----------|----------|----------|----------|----------|
| IO15DAT  | IO14DAT  | IO13DAT  | IO12DAT  | IO11DAT  | IO10DAT  | IO9DAT   | IO8DAT   |
| R/W, pin |
| 7        | 6        | 5        | 4        | 3        | 2        | 1        | 0        |
|          |          |          |          |          |          |          |          |
| IO7DAT   | IO6DAT   | IO5DAT   | IO4DAT   | IO3DAT   | IO2DAT   | IO1DAT   | IO0DAT   |

**LEGEND:** R = Read, W = Write, n = value at reset, pin = the reset value depends on the signal level on the corresponding I/O pin.

Figure 3–33. Parallel GPIO Data Register 0 Layout (0x4402)

Table 3-36. Parallel GPIO Data Register 0 Bit Field Description<sup>†</sup>

| BIT NAME | BIT NO. | ACCESS | RESET VALUE  | DESCRIPTION  |
|----------|---------|--------|--|--|
| IOxDAT   | 15–0    | R/W    | Depends on the signal level on the corresponding I/O pin | Data bits that are used to control the level of the corresponding I/O pins configured as output pins and to monitor the level of the corresponding I/O pins configured as input pins. See Table 3–4. |
|          |         |        |  | If IOxDIR = 0, then:   |
|          |         |        |  | IOxDAT = 0: Corresponding I/O pin is read as a low IOxDAT = 1: Corresponding I/O pin is read as a high   |
|          |         |        |  | If IOxDIR = 1, then:   |
|          |         |        |  | IOxDAT = 0: Set corresponding I/O pin to low IOxDAT = 1: Set corresponding I/O pin to high   |
|          |         |        |  | Bits [3:0] correspond to EMIF.A[21:18]   |

 $\dagger x = \text{value from 0 to 15}$ 

### 3.11.2.4 Parallel GPIO Enable Register 1 (PGPIOEN1)

| 15     | 14     | 13     | 12     | 11     | 10     | 9      | 8      |
|--------|--------|--------|--------|--------|--------|--------|--------|
| IO31EN | IO30EN | IO29EN | IO28EN | IO27EN | IO26EN | IO25EN | IO24EN |
| R/W, 0 |
| 7      | 6      | 5      | 4      | 3      | 2      | 1      | 0      |
| IO23EN | IO22EN | IO21EN | IO20EN | IO19EN | IO18EN | IO17EN | IO16EN |
| R/W, 0 |

**LEGEND:** R = Read, W = Write, n = value at reset

Figure 3-34. Parallel GPIO Enable Register 1 Layout (0x4403)

Table 3-37. Parallel GPIO Enable Register 1 Bit Field Description<sup>†</sup>

| BIT NAME | BIT NO. | ACCESS | RESET VALUE       | DESCRIPTION   |  |  |
|----------|---------|--------|-------------------|---|--|--|
| IOxEN    | 15–0    | R/W    | 00000000000000000 | Enable or disable GPIO function of the EMIF data bus EMIF.D[31 and the EMIF control signals C[11:0]. See Table 3–4. |  |  |
|          |         |        |                   | IOxEN = 0:  | GPIO function of corresponding signal is disabled, i.e., the pin goes into a high-impedance state. |  |
|          |         |        |                   | IOxEN = 1:  | GPIO function of corresponding signal is enabled, i.e., the signal supports its GPIO function.     |  |
|          |         |        |                   | Bits [15:4] corr  | respond to C[11:0]   |  |

 $\dagger$  x = value from 16 to 31

### 3.11.2.5 Parallel GPIO Direction Register 1 (PGPIODIR1)

| 15      | 14      | 13      | 12      | 11      | 10      | 9       | 8       |
|---------|---------|---------|---------|---------|---------|---------|---------|
| IO31DIR | IO30DIR | IO29DIR | IO28DIR | IO27DIR | IO26DIR | IO25DIR | IO24DIR |
| R/W, 0  |
| <br>7   | 6       | 5       | 4       | 3       | 2       | 1       | 0       |
| IO23DIR | IO22DIR | IO21DIR | IO20DIR | IO19DIR | IO18DIR | IO17DIR | IO16DIR |
| R/W, 0  |

**LEGEND:** R = Read, W = Write, n = value at reset

Figure 3–35. Parallel GPIO Direction Register 1 Layout (0x4404)

Table 3-38. Parallel GPIO Direction Register 1 Bit Field Description<sup>†</sup>

| BIT NAME | BIT NO. | ACCESS | RESET VALUE                             | DESCRIPTION  |
|----------|---------|--------|---|--|
| IOxDIR   | 15–0    | R/W    | 000000000000000000000000000000000000000 | Data direction bits that configure corresponding I/O pins either as inputs or outputs. See Table 3–4.  IOxDIR = 0: Configure corresponding pin as an input. IOxDIR = 1: Configure corresponding pin as an output.  Bits [15:4] correspond to C[11:0] |

 $^{\dagger}$  x = value from 16 to 31

### 3.11.2.6 Parallel GPIO Data Register 1 (PGPIODAT1)

| 15       | 14       | 13       | 12       | 11       | 10       | 9        | 8        |
|----------|----------|----------|----------|----------|----------|----------|----------|
| IO31DAT  | IO30DAT  | IO29DAT  | IO28DAT  | IO27DAT  | IO26DAT  | IO25DAT  | IO24DAT  |
| R/W, pin |
| 7        | 6        | 5        | 4        | 3        | 2        | 1        | 0        |
| IO23DAT  | IO22DAT  | IO21DAT  | IO20DAT  | IO19DAT  | IO18DAT  | IO17DAT  | IO16DAT  |
|          | IOZZDAI  | IOZIDAI  | IOZUDAI  | IOTSDAT  | IOTODAT  | IOTZDAT  | IOTODAT  |

**LEGEND:** R = Read, W = Write, n = value at reset, pin = the reset value depends on the signal level on the corresponding I/O pin.

Figure 3–36. Parallel GPIO Data Register 1 Layout (0x4405)

Table 3–39. Parallel GPIO Data Register 1 Bit Field Description<sup>†</sup>

| BIT NAME | BIT NO. | ACCESS | RESET VALUE   | DESCRIPTION   |
|----------|---------|--------|---|---|
| IOxDAT   | 15–0    | R/W    | Depends on the signal level on<br>the corresponding I/O pin | Data bits used to control the level of the corresponding I/O pins configured as output pins and to monitor the level of the corresponding I/O pins configured as input pins. See Table 3–4.  If IOxDIR = 0, then:  IOxDAT = 0: Corresponding I/O pin is read as a low |
|          |         |        |   | IOxDAT = 1: Corresponding I/O pin is read as a high   |
|          |         |        |   | If IOxDIR = 1, then:  |
|          |         |        |   | IOxDAT = 0: Set corresponding I/O pin to low IOxDAT = 1: Set corresponding I/O pin to high  |
|          |         |        |   | Bits [15:4] correspond to C[11:0]   |

 $\dagger$  x = value from 16 to 31

### 3.11.2.7 Parallel GPIO Enable Register 2 (PGPIOEN2)

| 15     | 14       | 13     | 12     | 11     | 10     | 9      | 8      |
|--------|----------|--------|--------|--------|--------|--------|--------|
| Res    | Reserved |        | IO44EN | IO43EN | IO42EN | IO41EN | IO40EN |
| R/V    | V, 00    | R/W, 0 |
| 7      | 6        | 5      | 4      | 3      | 2      | 1      | 0      |
| IO39EN | IO38EN   | IO37EN | IO36EN | IO35EN | IO34EN | IO33EN | IO32EN |
| R/W, 0 | R/W, 0   | R/W, 0 | R/W, 0 | R/W, 0 | R/W, 0 | R/W, 0 | R/W, 0 |

**LEGEND:** R = Read, W = Write, n = value at reset

Figure 3-37. Parallel GPIO Enable Register 2 Layout (0x4406)

Table 3-40. Parallel GPIO Enable Register 2 Bit Field Description<sup>†</sup>

| BIT NAME | BIT NO. | ACCESS | RESET VALUE                             | DESCRIPTION  |  |  |
|----------|---------|--------|---|--|--|--|
| Reserved | 15–14   | R/W    | 00                                      | Reserved   |  |  |
| IOxEN    | 13–0    | R/W    | 000000000000000000000000000000000000000 | Enable or disable GPIO function of the EMIF control signals C[15:12], the HPI data pins HD[7:0], and the HPI control signals HC[1:0]. See Table 3–4 and Table 3–5.  IOXEN = 0: GPIO function of corresponding signal is disabled, i.e., the pin goes into a high-impedance state.  IOXEN = 1: GPIO function of corresponding signal is |  |  |
|          |         |        |   | enabled, i.e., the signal supports its GPIO function.  Bits [13:12] correspond to HC[1:0] Bits [11:4] correspond to HD[7:0] Bits [3:0] correspond to C[15:12]  |  |  |

 $\dagger$  x = value from 32 to 45

# 3.11.2.8 Parallel GPIO Direction Register 2 (PGPIODIR2)

| 15      | 14            | 13      | 12      | 11      | 10      | 9       | 8       |
|---------|---------------|---------|---------|---------|---------|---------|---------|
| Rese    | erved         | IO45DIR | IO44DIR | IO43DIR | IO42DIR | IO41DIR | IO40DIR |
| R/V     | <i>I</i> , 00 | R/W, 0  |
| 7       | 6             | 5       | 4       | 3       | 2       | 1       | 0       |
| IO39DIR | IO38DIR       | IO37DIR | IO36DIR | IO35DIR | IO34DIR | IO33DIR | IO32DIR |
| R/W, 0  | R/W, 0        | R/W, 0  | R/W, 0  | R/W, 0  | R/W, 0  | R/W, 0  | R/W, 0  |

Figure 3–38. Parallel GPIO Direction Register 2 Layout (0x4407)

Table 3-41. Parallel GPIO Direction Register 2 Bit Field Description<sup>†</sup>

| BIT NAME | BIT NO. | ACCESS | RESET VALUE     | DESCRIPTION   |
|----------|---------|--------|-----------------|---|
| Reserved | 15–14   | R/W    | 00              | Reserved  |
| IOxDIR   | 13–0    | R/W    | 000000000000000 | Data direction bits that configure corresponding I/O pins either as inputs or outputs. See Table 3–4 and Table 3–5.  IOxDIR = 0: Configure corresponding pin as an input. IOxDIR = 1: Configure corresponding pin as an output.  Bits [13:12] correspond to HC[1:0] Bits [11:4] correspond to HD[7:0] Bits [3:0] correspond to C[15:12] |

 $<sup>\</sup>dagger$  x = value from 32 to 45

### 3.11.2.9 Parallel GPIO Data Register 2 (PGPIODAT2)

| 15       | 14       | 13       | 12       | 11       | 10       | 9        | 8        |
|----------|----------|----------|----------|----------|----------|----------|----------|
| Res      | erved    | IO45DAT  | IO44DAT  | IO43DAT  | IO42DAT  | IO41DAT  | IO40DAT  |
| R/V      | V, 00    | R/W, pin |
| 7        | 6        | 5        | 4        | 3        | 2        | 1        | 0        |
| IO39DAT  | IO38DAT  | IO37DAT  | IO36DAT  | IO35DAT  | IO34DAT  | IO33DAT  | IO32DAT  |
| R/W, pin |

**LEGEND:** R = Read, W = Write, n = value at reset, pin = the reset value depends on the signal level on the corresponding I/O pin.

Figure 3-39. Parallel GPIO Data Register 2 Layout (0x4408)

Table 3-42. Parallel GPIO Data Register 2 Bit Field Description<sup>†</sup>

| BIT NAME | BIT NO. | ACCESS | RESET VALUE   | DESCRIPTION  |
|----------|---------|--------|---|--|
| Reserved | 15–14   | R/W    | 00  | Reserved   |
| IOxDAT   | 13–0    | R/W    | Depends on the signal level on<br>the corresponding I/O pin | Data bits used to control the level of the I/O pins configured as output pins, and to monitor the level of the corresponding I/O pins configured as input pins. See Table 3–4 and Table 3–5.  If IOxDIR = 0, then: |
|          |         |        |   | IOxDAT = 0: Corresponding I/O pin is read as a low IOxDAT = 1: Corresponding I/O pin is read as a high   |
|          |         |        |   | If IOxDIR = 1, then:   |
|          |         |        |   | IOxDAT = 0: Set corresponding I/O pin to low IOxDAT = 1: Set corresponding I/O pin to high   |
|          |         |        |   | Bits [13:12] correspond to HC[1:0]<br>Bits [11:4] correspond to HD[7:0]<br>Bits [3:0] correspond to C[15:12]   |

 $<sup>\</sup>dagger$  x = value from 32 to 45

74

### 3.12 External Bus Control Register

The External Bus Control Register is used to disable/enable the bus pullups, pulldowns, and bus holders of the 5501 pins. Table 3–43 lists which 5501 pins have pullups, pulldowns, and bus holders and which bit on the XBCR enables/disables that feature. Note: for pins with dual functionality (e.g., HC0, HC1, C0, etc.), the bus holder, pullup, and pulldown feature of each pin can be enabled or disabled regardless of the function of the pin at the time.

Table 3-43. Pins With Pullups, Pulldowns, and Bus Holders

| XBCR CONTROL BIT | PIN         | FEATURE    |
|------------------|-------------|------------|
|                  | TCK         | Pullup     |
| EMU              | TDI         | Pullup     |
| ЕМО              | TMS         | Pullup     |
|                  | TRST        | Pulldown   |
| TEST             | EMU0        | Pullup     |
| TEST             | EMU1/OFF    | Pullup     |
| WDT              | NMI/WDTOUT  | Pullup     |
| HC               | HC0         | Pullup     |
| I IIC            | HC1         | Pulldown   |
| HD               | HD[7:0]     | Bus Holder |
|                  | C0          | Bus Holder |
|                  | C1          | Bus Holder |
|                  | C2          | Bus Holder |
|                  | C3          | Pullup     |
|                  | C4          | Bus Holder |
|                  | C5          | Bus Holder |
|                  | C6          | Bus Holder |
| PC               | C7          | Bus Holder |
| 10               | C8          | Bus Holder |
|                  | C9          | Bus Holder |
|                  | C10         | Bus Holder |
|                  | C11         | Bus Holder |
|                  | C12         | Bus Holder |
|                  | C13         | Bus Holder |
|                  | C14         | Pullup     |
|                  | C15         | Bus Holder |
| PD               | D[15:0]     | Bus Holder |
| FD               | PGPIO[19:4] | Bus Holder |
| PA               | A[21:2]     | Bus Holder |

# 3.12.1 External Bus Control Register (XBCR)

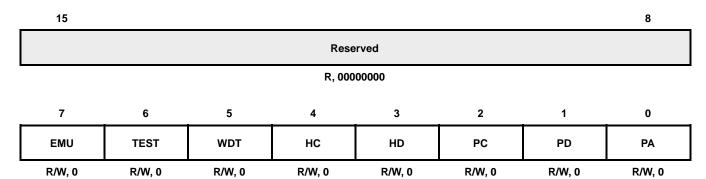


Figure 3-40. External Bus Control Register Layout (0x6C01)

Table 3-44. External Bus Control Register Bit Field Description

| BIT NAME | BIT NO. | ACCESS | RESET VALUE | DESCRIPTION  |
|----------|---------|--------|-------------|--|
| Reserved | 15–8    | R      | 00000000    | Reserved   |
| EMU      | 7       | R/W    | 0           | EMU bit  |
|          |         |        |             | EMU = 0: Pullups on EMU1 and EMU0 pins are enabled.<br>EMU = 1: Pullups on EMU1 and EMU0 pins are disabled.  |
| TEST     | 6       | R/W    | 0           | TEST bit   |
|          |         |        |             | TEST = 0: Pullups/pulldowns on test pins are enabled (does not include EMU1 and EMU0 pins) TEST = 1: Pullups/pulldowns on test pins are disabled (does not include EMU1 and EMU0 pins)   |
| WDT      | 5       | R/W    | 0           | WDT bit  |
|          |         |        |             | WDT = 0: Pullup on NMI/WDTOUT pin is enabled WDT = 1: Pullup on NMI/WDTOUT pin is disabled   |
| HC       | 4       | R/W    | 0           | HPI control signal bit   |
|          |         |        |             | HC = 0: Pullups/pulldowns on HPI control pins (HC0 and HC1) are enabled HC = 1: Pullups/pulldowns on HPI control pins (HC0 and HC1) are disabled   |
| HD       | 3       | R/W    | 0           | HPI data bus bit   |
|          |         |        |             | HD = 0: Bus holders on HPI data bus (pins HD[7:0]) are enabled HD = 1: Bus holders on HPI data bus (pins HD[7:0]) are disabled   |
| PC       | 2       | R/W    | 0           | EMIF control signals   |
|          |         |        |             | PC = 0: Bus holders and pullups on EMIF control pins are enabled PC = 1: Bus holders and pullups on EMIF control pins are disabled   |
| PD       | 1       | R/W    | 0           | EMIF data bus signals  |
|          |         |        |             | PD = 0: Bus holders on EMIF data bus (pins D[15:0]) and parallel general-purpose I/O pins (PGPIO[19:4]) are enabled PD = 1: Bus holders on EMIF data bus (pins D[15:0]) and parallel general-purpose I/O pins (PGPIO[19:4]) are disabled |
| PA       | 0       | R/W    | 0           | EMIF address bus signals   |
|          |         |        |             | PA = 0: Bus holders on EMIF address bus (pins A[21:2]) are enabled PA = 1: Bus holders on EMIF address bus (pins A[21:2]) are disabled   |

### 3.13 Internal Ports and System Registers

The 5501 includes three internal ports that interface the CPU core with the peripheral modules. Although these ports cannot be directly controlled by user code, the registers associated with each port can be used to monitor a number of error conditions that could be generated through illegal operation of the 5501. The port registers are described in the following sections.

The 5501 also includes two registers that can be used to monitor and control several aspects of the interface between the CPU and the system-level peripherals, these registers are also described in the following sections.

#### 3.13.1 XPORT Interface

The XPORT interfaces the CPU core to all peripheral modules. The XPORT will generate bus errors for invalid accesses to any registers that fall under the ranges shown in Table 3–45. The INTERREN bit of the XPORT Configuration Register (XCR) controls the bus error feature of the XPORT. The INTERR bit of the XPORT Bus Error Register (XERR) is set to "1" when an error occurs during an access to a register listed in Table 3–45. The EBUS and DBUS bits can be used to distinguish whether the error occurred during a write or read access.

Table 3-45. I/O Addresses Under Scope of XPORT

| I/O ADDRESS RANGE |
|-------------------|
| 0x0000-0x03FF     |
| 0x1400-0x17FF     |
| 0x2000-0x23FF     |

The PERITO bit of the XERR is used to indicate that a CPU, DMA, or HPI access to a disabled/idled peripheral module has generated a time-out error. The time-out error feature is enabled through the PERITOEN bit of the Time-Out Control Register (TOCR). A time-out error is generated when 512 clock cycles pass without a response from the peripheral register.

The XPORT can be placed into idle by setting the XPORTI bit of the Idle Control Register (ICR) and executing the IDLE instruction. When the XPORT is in idle, it will stop accepting new peripheral module requests and it will also not check for internal I/O bus errors. If there is a request from the CPU core or a peripheral module, the XPORT will not respond and hang. The ICR register will generate a bus error if the XPORT is idled without the CPU or Master Port domains being in idle mode.

SPRS206

### 3.13.1.1 XPORT Configuration Register (XCR)

The XPORT Configuration Register bit layout is shown in Figure 3–41 and the bits are described in Table 3–46.

15 14

Reserved

R/W, 1 R, 0000000

7 0

Reserved

**LEGEND:** R = Read, W = Write, n = value at reset

Figure 3-41. XPORT Configuration Register Layout (0x0100)

R, 00000000

Table 3-46. XPORT Configuration Register Bit Field Description

| BIT NAME | BIT NO. | ACCESS | RESET VALUE     |   | DESCRIPTION  |
|----------|---------|--------|-----------------|---|--|
| INTERREN | 15      | R/W    | 1               | INTERREN bit  |  |
|          |         |        |                 | invalid<br>Note the<br>will ha<br>INTERREN = 1: The XI<br>access<br>that will | PORT will not generate a bus error for accesses to registers listed in Table 3–45. hat any invalid accesses to these registers ing the pipeline. PORT will generate a bus error for invalid ses to registers listed in Table 3–45.† Note hen a bus error occurs, any data returned read instruction will not be valid. |
| Reserved | 14–0    | R      | 000000000000000 | Reserved  |  |

This feature will not work if the XPORT is placed in idle through the ICR. However, a bus error will be generated if the XPORT is placed in idle without the CPU being in idle.

# 3.13.1.2 XPORT Bus Error Register (XERR)

The XPORT Bus Error Register bit layout is shown in Figure 3-42 and the bits are described in Table 3-47.

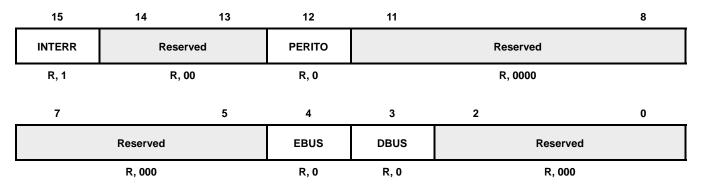


Figure 3–42. XPORT Bus Error Register Layout (0x0102)

Table 3-47. XPORT Bus Error Register Bit Field Description

| BIT NAME | BIT NO. | ACCESS | RESET VALUE | DESCRIPTION  |
|----------|---------|--------|-------------|--|
| INTERR   | 15      | R      | 1           | INTERR bit   |
|          |         |        |             | INTERR = 0: No error INTERR = 1: An error occurred during an access to one of the registers listed in Table 3–45.          |
| Reserved | 14–13   | R      | 00          | Reserved   |
| PERITO   | 12      | R      | 0           | PERITO bit   |
|          |         |        |             | PERITO = 0: No error PERITO = 1: A time-out error occurred during an access to a peripheral register.                      |
| Reserved | 11–5    | R      | 0000000     | Reserved   |
| EBUS     | 4       | R      | 0           | EBUS error bit <sup>†</sup>  |
|          |         |        |             | EBUS = 0: No error EBUS = 1: An error occurred during an EBUS access (write) to one of the registers listed in Table 3–45. |
| DBUS     | 3       | R      | 0           | DBUS error bit <sup>†</sup>  |
|          |         |        |             | DBUS = 0: No error DBUS = 1: An error occurred during a DBUS access (read) to one of the registers listed in Table 3–45.   |
| Reserved | 2–0     | R      | 000         | Reserved   |

<sup>†</sup> See the TMS320C55x DSP CPU Reference Guide (literature number SPRU371) for more information on the D-bus and E-bus.

#### 3.13.2 DPORT Interface

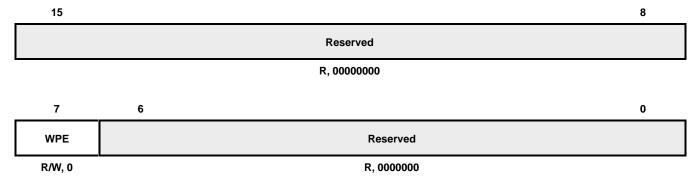
The DPORT interfaces the CPU to the EMIF module. The DPORT is capable of enabling write posting on the EMIF module. Write posting prevents stalls to the CPU during external memory writes. Two write posting registers, which are freely associated with E and F bus writes, exist within the DPORT and are used to store the write address and data so that writes can be zero wait state for the CPU. External memory writes will not generate stalls to the CPU unless the two write posting registers are filled. Write posting is enabled by setting the WPE bit of the DCR to 1.

The EMIFTO bit of the DERR is used to indicate that a CPU, DMA, HPI, or IPORT access to external memory has generated a time-out error. The time-out error feature is enabled through the EMIFTOEN bit of the Time-Out Control Register (TOCR). This function is not recommended during normal operation of the 5501.

The DPORT can be placed into idle through the EMIFI bit of the Idle Control Register (ICR) and executing the IDLE instruction. When the DPORT is in idle, it will stop accepting new EMIF requests. If there is a request from the CPU or the EMIF, the DPORT will not respond and hang. The ICR register will generate a bus error if the DPORT is idled without the CPU or Master Port domains being in idle.

#### 3.13.2.1 DPORT Configuration Register (DCR)

The DPORT Configuration Register bit layout is shown in Figure 3–43 and the bits are described in Table 3–48.



**LEGEND:** R = Read, W = Write, n = value at reset

Figure 3–43. DPORT Configuration Register Layout (0x0200)

Table 3-48. DPORT Configuration Register Bit Field Description<sup>†</sup>

| BIT NAME | BIT NO. | ACCESS | RESET VALUE | DESCRIPTION  |
|----------|---------|--------|-------------|--|
| Reserved | 15–8    | R      | 00000000    | Reserved   |
| WPE      | 7       | R/W    | 0           | Write Posting Enable bit <sup>†</sup> WPE = 0: Write posting disabled WPE = 1: Write posting enabled |
| Reserved | 6–0     | R      | 0000000     | Reserved   |

TWrite posting should not be enabled or disabled while the EMIF is conducting a transaction with external memory.

# 3.13.2.2 DPORT Bus Error Register (DERR)

The DPORT Bus Error Register bit layout is shown in Figure 3-44 and the bits are described in Table 3-49.

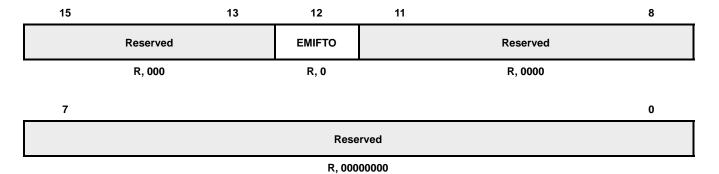


Figure 3–44. DPORT Bus Error Register Layout (0x0202)

Table 3-49. DPORT Bus Error Register Bit Field Description

|          |         |        |             | =   |
|----------|---------|--------|-------------|---|
| BIT NAME | BIT NO. | ACCESS | RESET VALUE | DESCRIPTION                                       |
| Reserved | 15–13   | R      | 000         | Reserved  |
| EMIFTO   | 12      | R      | 0           | EMIFTO bit  |
|          |         |        |             | EMIFTO = 0: No error<br>EMIFTO = 1: Error 1 error |
| Reserved | 11–0    | R      | 00000000000 | Reserved  |

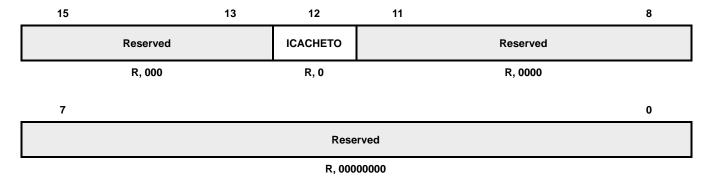
#### 3.13.3 IPORT Interface

The IPORT interfaces the I-Cache to the EMIF module. The ICACHETO bit of the IPORT Bus Error Register (IERR) can be used to determine if a time-out error has occurred during an ICACHE access to external memory. The time-out feature is enabled through the EMIFTOEN bit of the Time-Out Control Register (TOCR).

The IPORT can be placed into idle through the IPORTI bit of the Idle Control Register (ICR) and executing the IDLE instruction. The IPORT will go into idle when there are no new requests from the ICACHE. When the IPORT is in idle, it will stop accepting new requests from the CPU, it is important that the program flow not use external memory in this case. If there are requests from the CPU, the IPORT will not respond and hang. The ICR register will generate a bus error if the IPORT is idled without the CPU domain being in idle.

#### 3.13.3.1 IPORT Bus Error Register (IERR)

The IPORT Bus Error Register bit layout is shown in Figure 3-45 and the bits are described in Table 3-50.



**LEGEND:** R = Read, W = Write, *n* = value at reset

Figure 3-45. IPORT Bus Error Register Layout (0x0302)

Table 3-50. IPORT Bus Error Register Bit Field Description

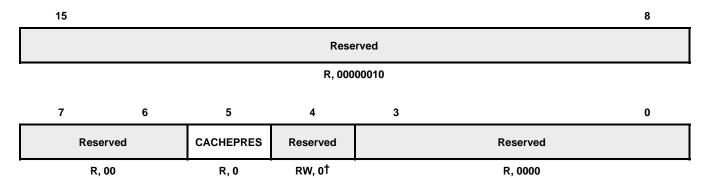
| BIT NAME | BIT NO. | ACCESS | RESET VALUE | DESCRIPTION  |
|----------|---------|--------|-------------|--|
| Reserved | 15–13   | R      | 000         | Reserved   |
| ICACHETO | 12      | R      | 0           | ICACHETO bit  ICACHETO = 0: No error ICACHETO = 1: A time-out error occurred during an ICACHE access to external memory. |
| Reserved | 11–0    | R      | 00000000000 | Reserved   |

See the TMS320C55x DSP CPU Reference Guide (literature number SPRU371) for more information on the P-bus.

## 3.13.4 System Configuration Register (CONFIG)

The System Configuration Register can be used to determine the operational state of the ICACHE. If the ICACHE is not functioning, the CACHEPRES bit of the CONFIG register will be cleared. If the ICACHE is functioning normally, this bit will be set.

The System Configuration Register bit layout is shown in Figure 3–46 and the bits are described in Table 3–51.



**LEGEND:** R = Read, W = Write, n = value at reset

Figure 3–46. System Configuration Register Layout (0x07FD)

Table 3-51. System Configuration Register Bit Field Description

| BIT NAME  | BIT NO. | ACCESS | RESET VALUE | DESCRIPTION   |
|-----------|---------|--------|-------------|---|
| Reserved  | 15–6    | R      | 000001000   | Reserved  |
| CACHEPRES | 5       | R      | 0           | ICACHE present  CACHEPRES = 0: ICACHE is not functioning CACHEPRES = 1: ICACHE is enabled and working |
| Reserved  | 4       | R/W    | 0†          | Reserved  |
| Reserved  | 3–0     | R      | 0000        | Reserved  |

<sup>†</sup> This Reserved bit *must* be kept as zero during any writes to CONFIG.

SPRS206

<sup>†</sup> This Reserved bit *must* be kept as zero during any writes to CONFIG.

### 3.13.5 Time-Out Control Register (TOCR)

The Time-Out Control Register can be used to select whether or not a time-out error is generated when an access to a disabled/idled peripheral module occurs. If the CPU or DMA access a disabled/idle peripheral module and 512 CPU clock cycles pass without an acknowledgement from the peripheral module, then a time-out error will be sent to the corresponding module if bit 1 in the Time-Out Control Register is set. A time-out error will generate a CPU bus error that can be serviced through software by using the bus error interrupt (BERR) (see Section 3.16, Interrupts, for more information on interrupts). If the DMA gets a time-out error, it will set the TIMEOUT bit in the DMA Status Register (DMACSR) and generate a time-out error that can be serviced through software by the CPU [see the *TMS320C55x DSP Peripherals Reference Guide* (literature number SPRU317) for more information on using this feature of the DMA].

The Time-Out Control Register can also be used to select whether or not a time-out error is generated when a memory access through the EMIF module stalls for more than 512 CPU clock cycles. It is recommended that this feature not be used for it can cause unexpected results.

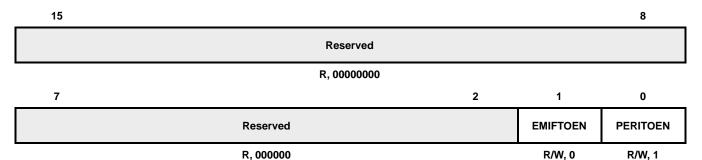


Figure 3-47. Time-Out Control Register Layout (0x9000)

Table 3-52. Time-Out Control Register Bit Field Description

| BIT NAME | BIT NO. | ACCESS | RESET VALUE    | DESCRIPTION   |  |
|----------|---------|--------|----------------|---|--|
| Reserved | 15–2    | R      | 00000000000000 | Reserved  |  |
| EMIFTOEN | 1       | R/W    | 0              | EMIF time-out control bit  EMIFTOEN = 0: A time-out error is not generated when an EMI access stalls for more than 512 CPU clock                  |  |
|          |         |        |                | cycles.  EMIFTOEN = 1: A time-out error is generated when an EMIF access stalls for more than 512 CPU clock cycles.                               |  |
| PERITOEN | 0       | R/W    | 1              | Peripheral module time-out control bit  |  |
|          |         |        |                | PERITOEN = 0: A time-out error is not generated when a CPU access to a disabled/idle peripheral module stalls for more than 512 CPU clock cycles. |  |
|          |         |        |                | PERITOEN = 1: A time-out error is generated when a CPU access to a disabled/idle peripheral module stalls for more than 512 CPU clock cycles.     |  |

## 3.14 CPU Memory-Mapped Registers

The 5501 has 78 memory-mapped CPU registers that are mapped in data memory space address 0h to 4Fh. Table 3–53 provides a list of the CPU memory-mapped registers (MMRs) available. The corresponding TMS320C54 $x^{TM}$  (C54 $x^{TM}$ ) CPU registers are also indicated where applicable.

Table 3-53. CPU Memory-Mapped Registers

| C54X<br>REGISTER | C55X<br>REGISTER | WORD ADDRESS<br>(HEX) | C55X REGISTER DESCRIPTION                           | BIT FIELD |
|------------------|------------------|-----------------------|---|-----------|
| IER              | IER0             | 00                    | Interrupt Enable Register 0                         | [15–0]    |
| IFR              | IFR0             | 01                    | Interrupt Flag Register 0                           | [15–0]    |
| _                | ST0_55           | 02                    | Status Register 0                                   | [15–0]    |
| _                | ST1_55           | 03                    | Status Register 1                                   | [15–0]    |
| _                | ST3_55           | 04                    | Status Register 3                                   | [15–0]    |
| _                | _                | 05                    | Reserved  | [15–0]    |
| ST0              | ST0              | 06                    | Status Register 0 (protected address for C54x code) | [15–0]    |
| ST1              | ST1              | 07                    | Status Register 1 (protected address for C54x code) | [15–0]    |
| AL               | AC0L             | 08                    |   | [15–0]    |
| AH               | AC0H             | 09                    | Accumulator 0                                       | [31–16]   |
| AG               | AC0G             | 0A                    |   | [39–32]   |
| BL               | AC1L             | 0B                    |   | [15–0]    |
| ВН               | AC1H             | 0C                    | Accumulator 1                                       | [31–16]   |
| BG               | AC1G             | 0D                    |   | [39–32]   |
| TREG             | T3               | 0E                    | Temporary Register 3                                | [15–0]    |
| TRN              | TRN0             | 0F                    | Transition Register 0                               | [15–0]    |
| AR0              | AR0              | 10                    | Auxiliary Register 0                                | [15–0]    |
| AR1              | AR1              | 11                    | Auxiliary Register 1                                | [15–0]    |
| AR2              | AR2              | 12                    | Auxiliary Register 2                                | [15–0]    |
| AR3              | AR3              | 13                    | Auxiliary Register 3                                | [15–0]    |
| AR4              | AR4              | 14                    | Auxiliary Register 4                                | [15–0]    |
| AR5              | AR5              | 15                    | Auxiliary Register 5                                | [15–0]    |
| AR6              | AR6              | 16                    | Auxiliary Register 6                                | [15–0]    |
| AR7              | AR7              | 17                    | Auxiliary Register 7                                | [15–0]    |
| SP               | SP               | 18                    | Data Stack Pointer                                  | [15–0]    |
| BK               | BK03             | 19                    | Circular Buffer Size Register for AR[0-3]           | [15–0]    |
| BRC              | BRC0             | 1A                    | Block Repeat Counter 0                              | [15–0]    |
| RSA              | RSA0L            | 1B                    | Low Part of Block Repeat Start Address Register 0   | [15–0]    |
| REA              | REA0L            | 1C                    | Low Part of Block Repeat End Address Register 0     | [15–0]    |
| PMST             | PMST             | 1D                    | Status Register 3 (protected address for C54x code) | [15–0]    |
| XPC              | XPC              | 1E                    | Program Counter Extension Register for C54x code    | [7–0]     |
| _                | _                | 1F                    | Reserved  | [15–0]    |
| _                | T0               | 20                    | Temporary Register 0                                | [15–0]    |
| _                | T1               | 21                    | Temporary Register 1                                | [15–0]    |
| _                | T2               | 22                    | Temporary Register 2                                | [15–0]    |
| _                | Т3               | 23                    | Temporary Register 3                                | [15–0]    |
| _                | AC2L             | 24                    | Accumulator 2                                       | [15–0]    |
| _                | AC2H             | 25                    |   | [31–16]   |
| _                | AC2G             | 26                    |   | [39–32]   |

TMS320C54x and C54x are trademarks of Texas Instruments.



SPRS206

# Table 3-53. CPU Memory-Mapped Registers (Continued)

| C54X<br>REGISTER | C55X<br>REGISTER | WORD ADDRESS<br>(HEX) | C55X REGISTER DESCRIPTION   | BIT FIELD |
|------------------|------------------|-----------------------|---|-----------|
| =                | CDP              | 27                    | Coefficient Data Pointer  | [15–0]    |
| _                | AC3L             | 28                    | Accumulator 3   | [15–0]    |
| _                | AC3H             | 29                    |   | [31–16]   |
| -                | AC3G             | 2A                    |   | [39–32]   |
| -                | DPH              | 2B                    | High Part of the Extended Data Page Register (XDP = DPH:DP)             | [6–0]     |
| -                | _                | 2C                    | Reserved  | [6–0]     |
| _                | _                | 2D                    | Reserved  | [6–0]     |
| -                | DP               | 2E                    | Data Page Register  | [15–0]    |
| -                | PDP              | 2F                    | Peripheral Data Page Register   | [8–0]     |
| _                | BK47             | 30                    | Circular Buffer Size Register for AR[4–7]                               | [15–0]    |
| _                | BKC              | 31                    | Circular Buffer Size Register for CDP                                   | [15–0]    |
| -                | BSA01            | 32                    | Circular Buffer Start Address Register for AR[0–1]                      | [15–0]    |
| _                | BSA23            | 33                    | Circular Buffer Start Address Register for AR[2–3]                      | [15–0]    |
| _                | BSA45            | 34                    | Circular Buffer Start Address Register for AR[4–5]                      | [15–0]    |
| _                | BSA67            | 35                    | Circular Buffer Start Address Register for AR[6–7]                      | [15–0]    |
| _                | BSAC             | 36                    | Circular Buffer Start Address Register for CDP                          | [15–0]    |
| _                | BIOS             | 37                    | Data Page Pointer Storage Location for 128-word Data Table              | [15–0]    |
| _                | TRN1             | 38                    | Transition Register 1   | [15–0]    |
| _                | BRC1             | 39                    | Block Repeat Counter 1  | [15–0]    |
| _                | BRS1             | 3A                    | BRC1 Save Register  | [15–0]    |
| _                | CSR              | 3B                    | Computed Single Repeat Register   | [15–0]    |
| _                | RSA0H            | 3C                    | Block Repeat Start Address Register 0                                   | [23–16]   |
| _                | RSA0L            | 3D                    |   | [15–0]    |
| _                | REA0H            | 3E                    | Block Repeat End Address Register 0                                     | [23–16]   |
| _                | REA0L            | 3F                    | -   | [15–0]    |
| -                | RSA1H            | 40                    | Block Repeat Start Address Register 1                                   | [23–16]   |
| _                | RSA1L            | 41                    |   | [15–0]    |
| _                | REA1H            | 42                    | Block Repeat End Address Register 1                                     | [23–16]   |
| _                | REA1L            | 43                    |   | [15–0]    |
| _                | RPTC             | 44                    | Single Repeat Counter   | [15–0]    |
| _                | IER1             | 45                    | Interrupt Enable Register 1   | [15–0]    |
| _                | IFR1             | 46                    | Interrupt Flag Register 1   | [15–0]    |
| _                | DBIER0           | 47                    | Debug Interrupt Enable Register 0                                       | [15–0]    |
| _                | DBIER1           | 48                    | Debug Interrupt Enable Register 0                                       | [15–0]    |
| _                | IVPD             | 49                    | Interrupt Vector Pointer  | [15–0]    |
| _                | IVPH             | 4A                    | Interrupt Vector Pointer  | [15–0]    |
| _                | ST2_55           | 4B                    | Status Register 2   | [15–0]    |
| _                | SSP              | 4C                    | System Stack Pointer  | [15–0]    |
| _                | SP               | 4D                    | Data Stack Pointer  | [15–0]    |
| -                | SPH              | 4E                    | High Part of the Extended Stack Pointers (XSP = SPH:SP, XSSP = SPH:SSP) | [6–0]     |
| _                | CDPH             | 4F                    | High Part of the Extended Coefficient Data Pointer (XCDP = CDPH:CDP)    | [6–0]     |

### 3.15 Peripheral Registers

Each 5501 device has a set of memory-mapped registers associated with peripherals as listed in Table 3–54 through Table 3–72. Some registers use less than 16 bits. When reading these registers, unused bits are always read as 0.

Table 3-54. Peripheral Bus Controller Configuration Registers

| WORD ADDRESS | REGISTER NAME | DESCRIPTION                    | RESET VALUET                |
|--------------|---------------|--------------------------------|-----------------------------|
| 0x0000       | CMR           | Control Mode Register          | 1111 1110 1001 0011         |
| 0x0001       | ICR           | Idle Configuration Register    | 0000 0000 0000 0000         |
| 0x0002       | ISTR          | Idle Status Register           | 0000 0000 0000 0000         |
| 0x0003       | PER1          | Priority Encoder Register 1    | 00001-00000000              |
| 0x0004       | PER2          | Priority Encoder Register 2    | 01100-0000010               |
| 0x0005       | PER3          | Priority Encoder Register 3    | 00111-00000110              |
| 0x0006       | PER4          | Priority Encoder Register 4    | 01001–00001000              |
| 0x0007       | PER5          | Priority Encoder Register 5    | 01111-00001110              |
| 0x0008       | PER6          | Priority Encoder Register 6    | 10101-00010000              |
| 0x0009       | PER7          | Priority Encoder Register 7    | 00100-00000011              |
| 0x000A       | PER8          | Priority Encoder Register 8    | 01011-00001000              |
| 0x000B       | PER9          | Priority Encoder Register 9    | 10010-00010001              |
| 0x000C       | PER10         | Priority Encoder Register 10   | 10100-00010011              |
| 0x000D       | PER11         | Priority Encoder Register 11   | 00101–00011101              |
| 0x000E       | Reserved      |                                |                             |
| 0x000F       | BOOT_MOD      | Boot Mode Register (read only) | Value of GPIO[2:0] at reset |
| 0x0010       | Reserved      |                                |                             |
| 0x0011       | Reserved      |                                |                             |
| 0x0100       | XCR           | XPORT Configuration Register   | 1000 0000 0000 0000         |
| 0x0102       | XERR          | XPORT Bus Error Register       | 1000 0000 0000 0000         |
| 0x0200       | DCR           | DPORT Configuration Register   | 0000 0000 0000 0000         |
| 0x0202       | DERR          | DPORT Bus Error Register       | 0000 0000 0000 0000         |
| 0x0302       | IERR          | IPORT Bus Error Register       | 0000 0000 0000 0000         |
| 0x07FD       | CONFIG        | System Configuration Register  | 0000 0001 0000 0000         |

<sup>†</sup>x denotes a "don't care."

86

Table 3-55. External Memory Interface Registers

| WORD ADDRESS             | REGISTER NAME | DESCRIPTION                           | RESET VALUET        |
|--------------------------|---------------|---------------------------------------|---------------------|
| 0x0800                   | EGCR1         | EMIF Global Control Register 1        | 0000 0000 0110 0000 |
| 0x0801                   | EGCR2         | EMIF Global Control Register 2        | 0000 0000 0000 1001 |
| 0x0802                   | CE1_1         | EMIF CE1 Space Control Register 1     | 1111 1111 1111 0011 |
| 0x0803                   | CE1_2         | EMIF CE1 Space Control Register 2     | 1111 1111 1111      |
| 0x0804                   | CE0_1         | EMIF CE0 Space Control Register 1     | 0000 0000 0000 0010 |
| 0x0805                   | CE0_2         | EMIF CE0 Space Control Register 2     | 0000 0000 0000 0000 |
| 0x0806                   | -             | Reserved                              |                     |
| 0x0807                   | -             | Reserved                              |                     |
| 0x0808                   | CE2_1         | EMIF CE2 Space Control Register 1     | 1111 1111 1111 0011 |
| 0x0809                   | CE2_2         | EMIF CE2 Space Control Register 2     | 1111 1111 1111      |
| 0x080A                   | CE3_1         | EMIF CE3 Space Control Register 1     | 1111 1111 1111 0011 |
| 0x080B                   | CE3_2         | EMIF CE3 Space Control Register 2     | 1111 1111 1111      |
| 0x080C                   | SDC1          | EMIF SDRAM Control Register 1         | 1111 0000 0000 0000 |
| 0x080D                   | SDC2          | EMIF SDRAM Control Register 2         | 0000 0011 0100 1000 |
| 0x080E                   | SDRC1         | EMIF SDRAM Refresh Control Register 1 | 1100 0101 1101 1100 |
| 0x080F                   | SDRC2         | EMIF SDRAM Refresh Control Register 2 | 0000 0000 0101 1101 |
| 0x0810                   | SDX1          | EMIF SDRAM Extension Register 1       | 1111 1001 0100 1000 |
| 0x0811                   | SDX2          | EMIF SDRAM Extension Register 2       | 1111 1001 0100 1000 |
| 0x0812                   | -             | Reserved                              |                     |
| :                        | -             | :                                     |                     |
| 0x0821                   | -             | Reserved                              |                     |
| 0x0822                   | CE1_SC1       | EMIF CE1 Secondary Control Register 1 | 0000 0000 0000 0010 |
| 0x0823                   | CE1_SC2       | EMIF CE1 Secondary Control Register 2 | 0000 0000 0000 0000 |
| 0x0824                   | CE0_SC1       | EMIF CE0 Secondary Control Register 1 | 0000 0000 0000 0010 |
| 0x0825                   | CE0_SC2       | EMIF CE0 Secondary Control Register 2 | 0000 0000 0000 0000 |
| 0x0826                   | -             | Reserved                              |                     |
| 0x0827                   | -             | Reserved                              |                     |
| 0x0828                   | CE2_SC1       | EMIF CE2 Secondary Control Register 1 | 0000 0000 0000 0010 |
| 0x0829                   | CE2_SC2       | EMIF CE2 Secondary Control Register 2 | 0000 0000 0000 0000 |
| 0x082A                   | CE3_SC1       | EMIF CE3 Secondary Control Register 1 | 0000 0000 0000 0010 |
| 0x082B                   | CE3_SC2       | EMIF CE3 Secondary Control Register 2 | 0000 0000 0000 0000 |
| 0x082C                   | -             | Reserved                              |                     |
| :                        | -             | :                                     |                     |
| 0x0839                   | -             | Reserved                              |                     |
| t x denotes a "don't car | · · "         |                                       |                     |

<sup>†</sup> x denotes a "don't care."

Table 3-56. DMA Configuration Registers

| WORD ADDRESS | REGISTER NAME  | DESCRIPTION  | RESET VALUE         |
|--------------|----------------|--|---------------------|
|              | <b>-</b>       | GLOBAL REGISTER  |                     |
| 0x0E00       | DMA_GCR(2:0)   | DMA Global Control Register                                    | 000                 |
| 0x0E01       | DMA_GTCR(3:0)  | DMA Global Timeout Control Register                            | 0000                |
|              | -              | CHANNEL #0 REGISTERS   |                     |
| 0x0C00       | DMA_CSDP0      | DMA Channel 0 Source Destination Parameters<br>Register        | 0000 0000 0000 0000 |
| 0x0C01       | DMA_CCR0(15:0) | DMA Channel 0 Control Register                                 | 0000 0000 0000 0000 |
| 0x0C02       | DMA_CICR0(5:0) | DMA Channel 0 Interrupt Control register                       | 00 0011             |
| 0x0C03       | DMA_CSR0(6:0)  | DMA Channel 0 Status register                                  | 00 0000             |
| 0x0C04       | DMA_CSSA_L0    | DMA Channel 0 Source Start Address, lower bits, register       | Undefined           |
| 0x0C05       | DMA_CSSA_U0    | DMA Channel 0 Source Start Address, upper bits, register       | Undefined           |
| 0x0C06       | DMA_CDSA_L0    | DMA Channel 0 Source Destination Address, lower bits, register | Undefined           |
| 0x0C07       | DMA_CDSA_U0    | DMA Channel 0 Source Destination Address, upper bits, register | Undefined           |
| 0x0C08       | DMA_CEN0       | DMA Channel 0 Element Number register                          | Undefined           |
| 0x0C09       | DMA_CFN0       | DMA Channel 0 Frame Number register                            | Undefined           |
| 0x0C0A       | DMA_CSFI0      | DMA Channel 0 Source Frame Index register                      | Undefined           |
| 0x0C0B       | DMA_CSEI0      | DMA Channel 0 Source Element Index register                    | Undefined           |
| 0x0C0C       | DMA_CSAC0      | DMA Channel 0 Source Address Counter register                  | Undefined           |
| 0x0C0D       | DMA_CDAC0      | DMA Channel 0 Destination Address Counter register             | Undefined           |
| 0x0C0E       | DMA_CDEI0      | DMA Channel 0 Destination Element Index register               | Undefined           |
| 0x0C0F       | DMA_CDFI0      | DMA Channel 0 Destination Frame Index register                 | Undefined           |
|              |                | CHANNEL #1 REGISTERS   |                     |
| 0x0C20       | DMA_CSDP1      | DMA Channel 1 Source Destination Parameters<br>Register        | 0000 0000 0000 0000 |
| 0x0C21       | DMA_CCR1(15:0) | DMA Channel 1 Control Register                                 | 0000 0000 0000 0000 |
| 0x0C22       | DMA_CICR1(5:0) | DMA Channel 1 Interrupt Control register                       | 00 0011             |
| 0x0C23       | DMA_CSR1(6:0)  | DMA Channel 1 Status register                                  | 00 0000             |
| 0x0C24       | DMA_CSSA_L1    | DMA Channel 1 Source Start Address, lower bits, register       | Undefined           |
| 0x0C25       | DMA_CSSA_U1    | DMA Channel 1 Source Start Address, upper bits, register       | Undefined           |
| 0x0C26       | DMA_CDSA_L1    | DMA Channel 1 Source Destination Address, lower bits, register | Undefined           |
| 0x0C27       | DMA_CDSA_U1    | DMA Channel 1 Source Destination Address, upper bits, register | Undefined           |
| 0x0C28       | DMA_CEN1       | DMA Channel 1 Element Number register                          | Undefined           |
| 0x0C29       | DMA_CFN1       | DMA Channel 1 Frame Number register                            | Undefined           |
| 0x0C2A       | DMA_CSFI1      | DMA Channel 1 Source Frame Index register                      | Undefined           |
| 0x0C2B       | DMA_CSEI1      | DMA Channel 1 Source Element Index register                    | Undefined           |
| 0x0C2C       | DMA_CSAC1      | DMA Channel 1 Source Address Counter register                  | Undefined           |
| 0x0C2D       | DMA_CDAC1      | DMA Channel 1 Destination Address Counter register             | Undefined           |
| 0x0C2E       | DMA_CDEI1      | DMA Channel 1 Destination Element Index register               | Undefined           |
| 0x0C2F       | DMA_CDFI1      | DMA Channel 1 Destination Frame Index register                 | Undefined           |

Table 3-56. DMA Configuration Registers (Continued)

| WORD ADDRESS | REGISTER NAME  | DESCRIPTION  | RESET VALUE         |
|--------------|----------------|--|---------------------|
|              | •              | CHANNEL #2 REGISTERS   |                     |
| 0x0C40       | DMA_CSDP2      | DMA Channel 2 Source Destination Parameters<br>Register        | 0000 0000 0000 0000 |
| 0x0C41       | DMA_CCR2(15:0) | DMA Channel 2 Control Register                                 | 0000 0000 0000 0000 |
| 0x0C42       | DMA_CICR2(5:0) | DMA Channel 2 Interrupt Control register                       | 00 0011             |
| 0x0C43       | DMA_CSR2(6:0)  | DMA Channel 2 Status register                                  | 00 0000             |
| 0x0C44       | DMA_CSSA_L2    | DMA Channel 2 Source Start Address, lower bits, register       | Undefined           |
| 0x0C45       | DMA_CSSA_U2    | DMA Channel 2 Source Start Address, upper bits, register       | Undefined           |
| 0x0C46       | DMA_CDSA_L2    | DMA Channel 2 Source Destination Address, lower bits, register | Undefined           |
| 0x0C47       | DMA_CDSA_U2    | DMA Channel 2 Source Destination Address, upper bits, register | Undefined           |
| 0x0C48       | DMA_CEN2       | DMA Channel 2 Element Number register                          | Undefined           |
| 0x0C49       | DMA_CFN2       | DMA Channel 2 Frame Number register                            | Undefined           |
| 0x0C4A       | DMA_CSFI2      | DMA Channel 2 Source Frame Index register                      | Undefined           |
| 0x0C4B       | DMA_CSEI2      | DMA Channel 2 Source Element Index register                    | Undefined           |
| 0x0C4C       | DMA_CSAC2      | DMA Channel 2 Source Address Counter register                  | Undefined           |
| 0x0C4D       | DMA_CDAC2      | DMA Channel 2 Destination Address Counter register             | Undefined           |
| 0x0C4E       | DMA_CDEI2      | DMA Channel 2 Destination Element Index register               | Undefined           |
| 0x0C4F       | DMA_CDFI2      | DMA Channel 2 Destination Frame Index register                 | Undefined           |
|              |                | CHANNEL #3 REGISTERS   |                     |
| 0x0C60       | DMA_CSDP3      | DMA Channel 3 Source Destination Parameters<br>Register        | 0000 0000 0000 0000 |
| 0x0C61       | DMA_CCR3(15:0) | DMA Channel 3 Control Register                                 | 0000 0000 0000 0000 |
| 0x0C62       | DMA_CICR3(5:0) | DMA Channel 3 Interrupt Control register                       | 00 0011             |
| 0x0C63       | DMA_CSR3(6:0)  | DMA Channel 3 Status register                                  | 00 0000             |
| 0x0C64       | DMA_CSSA_L3    | DMA Channel 3 Source Start Address, lower bits, register       | Undefined           |
| 0x0C65       | DMA_CSSA_U3    | DMA Channel 3 Source Start Address, upper bits, register       | Undefined           |
| 0x0C66       | DMA_CDSA_L3    | DMA Channel 3 Source Destination Address, lower bits, register | Undefined           |
| 0x0C67       | DMA_CDSA_U3    | DMA Channel 3 Source Destination Address, upper bits, register | Undefined           |
| 0x0C68       | DMA_CEN3       | DMA Channel 3 Element Number register                          | Undefined           |
| 0x0C69       | DMA_CFN3       | DMA Channel 3 Frame Number register                            | Undefined           |
| 0x0C6A       | DMA_CSFI3      | DMA Channel 3 Source Frame Index register                      | Undefined           |
| 0x0C6B       | DMA_CSEI3      | DMA Channel 3 Source Element Index register                    | Undefined           |
| 0x0C6C       | DMA_CSAC3      | DMA Channel 3 Source Address Counter register                  | Undefined           |
| 0x0C6D       | DMA_CDAC3      | DMA Channel 3 Destination Address Counter register             | Undefined           |
| 0x0C6E       | DMA_CDEI3      | DMA Channel 3 Destination Element Index register               | Undefined           |
| 0x0C6F       | DMA_CDFI3      | DMA Channel 3 Destination Frame Index register                 | Undefined           |

Table 3-56. DMA Configuration Registers (Continued)

| WORD ADDRESS | +              | DESCRIPTION  | DECET VALUE         |
|--------------|----------------|--|---------------------|
| WORD ADDRESS | REGISTER NAME  | DESCRIPTION  CHANNEL #4 REGISTERS                              | RESET VALUE         |
| 0v0000       | DMA CCDD4      |  | 0000 0000 0000 0000 |
| 0x0C80       | DMA_CSDP4      | DMA Channel 4 Source Destination Parameters<br>Register        | 0000 0000 0000 0000 |
| 0x0C81       | DMA_CCR4(15:0) | DMA Channel 4 Control Register                                 | 0000 0000 0000 0000 |
| 0x0C82       | DMA_CICR4(5:0) | DMA Channel 4 Interrupt Control register                       | 00 0011             |
| 0x0C83       | DMA_CSR4(6:0)  | DMA Channel 4 Status register                                  | 00 0000             |
| 0x0C84       | DMA_CSSA_L4    | DMA Channel 4 Source Start Address, lower bits, register       | Undefined           |
| 0x0C85       | DMA_CSSA_U4    | DMA Channel 4 Source Start Address, upper bits, register       | Undefined           |
| 0x0C86       | DMA_CDSA_L4    | DMA Channel 4 Source Destination Address, lower bits, register | Undefined           |
| 0x0C87       | DMA_CDSA_U4    | DMA Channel 4 Source Destination Address, upper bits, register | Undefined           |
| 0x0C88       | DMA_CEN4       | DMA Channel 4 Element Number register                          | Undefined           |
| 0x0C89       | DMA_CFN4       | DMA Channel 4 Frame Number register                            | Undefined           |
| 0x0C8A       | DMA_CSFI4      | DMA Channel 4 Source Frame Index register                      | Undefined           |
| 0x0C8B       | DMA_CSEI4      | DMA Channel 4 Source Element Index register                    | Undefined           |
| 0x0C8C       | DMA_CSAC4      | DMA Channel 4 Source Address Counter register                  | Undefined           |
| 0x0C8D       | DMA_CDAC4      | DMA Channel 4 destination Address Counter register             | Undefined           |
| 0x0C8E       | DMA_CDEI4      | DMA Channel 4 Destination Element Index register               | Undefined           |
| 0x0C8F       | DMA_CDFI4      | DMA Channel 4 Destination Frame Index register                 | Undefined           |
|              |                | CHANNEL #5 REGISTERS   |                     |
| 0x0CA0       | DMA_CSDP5      | DMA Channel 5 Source Destination Parameters<br>Register        | 0000 0000 0000 0000 |
| 0x0CA1       | DMA_CCR5(15:0) | DMA Channel 5 Control Register                                 | 0000 0000 0000 0000 |
| 0x0CA2       | DMA_CICR5(5:0) | DMA Channel 5 Interrupt Control register                       | 00 0011             |
| 0x0CA3       | DMA_CSR5(6:0)  | DMA Channel 5 Status register                                  | 00 0000             |
| 0x0CA4       | DMA_CSSA_L5    | DMA Channel 5 Source Start Address, lower bits, register       | Undefined           |
| 0x0CA5       | DMA_CSSA_U5    | DMA Channel 5 Source Start Address, upper bits, register       | Undefined           |
| 0x0CA6       | DMA_CDSA_L5    | DMA Channel 5 Source Destination Address, lower bits, register | Undefined           |
| 0x0CA7       | DMA_CDSA_U5    | DMA Channel 5 Source Destination Address, upper bits, register | Undefined           |
| 0x0CA8       | DMA_CEN5       | DMA Channel 5 Element Number register                          | Undefined           |
| 0x0CA9       | DMA_CFN5       | DMA Channel 5 Frame Number register                            | Undefined           |
| 0x0CAA       | DMA_CSFI5      | DMA Channel 5 Source Frame Index register                      | Undefined           |
| 0x0CAB       | DMA_CSEI5      | DMA Channel 5 Source Element Index register                    | Undefined           |
| 0x0CAC       | DMA_CSAC5      | DMA Channel 5 Source Address Counter register                  | Undefined           |
| 0x0CAD       | DMA_CDAC5      | DMA Channel 5 Destination Address Counter register             | Undefined           |
| 0x0CAE       | DMA_CDEI5      | DMA Channel 5 Destination Element Index register               | Undefined           |
| 0x0CAF       | DMA_CDFI5      | DMA Channel 5 Destination Frame Index register                 | Undefined           |

91

### Table 3-57. Instruction Cache Registers

| WORD ADDRESS                                | REGISTER NAME  | DESCRIPTION                                 |
|---|--|---|
| 0x1400                                      | ICGC   | ICache Global Control Register              |
| 0x1401 ICFLARL ICache Flush Line Address Re |  | ICache Flush Line Address Register Low Part |
| 0x1402                                      | x1402 ICFLARH ICache Flush Line Address Register High Part |   |
| 0x1403                                      | ICWMC  | ICache N-Way Control Register               |

### Table 3-58. Trace FIFO<sup>†</sup>

| WORD ADDRESS    | REGISTER NAME  | DESCRIPTION                          |
|-----------------|----------------|--------------------------------------|
| 0x2000 – 0x203F | TRC00 - TRC63  | Trace Register Discontinuity Section |
| 0x2040 - 0x204F | TRC64 – TRC79  | Trace Register Last PC Section       |
| 0x2050          | TRC_LPCOFFSET1 | Trace LPC Offset Register 1          |
| 0x2051          | TRC_LPCOFFSET2 | Trace LPC Offset Register 2          |
| 0x2052          | TRC_PTR        | Trace Pointer Register               |
| 0x2053          | TRC_CNTL       | Trace Control Register               |
| 0x2054          | TRC_ID         | Trace ID Register                    |

The Trace FIFO registers are used by the emulator only and do not require any intervention from the user.

### Table 3-59. Timer Signal Selection Register

| WORD ADDRESS | REGISTER NAME | DESCRIPTION                     | RESET VALUE         |
|--------------|---------------|---------------------------------|---------------------|
| 0x8000       | TSSR          | Timer Signal Selection Register | 0000 0000 0000 0000 |

#### Table 3-60. Timers

| WORD ADDRESS | REGISTER NAME | DESCRIPTION                               | RESET VALUE         |
|--------------|---------------|---|---------------------|
| 0x1000       | GPTPID1_0     | Peripheral ID register 1, Timer #0        | 0000 0111 0000 0001 |
| 0x1001       | GPTPID2_0     | Peripheral ID register 2, Timer #0        | 0000 0000 0000 0001 |
| 0x1002       | GPTEMU_0      | Emulation Management Register, Timer #0   | 0000 0000 0000 0000 |
| 0x1003       | GPTCLK_0      | Timer Clock Speed Register, Timer #0      | 0000 0001 0000 1000 |
| 0x1004       | GPTGPINT_0    | GPIO Interrupt Control Register, Timer #0 | 0000 0000 0000 0000 |
| 0x1005       | GPTGPEN_0     | GPIO Enable Register, Timer #0            | 0000 0000 0000 0000 |
| 0x1006       | GPTGPDAT_0    | GPIO Data Register, Timer #0              | 0000 0000 0000 0000 |
| 0x1007       | GPTGPDIR_0    | GPIO Direction Register, Timer #0         | 0000 0000 0000 0000 |
| 0x1008       | GPTCNT1_0     | Timer Counter 1 Register, Timer #0        | 0000 0000 0000 0000 |
| 0x1009       | GPTCNT2_0     | Timer Counter 2 Register, Timer #0        | 0000 0000 0000 0000 |
| 0x100A       | GPTCNT3_0     | Timer Counter 3 Register, Timer #0        | 0000 0000 0000 0000 |
| 0x100B       | GPTCNT4_0     | Timer Counter 4 Register, Timer #0        | 0000 0000 0000 0000 |
| 0x100C       | GPTPRD1_0     | Period Register 1, Timer #0               | 0000 0000 0000 0000 |
| 0x100D       | GPTPRD2_0     | Period Register 2, Timer #0               | 0000 0000 0000 0000 |
| 0x100E       | GPTPRD3_0     | Period Register 3, Timer #0               | 0000 0000 0000 0000 |
| 0x100F       | GPTPRD4_0     | Period Register 4, Timer #0               | 0000 0000 0000 0000 |
| 0x1010       | GPTCTL1_0     | Timer Control Register 1, Timer #0        | 0000 0000 0000 0000 |
| 0x1011       | GPTCTL2_0     | Timer Control Register 2, Timer #0        | 1111 1111 0000 0000 |
| 0x1012       | GPTGCTL1_0    | Global Timer Control Register 1, Timer #0 | 0000 0000 0000 0000 |
| 0x2400       | GPTPID1_1     | Peripheral ID register 1, Timer #1        | 0000 0111 0000 0001 |
| 0x2401       | GPTPID2_1     | Peripheral ID register 2, Timer #1        | 0000 0000 0000 0001 |
| 0x2402       | GPTEMU_1      | Emulation Management Register, Timer #1   | 0000 0000 0000 0000 |
| 0x2403       | GPTCLK_1      | Timer Clock Speed Register, Timer #1      | 0000 0001 0000 1000 |
| 0x2404       | GPTGPINT_1    | GPIO Interrupt Control Register, Timer #1 | 0000 0000 0000 0000 |
| 0x2405       | GPTGPEN_1     | GPIO Enable Register, Timer #1            | 0000 0000 0000 0000 |

92

Table 3-60. Timers (Continued)

| WORD ADDRESS | REGISTER NAME | DESCRIPTION                                     | RESET VALUE         |
|--------------|---------------|---|---------------------|
| 0x2406       | GPTGPDAT_1    | GPIO Data Register, Timer #1                    | 0000 0000 0000 0000 |
| 0x2407       | GPTGPDIR_1    | GPIO Direction Register, Timer #1               | 0000 0000 0000 0000 |
| 0x2408       | GPTCNT1_1     | Timer Counter 1 Register, Timer #1              | 0000 0000 0000 0000 |
| 0x2409       | GPTCNT2_1     | Timer Counter 2 Register, Timer #1              | 0000 0000 0000 0000 |
| 0x240A       | GPTCNT3_1     | Timer Counter 3 Register, Timer #1              | 0000 0000 0000 0000 |
| 0x240B       | GPTCNT4_1     | Timer Counter 4 Register, Timer #1              | 0000 0000 0000 0000 |
| 0x240C       | GPTPRD1_1     | Period Register 1, Timer #1                     | 0000 0000 0000 0000 |
| 0x240D       | GPTPRD2_1     | Period Register 2, Timer #1                     | 0000 0000 0000 0000 |
| 0x240E       | GPTPRD3_1     | Period Register 3, Timer #1                     | 0000 0000 0000 0000 |
| 0x240F       | GPTPRD4_1     | Period Register 4, Timer #1                     | 0000 0000 0000 0000 |
| 0x2410       | GPTCTL1_1     | Timer Control Register 1, Timer #1              | 0000 0000 0000 0000 |
| 0x2411       | GPTCTL2_1     | Timer Control Register 2, Timer #1              | 1111 1111 0000 0000 |
| 0x2412       | GPTGCTL1_1    | Global Timer Control Register 1, Timer #1       | 0000 0000 0000 0000 |
| 0x4000       | WDTPID1       | Peripheral ID register 1, Watchdog Timer        | 0000 0111 0000 0001 |
| 0x4001       | WDTPID2       | Peripheral ID register 2, Watchdog Timer        | 0000 0000 0000 0001 |
| 0x4002       | WDTEMU        | Emulation Management Register, Watchdog Timer   | 0000 0000 0000 0000 |
| 0x4003       | WDTCLK        | Timer Clock Speed Register, Watchdog Timer      | 0000 0001 0000 1000 |
| 0x4004       | WDTGPINT      | GPIO Interrupt Control Register, Watchdog Timer | 0000 0000 0000 0000 |
| 0x4005       | WDTGPEN       | GPIO Enable Register, Watchdog Timer            | 0000 0000 0000 0000 |
| 0x4006       | WDTGPDAT      | GPIO Data Register, Watchdog Timer              | 0000 0000 0000 0000 |
| 0x4007       | WDTGPDIR      | GPIO Direction Register, Watchdog Timer         | 0000 0000 0000 0000 |
| 0x4008       | WDTCNT1       | Timer Counter 1 Register, Watchdog Timer        | 0000 0000 0000 0000 |
| 0x4009       | WDTCNT2       | Timer Counter 2 Register, Watchdog Timer        | 0000 0000 0000 0000 |
| 0x400A       | WDTCNT3       | Timer Counter 3 Register, Watchdog Timer        | 0000 0000 0000 0000 |
| 0x400B       | WDTCNT4       | Timer Counter 4 Register, Watchdog Timer        | 0000 0000 0000 0000 |
| 0x400C       | WDTPRD1       | Period Register 1, Watchdog Timer               | 0000 0000 0000 0000 |
| 0x400D       | WDTPRD2       | Period Register 2, Watchdog Timer               | 0000 0000 0000 0000 |
| 0x400E       | WDTPRD3       | Period Register 3, Watchdog Timer               | 0000 0000 0000 0000 |
| 0x400F       | WDTPRD4       | Period Register 4, Watchdog Timer               | 0000 0000 0000 0000 |
| 0x4010       | WDTCTL1       | Timer Control Register 1, Watchdog Timer        | 0000 0000 0000 0000 |
| 0x4011       | WDTCTL2       | Timer Control Register 2, Watchdog Timer        | 1111 1111 0000 0000 |
| 0x4012       | WDTGCTL1      | Global Timer Control Register 1, Watchdog Timer | 0000 0000 0000 0000 |
| 0x4014       | WDTWCTL1      | WD Timer Control Register 1, Watchdog Timer     | 0000 0000 0000 0000 |
| 0x4015       | WDTWCTL2      | WD Timer Control Register 2, Watchdog Timer     | 0000 0000 0000 0000 |

Table 3-61. Multichannel Serial Port #0

| WORD ADDRESS | REGISTER NAME | DESCRIPTION  | RESET VALUE         |
|--------------|---------------|--|---------------------|
| 0x2800       | DRR1_0        | Data Receive Register 1, McBSP #0                      | 0000 0000 0000 0000 |
| 0x2801       | DRR2_0        | Data Receive Register 2, McBSP #0                      | 0000 0000 0000 0000 |
| 0x2802       | DXR1_0        | Data Transmit Register 1, McBSP #0                     | 0000 0000 0000 0000 |
| 0x2803       | DXR2_0        | Data Transmit Register 2, McBSP #0                     | 0000 0000 0000 0000 |
| 0x2804       | SPCR1_0       | Serial Port Control Register 1, McBSP #0               | 0000 0000 0000 0000 |
| 0x2805       | SPCR2_0       | Serial Port Control Register 2, McBSP #0               | 0000 0000 0000 0000 |
| 0x2806       | RCR1_0        | Receive Control Register 1, McBSP #0                   | 0000 0000 0000 0000 |
| 0x2807       | RCR2_0        | Receive Control Register 2, McBSP #0                   | 0000 0000 0000 0000 |
| 0x2808       | XCR1_0        | Transmit Control Register 1, McBSP #0                  | 0000 0000 0000 0000 |
| 0x2809       | XCR2_0        | Transmit Control Register 2, McBSP #0                  | 0000 0000 0000 0000 |
| 0x280A       | SRGR1_0       | Sample Rate Generator Register 1, McBSP #0             | 0020 0000 0000 0000 |
| 0x280B       | SRGR2_0       | Sample Rate Generator Register 2, McBSP #0             | 0000 0000 0000 0001 |
| 0x280C       | MCR1_0        | Multichannel Control Register 1, McBSP #0              | 0000 0000 0000 0000 |
| 0x280D       | MCR2_0        | Multichannel Control Register 2, McBSP #0              | 0000 0000 0000 0000 |
| 0x280E       | RCERA_0       | Receive Channel Enable Register Partition A, McBSP #0  | 0000 0000 0000 0000 |
| 0x280F       | RCERB_0       | Receive Channel Enable Register Partition B, McBSP #0  | 0000 0000 0000 0000 |
| 0x2810       | XCERA_0       | Transmit Channel Enable Register Partition A, McBSP #0 | 0000 0000 0000 0000 |
| 0x2811       | XCERB_0       | Transmit Channel Enable Register Partition B, McBSP #0 | 0000 0000 0000 0000 |
| 0x2812       | PCR0          | Pin Control Register, McBSP #0                         | 0000 0000 0000 0000 |
| 0x2813       |               | Reserved   |                     |
| 0x2814       | RCERC_0       | Receive Channel Enable Register Partition C, McBSP #0  | 0000 0000 0000 0000 |
| 0x2815       | RCERD_0       | Receive Channel Enable Register Partition D, McBSP #0  | 0000 0000 0000 0000 |
| 0x2816       | XCERC_0       | Transmit Channel Enable Register Partition C, McBSP #0 | 0000 0000 0000 0000 |
| 0x2817       | XCERD_0       | Transmit Channel Enable Register Partition D, McBSP #0 | 0000 0000 0000 0000 |
| 0x2818       | RCERE_0       | Receive Channel Enable Register Partition E, McBSP #0  | 0000 0000 0000 0000 |
| 0x2819       | RCERF_0       | Receive Channel Enable Register Partition F, McBSP #0  | 0000 0000 0000 0000 |
| 0x281A       | XCERE_0       | Transmit Channel Enable Register Partition E, McBSP #0 | 0000 0000 0000 0000 |
| 0x281B       | XCERF_0       | Transmit Channel Enable Register Partition F, McBSP #0 | 0000 0000 0000 0000 |
| 0x281C       | RCERG_0       | Receive Channel Enable Register Partition G, McBSP #0  | 0000 0000 0000 0000 |
| 0x281D       | RCERH_0       | Receive Channel Enable Register Partition H, McBSP #0  | 0000 0000 0000 0000 |
| 0x281E       | XCERG_0       | Transmit Channel Enable Register Partition G, McBSP #0 | 0000 0000 0000 0000 |
| 0x281F       | XCERH_0       | Transmit Channel Enable Register Partition H, McBSP #0 | 0000 0000 0000 0000 |

Table 3-62. Multichannel Serial Port #1

| WORD ADDRESS | REGISTER NAME | DESCRIPTION  | RESET VALUE         |
|--------------|---------------|--|---------------------|
| 0x2C00       | DRR1_1        | Data Receive Register 1, McBSP #1                      | 0000 0000 0000 0000 |
| 0x2C01       | DRR2_1        | Data Receive Register 2, McBSP #1                      | 0000 0000 0000 0000 |
| 0x2C02       | DXR1_1        | Data Transmit Register 1, McBSP #1                     | 0000 0000 0000 0000 |
| 0x2C03       | DXR2_1        | Data Transmit Register 2, McBSP #1                     | 0000 0000 0000 0000 |
| 0x2C04       | SPCR1_1       | Serial Port Control Register 1, McBSP #1               | 0000 0000 0000 0000 |
| 0x2C05       | SPCR2_1       | Serial Port Control Register 2, McBSP #1               | 0000 0000 0000 0000 |
| 0x2C06       | RCR1_1        | Receive Control Register 1, McBSP #1                   | 0000 0000 0000 0000 |
| 0x2C07       | RCR2_1        | Receive Control Register 2, McBSP #1                   | 0000 0000 0000 0000 |
| 0x2C08       | XCR1_1        | Transmit Control Register 1, McBSP #1                  | 0000 0000 0000 0000 |
| 0x2C09       | XCR2_1        | Transmit Control Register 2, McBSP #1                  | 0000 0000 0000 0000 |
| 0x2C0A       | SRGR1_1       | Sample Rate Generator Register 1, McBSP #1             | 0020 0000 0000 0000 |
| 0x2C0B       | SRGR2_1       | Sample Rate Generator Register 2, McBSP #1             | 0000 0000 0000 0001 |
| 0x2C0C       | MCR1_1        | Multichannel Register 1, McBSP #1                      | 0000 0000 0000 0000 |
| 0x2C0D       | MCR2_1        | Multichannel Register 2, McBSP #1                      | 0000 0000 0000 0000 |
| 0x2C0E       | RCERA_1       | Receive Channel Enable Register Partition A, McBSP #1  | 0000 0000 0000 0000 |
| 0x2C0F       | RCERB_1       | Receive Channel Enable Register Partition B, McBSP #1  | 0000 0000 0000 0000 |
| 0x2C10       | XCERA_1       | Transmit Channel Enable Register Partition A, McBSP #1 | 0000 0000 0000 0000 |
| 0x2C11       | XCERB_1       | Transmit Channel Enable Register Partition B, McBSP #1 | 0000 0000 0000 0000 |
| 0x2C12       | PCR1          | Pin Control Register, McBSP #1                         | 0000 0000 0000 0000 |
| 0x2C13       |               | Reserved   |                     |
| 0x2C14       | RCERC_1       | Receive Channel Enable Register Partition C, McBSP #1  | 0000 0000 0000 0000 |
| 0x2C15       | RCERD_1       | Receive Channel Enable Register Partition D, McBSP #1  | 0000 0000 0000 0000 |
| 0x2C16       | XCERC_1       | Transmit Channel Enable Register Partition C, McBSP #1 | 0000 0000 0000 0000 |
| 0x2C17       | XCERD_1       | Transmit Channel Enable Register Partition D, McBSP #1 | 0000 0000 0000 0000 |
| 0x2C18       | RCERE_1       | Receive Channel Enable Register Partition E, McBSP #1  | 0000 0000 0000 0000 |
| 0x2C19       | RCERF_1       | Receive Channel Enable Register Partition F, McBSP #1  | 0000 0000 0000 0000 |
| 0x2C1A       | XCERE_1       | Transmit Channel Enable Register Partition E, McBSP #1 | 0000 0000 0000 0000 |
| 0x2C1B       | XCERF_1       | Transmit Channel Enable Register Partition F, McBSP #1 | 0000 0000 0000 0000 |
| 0x2C1C       | RCERG_1       | Receive Channel Enable Register Partition G, McBSP #1  | 0000 0000 0000 0000 |
| 0x2C1D       | RCERH_1       | Receive Channel Enable Register Partition H, McBSP #1  | 0000 0000 0000 0000 |
| 0x2C1E       | XCERG_1       | Transmit Channel Enable Register Partition G, McBSP #1 | 0000 0000 0000 0000 |
| 0x2C1F       | XCERH_1       | Transmit Channel Enable Register Partition H, McBSP #1 | 0000 0000 0000 0000 |

#### Table 3-63. HPI

| WORD ADDRESS    | REGISTER NAME | DESCRIPTION                      | RESET VALUE <sup>†</sup> |
|-----------------|---------------|----------------------------------|--------------------------|
| 0xA000          | PID LSW       | PID [15:0]                       | 0000 0010                |
| 0xA001          | PID MSW       | PID [31:16]                      | 0000 0000 0000 0001      |
| 0xA002          | PWREMU_MGMT1  | Power and Management Register 1  | 0000 0000 0000 0000      |
| 0xA003 - 0xA005 |               | Reserved                         |                          |
| 0xA006          | HGPIOEN       | HPI GPIO enable register         | 0000 0000 0000 0000      |
| 0xA007          |               | Reserved                         |                          |
| 0xA008          | HGPIODIR      | HPI GPIO direction register      | 0000 0000 0000 0000      |
| 0xA009          |               | Reserved                         |                          |
| 0xA00A          | GPIODAT       | GPIO data register               | 0000 0000 0000 0000      |
| 0xA00B - 0xA017 |               | Reserved                         |                          |
| 0xA018          | HPIC          | Host Port Control Register       | 0000 0000 0000 1000      |
| 0xA019          |               | Reserved                         |                          |
| 0xA01A          | HPIAW         | Host Port Write Address Register | xxxx xxxx xxxx xxxx      |
| 0xA01B          |               | Reserved                         |                          |
| 0xA01C          | HPIAR         | Host Port Read Address Register  | xxxx xxxx xxxx xxxx      |
| 0xA01D - 0xA020 |               | Reserved                         |                          |

<sup>†</sup> x denotes a "don't care."

### Table 3-64. GPIO

| WORD ADDRESS | REGISTER NAME | DESCRIPTION                            | RESET VALUE <sup>†</sup> |
|--------------|---------------|--|--------------------------|
| 0x3400       | IODIR         | General-purpose I/O Direction Register | 0000 0000 0000 0000      |
| 0x3401       | IODATA        | General-purpose I/O Data Register      | 0000 0000 xxxx xxxx      |
| 0x4400       | PGPIOEN0      | Parallel GPIO Enable Register 0        | 0000 0000 0000 0000      |
| 0x4401       | PGPIODIR0     | Parallel GPIO Direction Register 0     | 0000 0000 0000 0000      |
| 0x4402       | PGPIODAT0     | Parallel GPIO Data Register 0          | 0000 0000 0000 0000      |
| 0x4403       | PGPIOEN1      | Parallel GPIO Enable Register 1        | 0000 0000 0000 0000      |
| 0x4404       | PGPIODIR1     | Parallel GPIO Direction Register 1     | 0000 0000 0000 0000      |
| 0x4405       | PGPIODAT1     | Parallel GPIO Data Register 1          | 0000 0000 0000 0000      |
| 0x4406       | PGPIOEN2      | Parallel GPIO Enable Register 2        | 0000 0000 0000 0000      |
| 0x4407       | PGPIODIR2     | Parallel GPIO Direction Register 2     | 0000 0000 0000 0000      |
| 0x4408       | PGPIODAT2     | Parallel GPIO Data Register 2          | 0000 0000 0000 0000      |

<sup>†</sup> x denotes a "don't care."

### Table 3-65. Device Revision ID

| WORD ADDRESS    | REGISTER NAME | DESCRIPTION                      | RESET VALUE <sup>†</sup>    |
|-----------------|---------------|----------------------------------|-----------------------------|
| 0x3800 - 0x3803 | Die ID        | Die ID                           |                             |
| 0x3804          | Chip ID (LSW) | Defines F# 3LS digits and PG rev | 1001 0100 0110 0001         |
| 0x3805          | Chip ID (MSW) | Defines F# 3MS digits            | 0000 0111 0101 0001         |
| 0x3806          | Sub ID        | Defines subsytem ID              | 0000 0000 0000 0000‡        |
| 0x3807          | Cat ID        | Defines catalog device           | 0101 0101 0000 0001 (5501h) |

<sup>†</sup>x denotes a "don't care."

Table 3-66. I<sup>2</sup>C

| WORD ADDRESS | REGISTER NAME | DESCRIPTION   | RESET VALUET        |
|--------------|---------------|---|---------------------|
| 0x3C00       | I2COAR        | I <sup>2</sup> C Own Address Register                     | 0000 0000 0000 0000 |
| 0x3C01       | I2CIER        | I <sup>2</sup> C Interrupt Enable Register                | 0000 0000 0000 0000 |
| 0x3C02       | I2CSTR        | I <sup>2</sup> C Status Register                          | 0000 0001 0000 0000 |
| 0x3C03       | I2CCLKL       | I <sup>2</sup> C Clock Low-Time Divider Register          | 0000 0000 0000 0000 |
| 0x3C04       | I2CCLKH       | I <sup>2</sup> C Clock High-Time Divider Register         | 0000 0000 0000 0000 |
| 0x3C05       | I2CCNT        | I <sup>2</sup> C Data Count                               | 0000 0000 0000 0000 |
| 0x3C06       | I2CDRR        | I <sup>2</sup> C Data Receive Register                    | 0000 0000 0000 0000 |
| 0x3C07       | I2CSAR        | I <sup>2</sup> C Slave Address Register                   | 0000 0011 1111 1111 |
| 0x3C08       | I2CDXR        | I <sup>2</sup> C Data Transmit Register                   | 0000 0000 0000 0000 |
| 0x3C09       | I2CMDR        | I <sup>2</sup> C Mode Register                            | 0000 0000 0000 0000 |
| 0x3C0A       | I2CISRC       | I <sup>2</sup> C Interrupt Source Register                | 0000 0000 0000 0000 |
| 0x3C0B       | I2CGPIO       | I <sup>2</sup> C General-Purpose Register (Not supported) | xxxx xxxx xxxx xxxx |
| 0x3C0C       | I2CPSC        | I <sup>2</sup> C Prescaler Register                       | 0000 0000 0000 0000 |
| 0x3C0D       | PID1          | I <sup>2</sup> C Peripheral ID Register 1                 | _                   |
| 0x3C0E       | PID2          | I <sup>2</sup> C Peripheral ID Register 2                 | _                   |
| _            | I2CXSR        | I <sup>2</sup> C Transmit Shift Register                  | _                   |
| _            | I2CRSR        | I <sup>2</sup> C Receive Shift Register                   | _                   |

<sup>†</sup> x denotes a "don't care."

<sup>‡</sup> Denotes single core

#### Table 3-67. UART

| WORD ADDRESS | REGISTER NAME              | DESCRIPTION  | RESET VALUE <sup>†</sup> |
|--------------|----------------------------|--|--------------------------|
| 0x9C00       | URRBR/<br>URTHR/<br>URDLL‡ | Receive Buffer Register<br>Transmit Holding Register<br>Divisor Latch LSB Register | xxxx xxxx                |
| 0x9C01       | URIER/<br>URDLM§           | Interrupt Enable Register<br>Divisor Latch MSB Register                            | 0000 0000                |
| 0x9C02       | URIIR/<br>URFCR¶           | Interrupt Identification Register<br>FIFO Control Register                         | 0000 0001<br>0000 0000   |
| 0x9C03       | URLCR                      | Line Control Register  | 0000 0000                |
| 0x9C04       | URMCR                      | Modem Control Register   | 0000 0000                |
| 0x9C05       | URLSR                      | Line Status Register   | 0110 0000                |
| 0x9C07       | URSCR                      | Scratch Register   | xxxx xxxx                |
| 0x9C08       | URDLL <sup>‡</sup>         | Divisor Latch LSB Register   | -                        |
| 0x9C09       | URDLM§                     | Divisor Latch MSB Register   | -                        |
| 0x9C0A       | URPID1                     | Peripheral ID Register (LSW)   | -                        |
| 0x9C0B       | URPID2                     | Peripheral ID Register (MSW)   | -                        |
| 0x9C0C       | URPECR                     | Power and Emulation Control Register   | 0000 0000 0000 0000      |

<sup>†</sup>x denotes a "don't care."

If DLAB = 0: Read Only: URRBR

Write Only: URTHR

If DLAB = 1: Read/Write: URDLL

If DLAB = 0: Read/WRite: URIER
If DLAB = 1: Read/Write: URDLM

¶ The registers URIIR and URFCR share one address.

Read Only: URIIR Write Only: URFCR

#### Table 3-68. External Bus Selection

| WORD ADDRESS | REGISTER NAME | DESCRIPTION RESET VALUE         |                     |
|--------------|---------------|---------------------------------|---------------------|
| 0x6C00       | XBSR          | External Bus Selection Register | 0000 0000 0000 0000 |
| 0x6C01       | XBCR          | External Bus Control Register   | 0000 0000 0000 0000 |

#### Table 3-69. Clock Mode Register

| WORD ADDRESS | REGISTER NAME | DESCRIPTION                 | RESET VALUE         |
|--------------|---------------|-----------------------------|---------------------|
| 0x8C00       | CLKMD         | Clock Mode Control Register | 0000 0000 0000 0000 |

#### Table 3-70. CLKOUT Selector Register

| WORD ADDRESS | REGISTER NAME | DESCRIPTION               | RESET VALUE         |
|--------------|---------------|---------------------------|---------------------|
| 0x8400       | CLKOUTSR      | CLKOUT Selection Register | 0000 0000 0000 0010 |

<sup>&</sup>lt;sup>‡</sup> The registers URRBR, URTHR, and URDLL share one address. URDLL also has a dedicated address. When using the dedicated address, the DLAB bit can be kept cleared, so that URRBR and URTHR are always selected at the shared address.

<sup>§</sup> The registers URIER and URDLM share one address. URDLM also has a dedicated address. When using the dedicated address, the DLAB bit can be kept cleared, so that URIER is always selected at the shared address.

# Table 3-71. Clock Controller Registers

| WORD ADDRESS | REGISTER NAME | DESCRIPTION   | RESET VALUE         |
|--------------|---------------|---|---------------------|
| 0x1C80       | PLLCSR        | PLL Control Status Register                         | 0000 0000 0000 0000 |
| 0x1C82       | CK3SEL        | CLKOUT3 Select Register 0000 0000 0000 1011         |                     |
| 0x1C88       | PLLM          | PLL Multiplier Control Register 0000 0000 0000 0000 |                     |
| 0x1C8A       | PLLDIV0       | PLL Divider 0 Register                              | 1000 0000 0000 0000 |
| 0x1C8C       | PLLDIV1       | PLL Divider 1 Register                              | 0000 0000 0000 0000 |
| 0x1C8E       | PLLDIV2       | PLL Divider 2 Register                              | 0000 0000 0000 0000 |
| 0x1C90       | PLLDIV3       | PLL Divider 3 Register                              | 0000 0000 0000 0000 |
| 0x1C92       | OSCDIV1       | Oscillator Divider 1 Register                       | 0000 0000 0000 0000 |
| 0x1C98       | WKEN          | Oscillator Wakeup Control Register                  | 0000 0000 0000 0000 |

# Table 3-72. IDLE Control Registers

| WORD ADDRESS | REGISTER NAME | DESCRIPTION RESET VALUE          |                     |
|--------------|---------------|----------------------------------|---------------------|
| 0x9400       | PICR          | Peripheral IDLE Control Register | 0000 0000 0000 0000 |
| 0x9401       | PISTR         | Peripheral IDLE Status Register  | 0000 0000 0000 0010 |
| 0x9402       | MICR          | Master IDLE Control Register     | 0000 0000 0000 0000 |
| 0x9403       | MISR          | Master IDLE Status Register      | 0000 0000 0000 0010 |

# 3.16 Interrupts

Vector-relative locations and priorities for all internal and external interrupts are shown in Table 3–73. For more information on setting up and using interrupts, please refer to the *TMS320C55x DSP CPU Reference Guide* (literature number SPRU371).

Table 3-73. Interrupt Table

| NAME         | SOFTWARE<br>(TRAP)<br>EQUIVALENT | LOCATION<br>(HEX BYTES) | PRIORITY | FUNCTION  |
|--------------|----------------------------------|-------------------------|----------|---|
| RESET        | SINT0                            | 0                       | 0        | Reset (hardware and software)                     |
| NMI          | SINT1                            | 8                       | 1        | Nonmaskable interrupt                             |
| INT0         | SINT2                            | 10                      | 3        | External interrupt #0                             |
| INT2         | SINT3                            | 18                      | 5        | External interrupt #2                             |
| TINT0        | SINT4                            | 20                      | 6        | Timer #0 interrupt                                |
| RINT0        | SINT5                            | 28                      | 7        | McBSP #0 receive interrupt                        |
| RINT1        | SINT6                            | 30                      | 9        | McBSP #1 receive interrupt                        |
| XINT1        | SINT7                            | 38                      | 10       | McBSP #1 transmit interrupt                       |
| LCKINT       | SINT8                            | 40                      | 11       | PLL lock interrupt                                |
| DMAC1        | SINT9                            | 48                      | 13       | DMA Channel #1 interrupt                          |
| DSPINT       | SINT10                           | 50                      | 14       | Interrupt from host                               |
| INT3/WDTINT† | SINT11                           | 58                      | 15       | External interrupt #3 or Watchdog timer interrupt |
| RINT2        | SINT12                           | 60                      | 17       | McBSP #2 receive interrupt                        |
| XINT2        | SINT13                           | 68                      | 18       | McBSP #2 transmit interrupt                       |
| DMAC4        | SINT14                           | 70                      | 21       | DMA Channel #4 interrupt                          |
| DMAC5        | SINT15                           | 78                      | 22       | DMA Channel #5 interrupt                          |
| INT1         | SINT16                           | 80                      | 4        | External interrupt #1                             |
| XINT0        | SINT17                           | 88                      | 8        | McBSP #0 transmit interrupt                       |
| DMAC0        | SINT18                           | 90                      | 12       | DMA Channel #0 interrupt                          |
| _            | SINT19                           | 98                      | 16       | Software interrupt #19                            |
| DMAC2        | SINT20                           | A0                      | 19       | DMA Channel #2 interrupt                          |
| DMAC3        | SINT21                           | A8                      | 20       | DMA Channel #3 interrupt                          |
| TINT1        | SINT22                           | В0                      | 23       | Timer #1 interrupt                                |
| IIC          | SINT23                           | B8                      | 24       | I <sup>2</sup> C interrupt                        |
| BERR         | SINT24                           | C0                      | 2        | Bus Error interrupt                               |
| DLOG         | SINT25                           | C8                      | 25       | Data Log interrupt                                |
| RTOS         | SINT26                           | D0                      | 26       | Real-time Operating System interrupt              |
| _            | SINT27                           | D8                      | 27       | Software interrupt #27                            |
|              | SINT28                           | E0                      | 28       | Software interrupt #28                            |
| _            | SINT29                           | E8                      | 29       | Software interrupt #29                            |
|              | SINT30                           | F0                      | 30       | Software interrupt #30                            |
|              | SINT31                           | F8                      | 31       | Software interrupt #31                            |

<sup>†</sup> WDTINT is only available when the Watchdog Timer is used as a general-purpose timer.

## 3.16.1 IFR and IER Registers

The Interrupt Enable Registers (IER0 and IER1) control which interrupts will be masked or enabled during normal operation. The Interrupt Flag Registers (IFR0 and IFR1) contain flags that indicate interrupts that are currently pending.

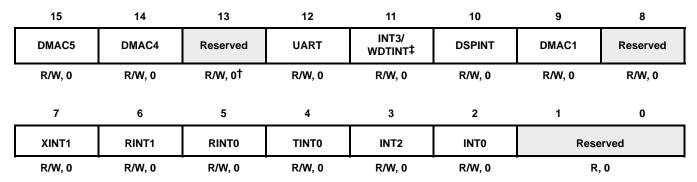
The Debug Interrupt Enable Registers (DBIER0 and DBIER1) are used only when the CPU is *halted* in the real-time emulation mode. If the CPU is *running* in real-time mode, the standard interrupt processing (IER0/1) is used and DBIER0/1 are ignored.

A maskable interrupt enabled in DBIER0/1 is defined as a time-critical interrupt. When the CPU is halted in the real-time mode, the only interrupts that are serviced are time-critical interrupts that are also enabled in an interrupt enable register (IER0 or IER1).

Write the DBIER0/1 to enable or disable time-critical interrupts. To enable an interrupt, set its corresponding bit. To disable an interrupt, clear its corresponding bit. Initialize these registers before using the real-time emulation mode.

A DSP hardware reset clears IFR0/1, IER0/1, and DBIER0/1 to 0. A software reset instruction clears IFR0/1 to 0 but does not affect IER0/1 and DBIER0/1.

The bit layouts of these registers for each interrupt are shown in Figure 3–48 and Figure 3–49. For more information on the IER, IFR, and DBIER registers, refer to the *TMS320C55x DSP CPU Reference Guide* (literature number SPRU371).

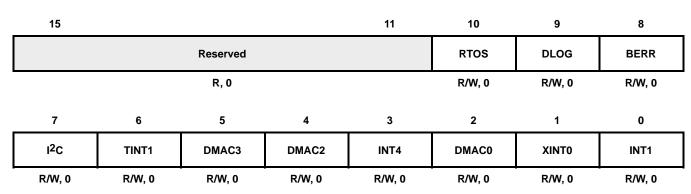


**LEGEND:** R = Read, W = Write, n = value at reset

Figure 3-48. IFR0, IER0, DBIFR0, and DBIER0 Registers Layout

<sup>†</sup> This bit must be kept zero when writing to IER0.

<sup>&</sup>lt;sup>‡</sup> The WDT interrupt pin must be connected to the INT3 pin through the TSSR.



**LEGEND:** R = Read, W = Write, n = value at reset

Figure 3-49. IFR1, IER1, DBIFR1, and DBIER1 Registers Layout

## 3.16.2 Interrupt Timing

The external interrupts ( $\overline{\text{NMI}}$  and  $\overline{\text{INT}}$ ) are synchronized to the CPU by way of a two-flip-flop synchronizer. The interrupt inputs are sampled on falling edges of the CPU clock. A sequence on the interrupt pin of 1–0–0–0 on consecutive cycles is required for an interrupt to be detected. Therefore, the minimum low pulse duration on the external interrupts on the 5501 is three CPU clock periods.

# 4 Documentation Support

Extensive documentation supports all TMS320™ DSP family of devices from product announcement through applications development. The following types of documentation are available to support the design and use of the TMS320C5000™ platform of DSPs:

- TMS320C55x™ DSP Functional Overview (literature number SPRU312)
- Device-specific data sheets
- Complete user's guides
- Development support tools
- Hardware and software application reports

TMS320C55x reference documentation that includes, but is not limited to, the following:

- TMS320C55x DSP CPU Reference Guide (literature number SPRU371)
- TMS320C55x DSP Mnemonic Instruction Set Reference Guide (literature number SPRU374)
- TMS320C55x DSP Algebraic Instruction Set Reference Guide (literature number SPRU375)
- TMS320C55x DSP Programmer's Guide (literature number SPRU376)
- TMS320C55x DSP Peripherals Reference Guide (literature number SPRU317)

The reference guides describe in detail the TMS320C55x<sup>™</sup> DSP products currently available and the hardware and software applications, including algorithms, for fixed-point TMS320 DSP family of devices.

A series of DSP textbooks is published by Prentice-Hall and John Wiley & Sons to support digital signal processing research and education. The TMS320 DSP newsletter, *Details on Signal Processing*, is published quarterly and distributed to update TMS320 DSP customers on product information.

Information regarding TI DSP products is also available on the Worldwide Web at http://www.ti.com uniform resource locator (URL).

TMS320 and TMS320C5000 are trademarks of Texas Instruments.



# 5 Device and Development-Support Tool Nomenclature

To designate the stages in the product development cycle, TI assigns prefixes to the part numbers of all TMS320™ DSP devices and support tools. Each TMS320™ DSP commercial family member has one of three prefixes: TMX, TMP, or TMS. Texas Instruments recommends two of three possible prefix designators for support tools: TMDX and TMDS. These prefixes represent evolutionary stages of product development from engineering prototypes (TMX/TMDX) through fully qualified production devices/tools (TMS/TMDS).

Device development evolutionary flow:

- TMX Experimental device that is not necessarily representative of the final device's electrical specifications
- **TMP** Final silicon die that conforms to the device's electrical specifications but has not completed quality and reliability verification
- TMS Fully qualified production device

Support tool development evolutionary flow:

**TMDX** Development-support product that has not yet completed Texas Instruments internal qualification testing.

**TMDS** Fully qualified development-support product

TMX and TMP devices and TMDX development-support tools are shipped with appropriate disclaimers describing their limitations and intended uses. Experimental devices (TMX) may not be representative of a final product and Texas Instruments reserves the right to change or discontinue these products without notice.

TMS devices and TMDS development-support tools have been characterized fully, and the quality and reliability of the device have been demonstrated fully. TI's standard warranty applies.

Predictions show that prototype devices (TMX or TMP) have a greater failure rate than the standard production devices. Texas Instruments recommends that these devices not be used in any production system because their expected end-use failure rate still is undefined. Only qualified production devices are to be used.

# 6 Electrical Specifications

This section provides the absolute maximum ratings and the recommended operating conditions for the TMS320VC5501 DSP.

All electrical and switching characteristics in this data manual are valid over the recommended operating conditions unless otherwise specified.

## 6.1 Absolute Maximum Ratings

The list of absolute maximum ratings are specified over operating case temperature. Stresses beyond those listed under Section 6.2, Electrical Specifications, may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under Section 6.3, Recommended Operating Conditions, is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. All supply voltage values (core and I/O) are with respect to V<sub>SS</sub>. Figure 6–1 provides the test load circuit values for a 3.3-V device. Measured timing information contained in this data manual is based on the test load setup and conditions shown in Figure 6–1.

## 6.2 Electrical Specifications

This section provides the absolute maximum ratings for the TMS320VC5501 DSP.

| Supply voltage I/O range, DV <sub>DD</sub>       | – 0.3 V to 4.0 V  |
|--|-------------------|
| Supply voltage core range, CV <sub>DD</sub>      | -0.3 V to $2.0$ V |
| Input voltage range, V <sub>I</sub>              | – 0.3 V to 4.5 V  |
| Output voltage range, V <sub>o</sub>             | – 0.3 V to 4.5 V  |
| Operating case temperature range, T <sub>C</sub> | . –40°C to 85°C   |
| Storage temperature range T <sub>stg</sub>       | – 55°C to 150°C   |

## 6.3 Recommended Operating Conditions

This section provides the recommended operating conditions for the TMS320VC5501 DSP.

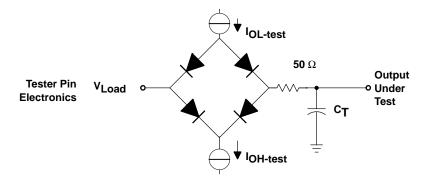
|                  |                               |   | MIN  | NOM  | MAX                    | UNIT |
|------------------|-------------------------------|---|------|------|------------------------|------|
| $DV_{DD}$        | Device supply voltage, I/O    |   | 2.7  | 3.3  | 3.6                    | V    |
| CV <sub>DD</sub> | Device supply voltage, core   | Device supply voltage, core   |      | 1.26 | 1.32                   | V    |
| $PV_{DD}$        | Device supply voltage, PLL    |   | 2.7  | 3.3  | 3.6                    | V    |
| VSS              | Supply voltage, GND           |   |      | 0    |                        | V    |
| VIH              | High-level input voltage, I/O | Hysteresis inputs $DV_{\mbox{\footnotesize DD}} = 2.7 - 3.6 \ \mbox{V}$     | 2.2  |      | DV <sub>DD +</sub> 0.3 |      |
|                  |                               | All other inputs  | 2    |      | DV <sub>DD</sub> + 0.3 |      |
| V <sub>IL</sub>  | Low-level input voltage, I/O  | Hysteresis inputs $DV_{\mbox{\footnotesize DD}} = 2.7 - 3.6 \ \mbox{\it V}$ | -0.3 |      | 0.8                    |      |
|                  |                               | All other inputs  | -0.3 |      | 0.8                    |      |
| ЮН               | High-level output current     | All outputs   |      |      | - 300                  | μΑ   |
| loL              | Low-level output current      | All outputs   |      |      | 1.5                    | mA   |
| T <sub>C</sub>   | Operating case temperature    |   | -40  | •    | 85                     | °C   |

# 6.4 Electrical Characteristics Over Recommended Operating Case Temperature Range (Unless Otherwise Noted)

|                  | PARAME  | TER  | TEST CONDITION  | NS   | MIN   | TYP | MAX | UNIT |
|------------------|---|--|---|------|-------|-----|-----|------|
| \/-··            | Llieb lovel output voltoge  |  | $DV_{DD} = 2.7 - 3.0 \text{ V},$<br>$I_{OH} = MAX$  |      | 2.2   |     |     | · >  |
| VOH              | High-level output voltage   |  | $DV_{DD} = 3.3 \pm 0.3 \text{ V},$<br>$I_{OH} = \text{MAX}$                                   |      | 2.4   |     |     | V    |
| $V_{OL}$         | Low-level output voltage  |  | I <sub>OL</sub> = MAX   |      |       |     | 0.4 | V    |
| l <sub>IZ</sub>  | Input current for outputs in  |  |   |      | - 300 |     | 300 | μА   |
| <b></b>          | high impedance  | All other output-only or input/output pins | DV <sub>DD</sub> = MAX,<br>-0.3 V < V <sub>I</sub> < 4.5 V                                    |      | - 5   |     | 5   |      |
|                  |   | Input pins with internal pulldown          | DV <sub>DD</sub> = MAX,<br>-0.3 V < V <sub>I</sub> < 4.5 V                                    |      | - 5   |     | 300 |      |
|                  |   | X2/CLKIN with oscillator on                | DV <sub>DD</sub> = MAX,<br>-0.3 V < V <sub>I</sub> < 4.5 V                                    |      | TBD   |     | TBD |      |
| I <sub>I</sub>   | Input current   | X2/CLKIN with oscillator off               | DV <sub>DD</sub> = MAX,<br>-0.3 V < V <sub>I</sub> < 4.5 V                                    |      | TBD   |     | TBD | μΑ   |
|                  |   | Input pins with internal pullup            | Pullup enabled<br>DV <sub>DD</sub> = MAX,<br>-0.3 V < V <sub>I</sub> < 4.5 V                  |      | - 300 |     | 5   |      |
|                  |   | All other input-only pins                  | DV <sub>DD</sub> = MAX,<br>-0.3 V < V <sub>I</sub> < 4.5 V                                    |      | - 5   |     | 5   |      |
| IDDC             | CV <sub>DD</sub> supply current, CPU +  | internal memory access†                    | $CV_{DD}$ = Nominal<br>CPU clock = 300 MHz<br>$T_{C}$ = 25°C                                  |      |       | TBD |     | mA   |
| I <sub>DDD</sub> | DV <sub>DD</sub> supply current, pins ac  | ctive‡                                     | $DV_{DD}$ = Nominal<br>CPU clock = 300 MHz<br>$T_{C}$ = 25°C                                  |      |       | TBD |     | mA   |
| I <sub>DDP</sub> | PV <sub>DD</sub> supply current, standby<br>Only CLKGEN domain enabled, PLL enabled |  | PV <sub>DD</sub> = Nominal<br>30-MHz clock input,<br>APLL mode = x10<br>T <sub>C</sub> = 25°C |      |       | TBD |     | mA   |
|                  | CV <sub>DD</sub> supply current, standby  |  | CV <sub>DD</sub> = Nominal  | 25°C |       | TBD |     | ^    |
| IDDC             | All domains idled   |  | input clock stopped   | 85°C |       | TBD |     | mA   |
| IDDD             | DV <sub>DD</sub> supply current, standby<br>All domains idled                       |  | DV <sub>DD</sub> = Nominal<br>no pin activity<br>T <sub>C</sub> = 25°C                        |      |       | TBD |     | μΑ   |
| Ci               | Input capacitance   |  |   |      |       | 3   |     | pF   |
| Co               | Output capacitance  |  |   |      |       | 3   |     | pF   |

<sup>†</sup> Test Condition: CPU executing 75% Dual-MAC / 25% ADD with moderate data bus activity (table of sine values). CPU and CLKGEN domains are active. All other domains are idled. The APLL is enabled.

<sup>&</sup>lt;sup>‡</sup> Test Condition: One word of a table of 16-bit sine values is written to the EMIF each microsecond (16 Mbps). Each EMIF output pin is connected to a 10-pF load capacitance.



Where:  $I_{OL\text{-test}} = 1.5 \text{ mA}$  (all outputs)  $I_{OH\text{-test}} = 300 \mu \text{A}$  (all outputs)

 $V_{Load} = 1.8 V$ 

C<sub>T</sub> = 15 pF typical load circuit capacitance

Figure 6-1. 3.3-V Test Load Circuit

## 6.5 Package Thermal Resistance Characteristics

Table 6–1 provide the thermal resistance characteristics for the recommended package types used on the TMS320VC5501 DSP.

Table 6-1. Thermal Resistance Characteristics

| PARAMETER      | GGW PACKAGE | PGF PACKAGE | UNIT | BOARD TYPE†        |
|----------------|-------------|-------------|------|--------------------|
| $R_{	heta JC}$ | TBD         | TBD         | °C/W | 2s JEDEC Test Card |

<sup>†</sup> Board types are as defined by JEDEC. Reference JEDEC Standard JESD51–9, Test Boards for Area Array Surface Mount Package Thermal Measurements.

# 6.6 Timing Parameter Symbology

Timing parameter symbols used in the timing requirements and switching characteristics tables are created in accordance with JEDEC Standard 100. To shorten the symbols, some of the pin names and other related terminology have been abbreviated as follows:

Lowercase subscripts and their meanings:

а access time cycle time (period) С d delay time dis disable time enable time en fall time hold time rise time setup time su transition time valid time

w pulse duration (width)

106

SPRS206

X Unknown, changing, or don't care level

Letters and symbols and their meanings:

H High
L Low
V Valid
Z High impedance



## 6.7 Clock Options

This section provides the timing requirements and switching characteristics for the various clock options available on the 5501.

## 6.7.1 Clock Generation in Bypass Mode (APLL Disabled)

Table 6–2 and Table 6–3 assume testing over recommended operating conditions and  $H = 0.5t_{C(CO)}$  (see Figure 6–2).

Table 6-2. CLKIN in Bypass Mode Timing Requirements

| NO. |                                      | MIN  | MAX | UNIT |
|-----|--------------------------------------|------|-----|------|
| C7  | t <sub>C(CI)</sub> Cycle time, CLKIN | 3.33 | †   | ns   |
| C8  | t <sub>f(CI)</sub> Fall time, CLKIN  |      | 6   | ns   |
| C9  | $t_{r(CI)}$ Rise time, CLKIN         |      | 6   | ns   |

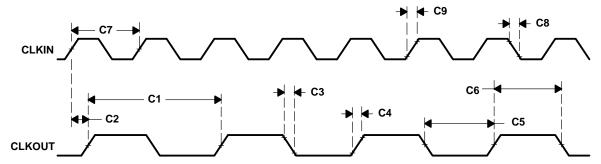
<sup>&</sup>lt;sup>†</sup> This device utilizes a fully static design and therefore can operate with t<sub>C(CI)</sub> approaching ∞. The device is characterized at frequencies approaching 0 Hz.

Table 6-3. CLKOUT in Bypass Mode Switching Characteristics

| NO. |                     | PARAMETER                                 | MIN   | TYP                 | MAX | UNIT |
|-----|---------------------|---|-------|---------------------|-----|------|
| C1  | t <sub>C</sub> (CO) | Cycle time, CLKOUT                        | 3.33‡ | t <sub>C</sub> (CI) | †   | ns   |
| C2  | td(CIH-CO)          | Delay time, CLKIN high to CLKOUT high/low | 1     | 2                   | 4   | ns   |
| C3  | tf(CO)              | Fall time, CLKOUT                         |       | 1                   |     | ns   |
| C4  | t <sub>r(CO)</sub>  | Rise time, CLKOUT                         |       | 1                   |     | ns   |
| C5  | tw(COL)             | Pulse duration, CLKOUT low                | H–1   | Н                   | H+1 | ns   |
| C6  | tw(COH)             | Pulse duration, CLKOUT high               | H–1   | Н                   | H+1 | ns   |

<sup>&</sup>lt;sup>†</sup> This device utilizes a fully static design and therefore can operate with t<sub>C(CI)</sub> approaching ∞. The device is characterized at frequencies approaching 0 Hz.

<sup>‡</sup> It is recommended that the lock mode (APLL synthesis enabled) clocking option be used for maximum frequency operation.



NOTE: The relationship of CLKIN to CLKOUT depends on the divide factor chosen. The waveform relationship shown in Figure 6–2 is intended to illustrate the timing parameters only and may differ based on configuration.

Figure 6-2. Bypass Mode Clock Timing

#### 6.7.2 Clock Generation in PLL Mode

The frequency of the reference clock provided at the CLKIN pin can be multiplied by a synthesis factor of N to generate the internal CPU clock cycle. The synthesis factor is determined by:

$$N = \frac{M}{D_0}$$

where: M = the multiply factor set in the PLLM field of the PLL Multiplier Control Register (PLLM)

D<sub>0</sub> = the divide factor set in the PLLDIV0 field of the PLL Divider 0 Register (PLLDIV0)

Valid values for M are (multiply by) 1 to 16. Valid values for  $D_0$  are (divide by) 1 – 32.

For detailed information on clock generation configuration, see the *TMS320C55x DSP Peripherals Reference Guide* (literature number SPRU317).

Table 6–4 and Table 6–5 assume testing over recommended operating conditions and  $H = 0.5t_{C(CO)}$  (see Figure 6–3).

Table 6-4. CLKIN in Lock Mode Timing Requirements

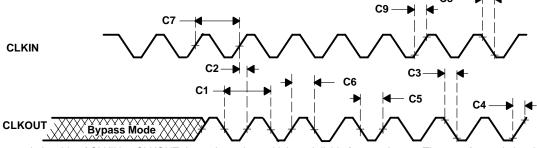
| NO. |                     |                        |                         |                     |     |     | UNIT |
|-----|---------------------|------------------------|-------------------------|---------------------|-----|-----|------|
| 07  |                     | Ovele time OLIVIN      | ADLL conthonic conclude | Oscillator disabled | 40† | 400 | ns   |
| C7  | t <sub>C</sub> (CI) | Cycle time, CLKIN      | APLL synthesis enabled  | Oscillator enabled  | 50  | 200 | ns   |
| C8  | t <sub>f</sub> (CI) | f(CI) Fall time, CLKIN |                         |                     |     | 6   | ns   |
| C9  | tr(CI)              | Rise time, CLKIN       |                         |                     |     | 6   | ns   |

<sup>†</sup> The clock frequency synthesis factor and minimum CLKIN cycle time should be chosen such that the resulting CLKOUT cycle time is within the specified range [t<sub>C</sub>(CO)].

Table 6-5. CLKOUT in Lock Mode Switching Characteristics

| NO. |                     | PARAMETER                                     | MIN  | TYP                    | MAX | UNIT |
|-----|---------------------|---|------|------------------------|-----|------|
| C1  | t <sub>C</sub> (CO) | Cycle time, CLKOUT                            | 3.33 | t <sub>c(CI)</sub> /N‡ |     | ns   |
| C2  | td(CI-CO)           | Delay time, CLKIN high/low to CLKOUT high/low | 1    | 2                      | 4   | ns   |
| C3  | tf(CO)              | Fall time, CLKOUT                             |      | 1                      |     | ns   |
| C4  | tr(CO)              | Rise time, CLKOUT                             |      | 1                      |     | ns   |
| C5  | tw(COL)             | Pulse duration, CLKOUT low                    | H–1  | Н                      | H+1 | ns   |
| C6  | tw(COH)             | Pulse duration, CLKOUT high                   | H–1  | Н                      | H+1 | ns   |

<sup>&</sup>lt;sup>‡</sup>N = Clock frequency synthesis factor



NOTE: The waveform relationship of CLKIN to CLKOUT depends on the multiply and divide factors chosen. The waveform relationship shown in Figure 6–3 is intended to illustrate the timing parameters only and may differ based on configuration.

Figure 6-3. External Multiply-by-N Clock Timing

## 6.7.3 EMIF Clock Options

Table 6–6 through Table 6–8 assume testing over recommended operating conditions (see Figure 6–4 through Figure 6–6).

Table 6-6. EMIF Timing Requirements for ECLKIN†‡

| NO. |                      |                             | MIN  | MAX | UNIT |
|-----|----------------------|-----------------------------|------|-----|------|
| E1  | t <sub>c</sub> (EKI) | Cycle time, ECLKIN          | 10   | 16P | ns   |
| E2  | tw(EKIH)             | Pulse duration, ECLKIN high | 3.38 |     | ns   |
| E3  | tw(EKIL)             | Pulse duration, ECLKIN low  | 3.38 |     | ns   |
| E4  | t <sub>t</sub> (EKI) | Transition time, ECLKIN     |      | 2   | ns   |

<sup>†</sup> P = 1/CPU clock frequency in ns. For example, when running parts at 300 MHz, use P = 3.33 ns.

#### Table 6-7. EMIF Switching Characteristics for ECLKOUT1§¶#

| NO. |                       | PARAMETER                                | MIN      | MAX      | UNIT |
|-----|-----------------------|--|----------|----------|------|
| E11 | t <sub>c</sub> (EKO1) | Cycle time, ECLKOUT1                     | E – 0.7  | E + 0.7  | ns   |
| E22 | tw(EKO1H)             | Pulse duration, ECLKOUT1 high            | EH – 0.7 | EH + 0.7 | ns   |
| E33 | tw(EKO1L)             | Pulse duration, ECLKOUT1 low             | EL – 0.7 | EL + 0.7 | ns   |
| E44 | <sup>t</sup> t(EKO1)  | Transition time, ECLKOUT1                |          | 1        | ns   |
| E55 | td(EKIH-EKO1H)        | Delay time, ECLKIN high to ECLKOUT1 high | 3        | 8        | ns   |
| E66 | td(EKIL-EKO1L)        | Delay time, ECLKIN low to ECLKOUT1 low   | 3        | 8        | ns   |

<sup>§</sup> The reference points for the rise and fall transitions are measured at VOL MAX and VOH MIN.

<sup>#</sup>EH is the high period of E (EMIF input clock period) in ns and EL is the low period of E (EMIF input clock period) in ns for EMIF.

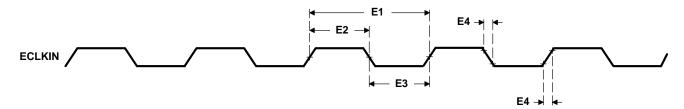


Figure 6-4. ECLKIN Timing for EMIF

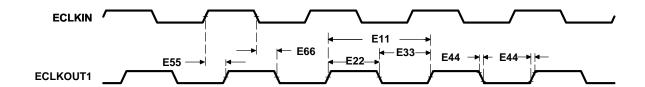


Figure 6-5. ECLKOUT1 Timing for EMIF Module

 $<sup>\</sup>ddagger$  The reference points for the rise and fall transitions are measured at V<sub>IL</sub> MAX and V<sub>IH</sub> MIN.

<sup>¶</sup> E = the EMIF input clock (CPU clock, CPU/2 clock, or CPU/4 clock) period in ns for EMIF.

| NO.       |                       | PARAMETER                                | MIN         | MAX         | UNIT |
|-----------|-----------------------|--|-------------|-------------|------|
| E1        | t <sub>C</sub> (EKO2) | Cycle time, ECLKOUT2                     | NE - 0.7    | NE + 0.7    | ns   |
| E2        | tw(EKO2H)             | Pulse duration, ECLKOUT2 high            | 0.5NE - 0.7 | 0.5NE + 0.7 | ns   |
| E3        | tw(EKO2L)             | Pulse duration, ECLKOUT2 low             | 0.5NE - 0.7 | 0.5NE + 0.7 | ns   |
| E4        | t <sub>t</sub> (EKO2) | Transition time, ECLKOUT2                |             | 1           | ns   |
| E5        | td(EKIH-EKO2H)        | Delay time, ECLKIN high to ECLKOUT2 high | 3           | 8           | ns   |
| <b>E6</b> | td(EKIH-EKO2L)        | Delay time, ECLKIN high to ECLKOUT2 low  | 3           | 8           | ns   |

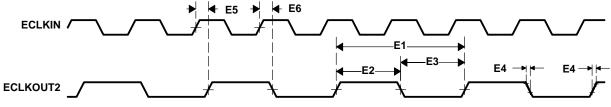


Figure 6-6. ECLKOUT2 Timing for the EMIF Module

<sup>†</sup> The reference points for the rise and fall transitions are measured at V<sub>OL</sub> MAX and V<sub>OH</sub> MIN. ‡ E = the EMIF input clock (CPU clock, CPU/2 clock, or CPU/4 clock) period in ns for EMIF. N = the EMIF input clock divider; N = 1, 2, or 4.

## 6.8 EMIF Asynchronous Memory Timing

Table 6–9 and Table 6–10 assume testing over recommended operating conditions (see Figure 6–7 and Figure 6–8).

Table 6-9. EMIF Asynchronous Memory Cycle Timing Requirements for ECLKIN†‡

| NO. |                             |   | MIN | MAX | UNIT |
|-----|-----------------------------|---|-----|-----|------|
| E3  | t <sub>su</sub> (EDV-AREH)  | Setup time, Dx valid before ARE high        | 6   |     | ns   |
| E4  | th(AREH-EDV)                | Hold time, Dx valid after ARE high          | 1   |     | ns   |
| E6  | t <sub>su(ARDY-EKO1H)</sub> | Setup time, ARDY valid before ECLKOUT1 high | 3   |     | ns   |
| E7  | th(EKO1H-ARDY)              | Hold time, ARDY valid after ECLKOUT1 high   | 1   |     | ns   |

<sup>†</sup> To ensure data setup time, simply program the strobe width wide enough. ARDY is internally synchronized. The ARDY signal is recognized in the cycle for which the setup and hold time is met. To use ARDY as an asynchronous input, the pulse width of the ARDY signal should be wide enough (e.g., pulse width = 2E) to ensure setup and hold time is met.

Table 6-10. EMIF Asynchronous Memory Cycle Switching Characteristics for ECLKOUT1द

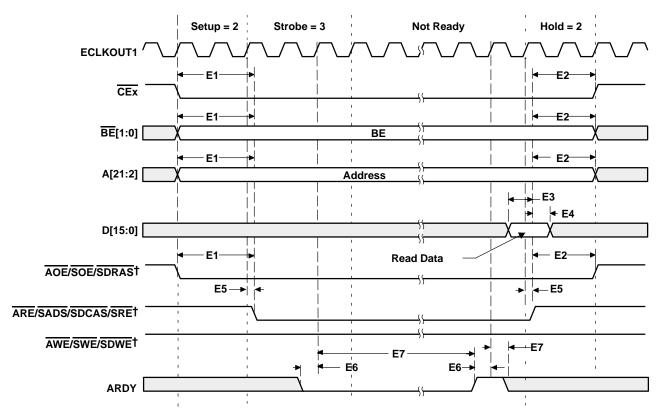
| NO. |                 | PARAMETER  | MIN          | MAX | UNIT |
|-----|-----------------|--|--------------|-----|------|
| E1  | tosu(SELV-AREL) | Output setup time, select signals valid to ARE low   | RS * E – 1.5 |     | ns   |
| E2  | toh(AREH-SELIV) | Output hold time, ARE high to select signals invalid | RH * E – 1.5 |     | ns   |
| E5  | td(EKO1H-AREV)  | Delay time, ECLKOUT1 high to ARE valid               | 1.5          | 5   | ns   |
| E8  | tosu(SELV-AWEL) | Output setup time, select signals valid to AWE low   | WS * E - 1.5 |     | ns   |
| E9  | toh(AWEH-SELIV) | Output hold time, AWE high to select signals invalid | WH * E – 1.5 |     | ns   |
| E10 | td(EKO1H-AWEV)  | Delay time, ECLKOUT1 high to AWE valid               | 1.5          | 5   | ns   |

<sup>‡</sup>RS = Read setup, RST = Read strobe, RH = Read hold, WS = Write setup, WST = Write strobe, WH = Write hold. These parameters are programmed via the EMIF CE space control registers.

<sup>‡</sup>RS = Read setup, RST = Read strobe, RH = Read hold, WS = Write setup, WST = Write strobe, WH = Write hold. These parameters are programmed via the EMIF CE space control registers.

<sup>§</sup> E = ECLKOUT1 period in ns for EMIF.

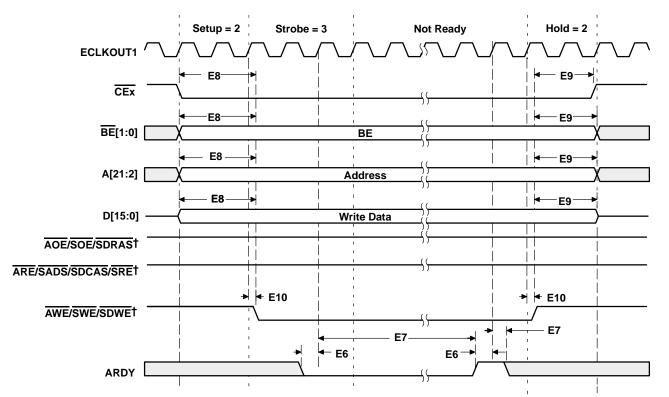
<sup>¶</sup> Select signals for EMIF include: CEx, BE[1:0], A[21:2], and AOE; and for EMIF writes, include D[15:0].



† AOE/SOE/SDRAS, ARE/SADS/SDCAS/SRE, and AWE/SWE/SDWE operate as AOE (identified under select signals), ARE, and AWE, respectively, during asynchronous memory accesses.

Figure 6–7. Asynchronous Memory Read Timing for EMIF†

SPRS206



<sup>†</sup> AOE/SOE/SDRAS, ARE/SADS/SDCAS/SRE, and AWE/SWE/SDWE operate as AOE (identified under select signals), ARE, and AWE, respectively, during asynchronous memory accesses.

Figure 6-8. Asynchronous Memory Write Timing for EMIF<sup>†</sup>

114

SPRS206

## 6.9 Programmable Synchronous Interface Timing

Table 6–11 and Table 6–12 assume testing over recommended operating conditions (see Figure 6–9 through Figure 6–11).

Table 6-11. EMIF Programmable Synchronous Interface Timing Requirements

| NO. |                             |  | MIN | MAX | UNIT |
|-----|-----------------------------|--|-----|-----|------|
| E6  | t <sub>su</sub> (EDV-EKOxH) | Setup time, read Dx valid before ECLKOUTx high | 2   |     | ns   |
| E7  | th(EKOxH-EDV)               | Hold time, read Dx valid after ECLKOUTx high   | 1.5 |     | ns   |

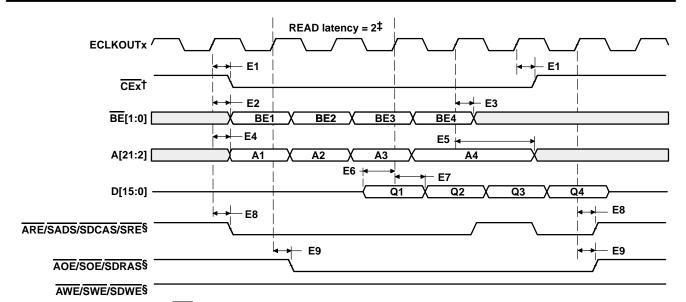
#### Table 6–12. EMIF Programmable Synchronous Interface Switching Characteristics<sup>†</sup>

| NO. |                | PARAMETER                                   | MIN | MAX | UNIT |
|-----|----------------|---|-----|-----|------|
| E1  | td(EKOxH-CEV)  | Delay time, ECLKOUTx high to CEx valid      | 1   | 5   | ns   |
| E2  | td(EKOxH-BEV)  | Delay time, ECLKOUTx high to BEx valid      |     | 5   | ns   |
| E3  | td(EKOxH-BEIV) | Delay time, ECLKOUTx high to BEx invalid    | 1   |     | ns   |
| E4  | td(EKOxH-EAV)  | Delay time, ECLKOUTx high to Ax valid       |     | 5   | ns   |
| E5  | td(EKOxH-EAIV) | Delay time, ECLKOUTx high to Ax invalid     | 1   |     | ns   |
| E8  | td(EKOxH-ADSV) | Delay time, ECLKOUTx high to SADS/SRE valid | 1   | 5   | ns   |
| E9  | td(EKOxH-OEV)  | Delay time, ECLKOUTx high to, SOE valid     | 1   | 5   | ns   |
| E10 | td(EKOxH-EDV)  | Delay time, ECLKOUTx high to Dx valid       |     | 5   | ns   |
| E11 | td(EKOxH-EDIV) | Delay time, ECLKOUTx high to Dx invalid     | 1   |     | ns   |
| E12 | td(EKOxH-WEV)  | Delay time, ECLKOUTx high to SWE valid      | 1   | 5   | ns   |

† The following parameters are programmable via the EMIF CE Secondary Control Registers (CEx\_SC1, CEx\_SC2):

- Read latency (SYNCRL): 0-, 1-, 2-, or 3-cycle read latency
- Write latency (SYNCWL): 0-, 1-, 2-, or 3-cycle write latency
- CEx assertion length (CEEXT): For standard SBSRAM or ZBT SRAM interface, CEx goes inactive after the final command has been issued (CEEXT = 0). For synchronous FIFO interface with glue, CEx is active when SOE is active (CEEXT = 1).
- Function of SADS/SRE (RENEN): For standard SBSRAM or ZBT SRAM interface, SADS/SRE acts as SADS with deselect cycles (RENEN = 0). For FIFO interface, SADS/SRE acts as SRE with NO deselect cycles (RENEN = 1).
- Synchronization clock (SNCCLK): Synchronized to ECLKOUT1 or ECLKOUT2



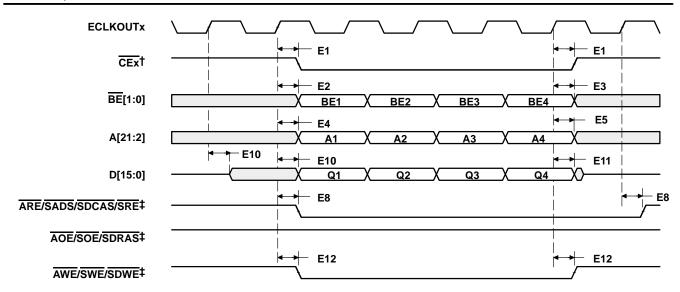


<sup>†</sup> The read latency and the length of CEx assertion are programmable via the SYNCRL and CEEXT fields, respectively, in the EMIF CE Secondary Control Registers (CEx\_SC1, CEx\_SC2). In the figure, SYNCRL = 2 and CEEXT = 0.

<sup>‡</sup> The following parameters are programmable via the EMIF CE Secondary Control Registers (CEx\_SC1, CEx\_SC2):

- Read latency (SYNCRL): 0-, 1-, 2-, or 3-cycle read latency
- Write latency (SYNCWL): 0-, 1-, 2-, or 3-cycle write latency
- CEx assertion length (CEEXT): For standard SBSRAM or ZBT SRAM interface, CEx goes inactive after the final command has been issued (CEEXT = 0). For synchronous FIFO interface with glue, CEx is active when SOE is active (CEEXT = 1).
- Function of SADS/SRE (RENEN): For standard SBSRAM or ZBT SRAM interface, SADS/SRE acts as SADS with deselect cycles (RENEN = 0). For FIFO interface, SADS/SRE acts as SRE with NO deselect cycles (RENEN = 1).
- Synchronization clock (SNCCLK): Synchronized to ECLKOUT1 or ECLKOUT2
- § ARE/SADS/SDCAS/SRE, AOE/SOE/SDRAS, and AWE/SWE/SDWE operate as SADS/SRE, SOE, and SWE, respectively, during programmable synchronous interface accesses.

Figure 6-9. Programmable Synchronous Interface Read Timing for EMIF (With Read Latency = 2)

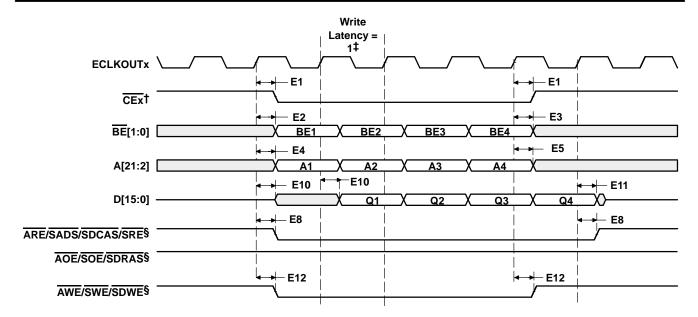


<sup>†</sup> The write latency and the length of CEx assertion are programmable via the SYNCWL and CEEXT fields, respectively, in the EMIF CE Secondary

Figure 6–10. Programmable Synchronous Interface Write Timing for EMIF (With Write Latency = 0)

SPRS206

Control Registers (CEx\_SC1, CEx\_SC2). In this figure, SYNCWL = 0 and CEEXT = 0. ‡ ARE/SADS/SDCAS/SRE, AOE/SOE/SDRAS, and AWE/SWE/SDWE operate as SADS/SRE, SOE, and SWE, respectively, during programmable synchronous interface accesses.



<sup>†</sup> The write latency and the length of CEx assertion are programmable via the SYNCWL and CEEXT fields, respectively, in the EMIF CE Secondary Control Registers (CEx\_SC1, CEx\_SC2). In this figure, SYNCWL = 1 and CEEXT = 0.

- Read latency (SYNCRL): 0-, 1-, 2-, or 3-cycle read latency
- Write latency (SYNCWL): 0-, 1-, 2-, or 3-cycle write latency
- CEx assertion length (CEEXT): For standard SBSRAM or ZBT SRAM interface, CEx goes inactive after the final command has been issued (CEEXT = 0). For synchronous FIFO interface with glue, CEx is active when SOE is active (CEEXT = 1).
- Function of SADS/SRE (RENEN): For standard SBSRAM or ZBT SRAM interface, SADS/SRE acts as SADS with deselect cycles (RENEN = 0). For FIFO interface, SADS/SRE acts as SRE with NO deselect cycles (RENEN = 1).
- Synchronization clock (SNCCLK): Synchronized to ECLKOUT1 or ECLKOUT2
- § ARE/SADS/SDCAS/SRE, AOE/SOE/SDRAS, and AWE/SWE/SDWE operate as SADS/SRE, SOE, and SWE, respectively, during programmable synchronous interface accesses.

Figure 6–11. Programmable Synchronous Interface Write Timing for EMIF (With Write Latency = 1)

<sup>&</sup>lt;sup>‡</sup> The following parameters are programmable via the EMIF CE Secondary Control Registers (CEx\_SC1, CEx\_SC2):

## 6.10 Synchronous DRAM Timing

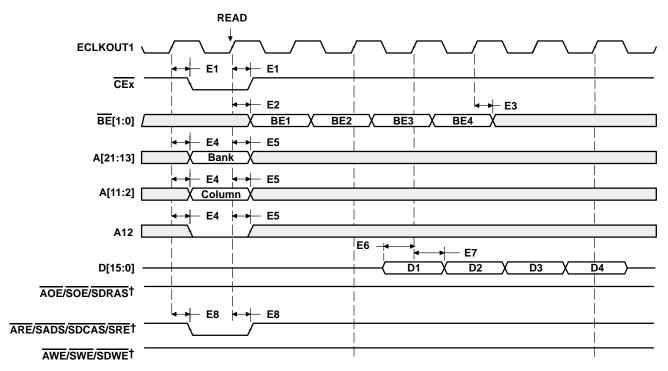
Table 6–13 and Table 6–14 assume testing over recommended operating conditions (see Figure 6–12 through Figure 6–19).

Table 6-13. EMIF Synchronous DRAM Cycle Timing Requirements

| NO. |                             |  | MIN | MAX | UNIT |
|-----|-----------------------------|--|-----|-----|------|
| E6  | t <sub>su</sub> (EDV-EKO1H) | Setup time, read Dx valid before ECLKOUT1 high | 0.5 |     | ns   |
| E7  | th(EKO1H-EDV)               | Hold time, read Dx valid after ECLKOUT1 high   | 2   |     | ns   |

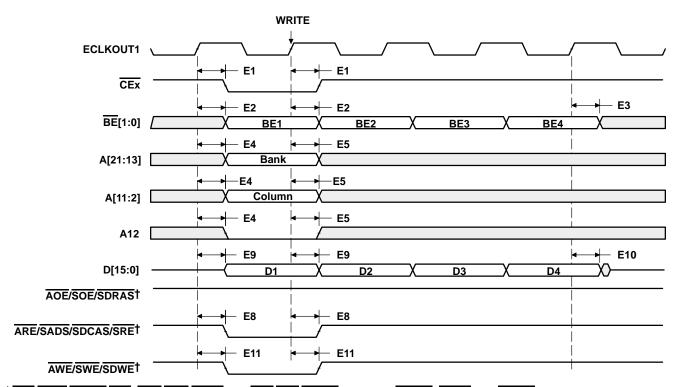
Table 6-14. EMIF Synchronous DRAM Cycle Switching Characteristics

| NO. |                | PARAMETER                                      | MIN | MAX | UNIT |
|-----|----------------|--|-----|-----|------|
| E1  | td(EKO1H-CEV)  | Delay time, ECLKOUT1 high to CEx valid/invalid | 1   | 5   | ns   |
| E2  | td(EKO1H-BEV)  | Delay time, ECLKOUT1 high to BEx valid         |     | 5   | ns   |
| E3  | td(EKO1H-BEIV) | Delay time, ECLKOUT1 high to BEx invalid       | 1   |     | ns   |
| E4  | td(EKO1H-EAV)  | Delay time, ECLKOUT1 high to Ax valid          |     | 5   | ns   |
| E5  | td(EKO1H-EAIV) | Delay time, ECLKOUT1 high to Ax invalid        | 1   |     | ns   |
| E8  | td(EKO1H-CASV) | Delay time, ECLKOUT1 high to SDCAS valid       | 1   | 5   | ns   |
| E9  | td(EKO1H-EDV)  | Delay time, ECLKOUT1 high to Dx valid          |     | 5   | ns   |
| E10 | td(EKO1H-EDIV) | Delay time, ECLKOUT1 high to Dx invalid        | 1   |     | ns   |
| E11 | td(EKO1H-WEV)  | Delay time, ECLKOUT1 high to SDWE valid        | 1   | 5   | ns   |
| E12 | td(EKO1H-RASV) | Delay time, ECLKOUT1 high to SDRAS valid       | 1   | 5   | ns   |
| E13 | td(EKO1H-CKEV) | Delay time, ECLKOUT1 high to SDCKE valid       | 1   | 5   | ns   |



<sup>†</sup> ARE/SADS/SDCAS/SRE, AWE/SWE/SDWE, and AOE/SOE/SDRAS operate as SDCAS, SDWE, and SDRAS, respectively, during SDRAM accesses.

Figure 6-12. SDRAM Read Command (CAS Latency 3) for EMIF



<sup>†</sup> ARE/SADS/SDCAS/SRE, AWE/SWE/SDWE, and AOE/SOE/SDRAS operate as SDCAS, SDWE, and SDRAS, respectively, during SDRAM accesses.

**ACTV** ECLKOUT1 / E1 CEx BE[1:0] **E**5 A[21:13] **Bank Activate** A[11:2] [ Row Address **E**5 **E**4 A12 [ **Row Address** D[15:0] [ E12 -E12 AOE/SOE/SDRAS†

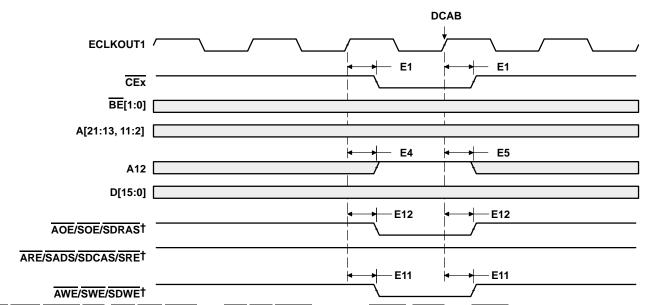
Figure 6-13. SDRAM Write Command for EMIF

ARE/SADS/SDCAS/SRE†

AWE/SWE/SDWE†

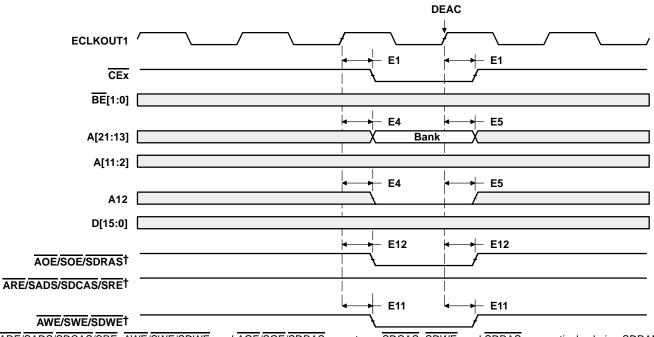
Figure 6-14. SDRAM ACTV Command for EMIF

<sup>†</sup> ARE/SADS/SDCAS/SRE, AWE/SWE/SDWE, and AOE/SOE/SDRAS operate as SDCAS, SDWE, and SDRAS, respectively, during SDRAM accesses.



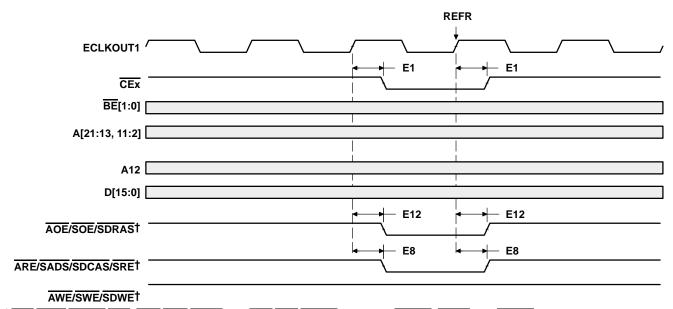
<sup>†</sup> ARE/SADS/SDCAS/SRE, AWE/SWE/SDWE, and AOE/SOE/SDRAS operate as SDCAS, SDWE, and SDRAS, respectively, during SDRAM accesses.

Figure 6-15. SDRAM DCAB Command for EMIF



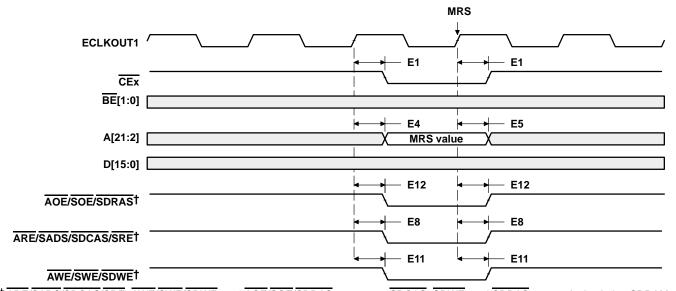
<sup>†</sup> ARE/SADS/SDCAS/SRE, AWE/SWE/SDWE, and AOE/SOE/SDRAS operate as SDCAS, SDWE, and SDRAS, respectively, during SDRAM accesses.

Figure 6-16. SDRAM DEAC Command for EMIF



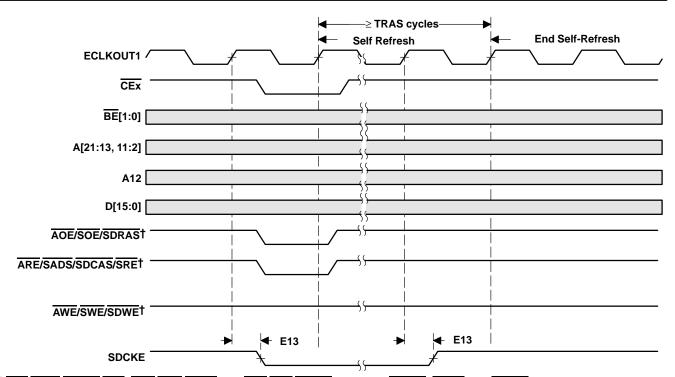
<sup>†</sup> ARE/SADS/SDCAS/SRE, AWE/SWE/SDWE, and AOE/SOE/SDRAS operate as SDCAS, SDWE, and SDRAS, respectively, during SDRAM accesses.

Figure 6-17. SDRAM REFR Command for EMIF



<sup>†</sup> ARE/SADS/SDCAS/SRE, AWE/SWE/SDWE, and AOE/SOE/SDRAS operate as SDCAS, SDWE, and SDRAS, respectively, during SDRAM accesses.

Figure 6-18. SDRAM MRS Command for EMIF



<sup>†</sup> ARE/SADS/SDCAS/SRE, AWE/SWE/SDWE, and AOE/SOE/SDRAS operate as SDCAS, SDWE, and SDRAS, respectively, during SDRAM accesses.

Figure 6-19. SDRAM Self-Refresh Timing for EMIF



## 6.11 HOLD/HOLDA Timing

Table 6–15 and Table 6–16 assume testing over recommended operating conditions (see Figure 6–20).

Table 6-15. EMIF HOLD/HOLDA Timing Requirements†

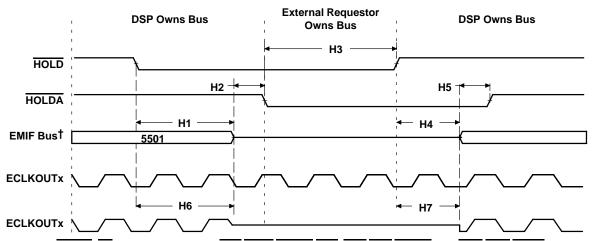
| NO. |   | MIN MA | X UNIT |
|-----|---|--------|--------|
| H3  | toh(HOLDAL-HOLDL) Hold time, HOLD low after HOLDA low | E      | ns     |

<sup>†</sup>E = the EMIF input clock (ECLKIN, CPU/1 clock, CPU1/2 clock, or CPU1/4 clock) period in ns for EMIF.

#### Table 6–16. EMIF HOLD/HOLDA Switching Characteristics †\$

| NO. |                             | PARAMETER  |    | MAX | UNIT |
|-----|-----------------------------|--|----|-----|------|
| H1  | <sup>t</sup> d(HOLDL-EMHZ)  | Delay time, HOLD low to EMIF Bus high impedance  | 2E | 1   | ns   |
| H2  | td(EMHZ-HOLDAL)             | Delay time, EMIF Bus high impedance to HOLDA low | 0  | 2E  | ns   |
| H4  | <sup>t</sup> d(HOLDH-EMLZ)  | Delay time, HOLD high to EMIF Bus low impedance  | 2E | 7E  | ns   |
| Н5  | <sup>t</sup> d(EMLZ-HOLDAH) | Delay time, EMIF Bus low impedance to HOLDA high | 0  | 2E  | ns   |
| Н6  | td(HOLDL-EKOHZ)             | Delay time, HOLD low to ECLKOUTx high impedance  | 2E | ¶   | ns   |
| H7  | td(HOLDH-EKOLZ)             | Delay time, HOLD high to ECLKOUTx low impedance  | 2E | 7E  | ns   |

All pending EMIF transactions are allowed to complete before HOLDA is asserted. If no bus transactions are occurring, then the minimum delay time can be achieved. Also, bus hold can be indefinitely delayed by setting NOHOLD = 1.



†EMIF Bus consists of: CE[3:0], BE[1:0], D[15:0], A[21:2], ARE/SADS/SDCAS/SRE, AOE/SOE/SDRAS, and AWE/SWE/SDWE, SDCKE, and SOE3.

Figure 6-20. HOLD/HOLDA Timing for EMIF

<sup>†</sup> E = the EMIF input clock (ECLKIN, CPU/1 clock, CPU1/2 clock, or CPU1/4 clock) period in ns for EMIF.

‡ EMIF Bus consists of: CE[3:0], BE[1:0], D[15:0], A[21:2], ARE/SADS/SDCAS/SRE, AOE/SOE/SDRAS, and AWE/SWE/SDWE, SDCKE, and SOE3.

<sup>§</sup> The EKxHZ bits in the EMIF Global Control Registers (EGCR1, EGCR2) determine the state of the ECLKOUTx signals during HOLDA. If EKxHZ = 0, ECLKOUTx continues clocking during Hold mode. If EKxHZ = 1, ECLKOUTx goes to high impedance during Hold mode, as shown in Figure 6-20.

## 6.12 Reset Timings

Table 6–17 and Table 6–18 assume testing over recommended operating conditions (see Figure 6–21).

Table 6-17. Reset Timing Requirements †

| N | Ю. |         |                        | MIN    | MAX | UNIT |
|---|----|---------|------------------------|--------|-----|------|
|   | ₹1 | tw(RSL) | Pulse width, RESET low | 2P + 5 |     | ns   |

<sup>†</sup>P = the period of the clock on the X2/CLKIN pin in ns. For example, when using 20 MHz as the input clock, use P = 50 ns.

Table 6-18. Reset Switching Characteristics †

| NO. |                            | PARAMETER   |                        | MIN MAX    | UNIT |
|-----|----------------------------|---|------------------------|------------|------|
| R3  | <sup>t</sup> d(RSL-EMIFHZ) | Delay time, RESET low to EMIF group high impedance‡ |                        | 6          | ns   |
| D4  |                            | Delevitine DECET high to EMIC arrows valid          | GPIO4 = 0 (CLKMOD = 0) | 41102P + 6 |      |
| K4  |                            |   | GPIO4 = 1 (CLKMOD = 1) | 6          | ns   |
| R5  | td(RSL-LOWIV)              | Delay time, RESET low to low group invalid§         |                        | 6          | ns   |
|     |                            | B: DECET  | GPIO4 = 0 (CLKMOD = 0) | 41102P + 6 |      |
| R6  | <sup>t</sup> d(RSH-LOWV)   | (NV) Delay time, RESET high to low group valid      | GPIO4 = 1 (CLKMOD = 1) | 6          | ns   |
| R7  | td(RSL-HIGHIV)             | Delay time, RESET low to high group invalid§        |                        | 6          | ns   |
| Do. |                            | - · · · · · · · · · · · · · · · · · · ·             | GPIO4 = 0 (CLKMOD = 0) | 41102P + 6 |      |
| R8  | <sup>t</sup> d(RSH-HIGHV)  | Delay time, RESET high to high group valid§         | GPIO4 = 1 (CLKMOD = 1) | 6          | ns   |
| R9  | <sup>t</sup> d(RSL-ZHZ)    | Delay time, RESET low to Z group high impedance     |                        | 6          | ns   |
| B40 |                            | Delevitime DECET high to 7 group invalid            | GPIO4 = 0 (CLKMOD = 0) | 41102P + 6 |      |
| R10 | <sup>t</sup> d(RSH-ZV)     | RSH-ZV) Delay time, RESET high to Z group invalid¶  | GPIO4 = 1 (CLKMOD = 1) | 6          | ns   |

<sup>†</sup> P = the period of the clock on the X2/CLKIN pin in ns. For example, when using 20 MHz as the input clock, use P = 50 ns. ‡ EMIF group: CE[3:0], BE[1:0], ECLKOUTX, ARE, AOE, AWE, SADS, SOE, SWE, SDRAS, SDCAS, SDWE § High group: HINT, IACK Low group: HOLDA

<sup>¶</sup> Z group: A[21:2], D[15:0], CLKR[2:0], CLKX[2:0], FSR[2:0], FSX[2:0], DX[2:0], GPIO[7:0], XF, TIM1, and TIM0.

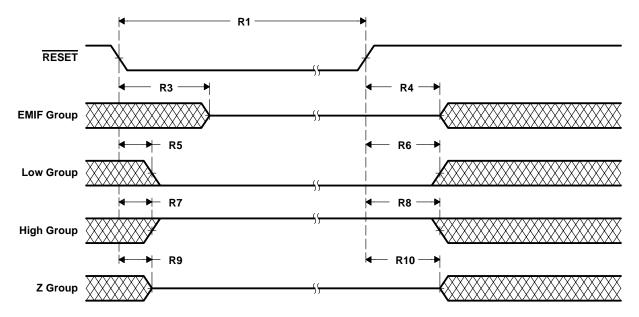


Figure 6-21. Reset Timing

# 6.13 External Interrupt and Interrupt Acknowledge (IACK) Timings

Table 6–19 and Table 6–20 assume testing over recommended operating conditions (see Figure 6–22 and Figure 6–23).

Table 6-19. External Interrupt and Interrupt Acknowledge Timing Requirements

| NO. |   | MIN | MAX | UNIT |
|-----|---|-----|-----|------|
| I1  | t <sub>w</sub> (INTL)A Pulse width, interrupt low, CPU active | 3P† |     | ns   |
| 12  | t <sub>w(INTH)A</sub> Pulse width, interrupt high, CPU active | 2P† |     | ns   |

 $<sup>^{\</sup>dagger}P = 1/CPU$  clock frequency in ns. For example, when running parts at 300 MHz, use P = 3.33 ns.

#### Table 6-20. External Interrupt and Interrupt Acknowledge Switching Characteristics

| N | 0.   | PARAMETER   |   | MAX | UNIT |
|---|------|---|---|-----|------|
| I | 13 1 | t <sub>d(COH-IACKV)</sub> Delay time, CLKOUT high to IACK valid | 0 | 3   | ns   |

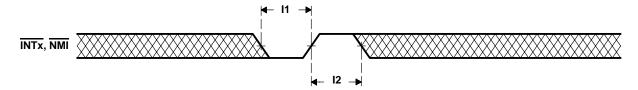


Figure 6-22. External Interrupt Timing

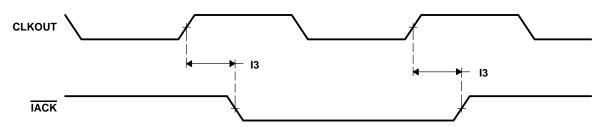


Figure 6-23. External Interrupt Acknowledge Timing

# 6.14 XF Timing

Table 6–21 assumes testing over recommended operating conditions (see Figure 6–24).

Table 6-21. XF Switching Characteristics

| NO. | PARAMETER          |                                    | MIN | MAX | UNIT |
|-----|--------------------|------------------------------------|-----|-----|------|
| V4  | 4                  | Delay time, CLKOUT high to XF high | 0   | 3   |      |
| X1  | <sup>t</sup> d(XF) | Delay time, CLKOUT high to XF low  | 0   | 3   | ns   |

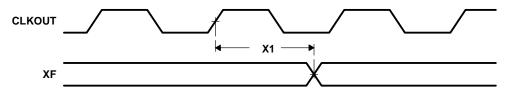


Figure 6–24. XF Timing

# 6.15 General-Purpose Input/Output (GPIOx)Timing

Table 6–22 and Table 6–23 assume testing over recommended operating conditions (see Figure 6–25).

Table 6-22. GPIO Pins Configured as Inputs Timing Requirements

| NO. |   | MIN | MAX | UNIT |
|-----|---|-----|-----|------|
| G2  | t <sub>su(GPIO</sub> —COH) Setup time, GPIOx input valid before CLKOUT high | 4   |     | ns   |
| G3  | th(COH_GPIO) Hold time, GPIOx input valid after CLKOUT high                 | 0   |     | ns   |

Table 6-23. GPIO Pins Configured as Inputs Switching Characteristics

|   | NO. | PARAMETER  |   | MAX | UNIT |
|---|-----|--|---|-----|------|
| Ī | G1  | t <sub>d(COH</sub> -GPIO) Delay time, CLKOUT high to GPIOx output change | 0 | 3   | ns   |

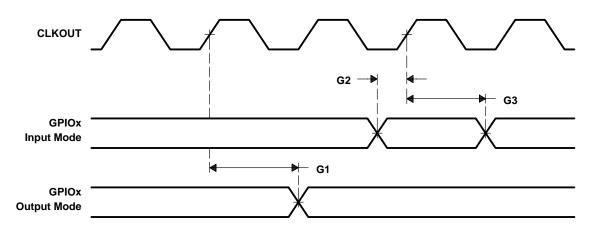


Figure 6-25. General-Purpose Input/Output (GPIOx) Signal Timings

## 6.15.1 TIMO/TIM1/WDTOUT Timings

Table 6–24 and Table 6–25 assume testing over recommended operating conditions (see Figure 6–26 and Figure 6–27).

Table 6-24. TIM0/TIM1/WDTOUT Pins Configured as Inputs Timing Requirements†

| NO. |  | MIN | MAX | UNIT |
|-----|--|-----|-----|------|
| T4  | t <sub>W</sub> (TIML) Pulse width, TIM0/TIM1/WDTOUT low  | P/4 |     | ns   |
| T5  | t <sub>W</sub> (TIMH) Pulse width, TIM0/TIM1/WDTOUT high | P/4 |     | ns   |

TP = (Divider1 Ratio)/(CPU Clock Frequency) in ns. For example, when running parts at 300 MHz with the fast peripheral domain at 1/2 the CPU clock frequency, use P = 2/300 MHz = 6.66 ns.

Table 6-25. TIM0/TIM1/WDTOUT Pins Configured as Outputs Switching Characteristics

| NO. |                      | PARAMETER  | MIN | MAX | UNIT |
|-----|----------------------|--|-----|-----|------|
| T1  | td(COH-TIMH)         | Delay time, CLKOUT high to TIM0/TIM1/WDTOUT high | 0   | 3   | ns   |
| T2  | td(COH-TIML)         | Delay time, CLKOUT high to TIM0/TIM1/WDTOUT low  | 0   | 3   | ns   |
| T3  | t <sub>w</sub> (TIM) | Pulse duration, TIM0/TIM1/WDTOUT                 | P†  |     | ns   |

TP = (Divider1 Ratio)/(CPU Clock Frequency) in ns. For example, when running parts at 300 MHz with the fast peripheral domain at 1/2 the CPU clock frequency, use P = 2/300 MHz = 6.66 ns.

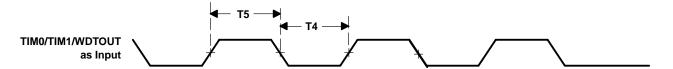


Figure 6-26. TIM0/TIM1/WDTOUT Timings When Configured as Inputs

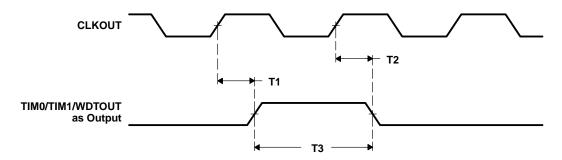


Figure 6-27. TIM0/TIM1/WDTOUT Timings When Configured as Outputs

## 6.16 Multichannel Buffered Serial Port (McBSP) Timing

## 6.16.1 McBSP Transmit and Receive Timings

Table 6–26 and Table 6–27 assume testing over recommended operating conditions (see Figure 6–28 and Figure 6–29).

Table 6-26. McBSP Transmit and Receive Timing Requirements<sup>†‡</sup>

| NO.  |                            |   |            | MIN   | MAX | UNIT |
|------|----------------------------|---|------------|-------|-----|------|
| M11  | t <sub>C</sub> (CKRX)      | Cycle time, CLKR/X                            | CLKR/X ext | 2P    |     | ns   |
| M12  | tw(CKRX)                   | Pulse duration, CLKR/X high or CLKR/X low     | CLKR/X ext | P – 1 |     | ns   |
| M13  | tr(CKRX)                   | Rise time, CLKR/X                             | CLKR/X ext |       | 5   | ns   |
| M14  | t <sub>f</sub> (CKRX)      | Fall time, CLKR/X                             | CLKR/X ext |       | 5   | ns   |
| 2045 | t <sub>su</sub> (FRH–CKRL) | Setup time, external FSR high before CLKR low | CLKR int   | 5     |     |      |
| M15  |                            |   | CLKR ext   | 1     |     | ns   |
|      | th(CKRL-FRH)               | Hold time, external FSR high after CLKR low   | CLKR int   | 0     |     |      |
| M16  |                            |   | CLKR ext   | 2     |     | ns   |
|      |                            | 0.1.1.1.1.1.1.1.1.1.1.1.1.1.1.1.1.1.1.1       | CLKR int   | 3     |     |      |
| M17  | tsu(DRV–CKRL)              | Setup time, DR valid before CLKR low          | CLKR ext   | 1     |     | ns   |
| M40  | <sup>t</sup> h(CKRL-DRV)   | Hold time, DR valid after CLKR low            | CLKR int   | 0     |     |      |
| M18  |                            |   | CLKR ext   | 2     |     | ns   |
| M40  | <sup>t</sup> su(FXH–CKXL)  | Setup time, external FSX high before CLKX low | CLKX int   | 5     |     |      |
| M19  |                            |   | CLKX ext   | 1     |     | ns   |
| 1400 | th(CKXL-FXH)               | Hold time, external FSX high after CLKX low   | CLKX int   | 0     |     |      |
| M20  |                            |   | CLKX ext   | 2     |     | ns   |

<sup>†</sup> Polarity bits CLKRP = CLKXP = FSRP = FSXP = 0. If the polarity of any of the signals is inverted, then the timing references of that signal are also inverted.

<sup>‡</sup> P = (Divider2 Ratio)/(CPU Clock Frequency) in ns. For example, when running parts at 300 MHz with the slow peripheral domain at 1/2 the CPU clock frequency, use P = 2/300 MHz = 6.66 ns.

Table 6-27. McBSP Transmit and Receive Switching Characteristics<sup>†‡</sup>

| NO.        | PARAMETER                    |  |           | MIN        | MAX        | UNIT |     |
|------------|------------------------------|--|-----------|------------|------------|------|-----|
| M1         | t <sub>C</sub> (CKRX)        | Cycle time, CLKR/X   |           | CLKR/X int | 2P         |      | ns  |
| M2         | tw(CKRXH)                    | Pulse duration, CLKR/X high  |           | CLKR/X int | D-1§       | D+1§ | ns  |
| М3         | tw(CKRXL)                    | Pulse duration, CLKR/X low   |           | CLKR/X int | C-1§       | C+1§ | ns  |
| M4         | •                            | Delay time, CLKR high to internal FSR valid  |           | CLKR int   | -2         | 2    | ns  |
| IVI        | td(CKRH-FRV)                 | Delay time, CERR high to internal 1 3R   | alid      | CLKR ext   | 4          | 8    | 115 |
| M5         | td(CKXH-FXV)                 | Delay time, CLKX high to internal FSX valid  |           | CLKX int   | -2         | 2    | ns  |
|            | u(CKAH-FAV)                  | Boldy time, GELOCHIGH to Internal 1 GA   | allu      | CLKX ext   | 4          | 8    | 110 |
| M6         | t <sub>dis</sub> (CKXH–DXHZ) | Disable time, CLKX high to DX high impedance   |           | CLKX int   | <b>-</b> 5 | 5    | ns  |
|            | dis(CRXI I-DXI IZ)           | following last data bit  | T         | CLKX ext   | 1          | 11   |     |
| <b>M</b> 7 |                              | Delay time, CLKX high to DX valid.<br>This applies to all bits except the first bit<br>transmitted.                            | DXENA = 0 | CLKX int   |            | 2    | ns  |
|            |                              |  |           | CLKX ext   |            | 8    |     |
|            |                              | Delay time, CLKX high to DX valid¶  Only applies to first bit transmitted when in Data Delay 1 or 2 (XDATDLY=01b or 10b) modes | DXENA = 0 | CLKX int   |            | 2    |     |
|            | td(CKXH-DXV)                 |  |           | CLKX ext   |            | 8    |     |
|            |                              |  | DXENA = 1 | CLKX int   |            | 2P+2 |     |
|            |                              |  |           | CLKX ext   |            | 2P+8 |     |
|            | ten(CKXH-DX)                 | H–DX)  Only applies to first bit transmitted when in Data Delay 1 or 2 (XDATDLY=01b or 10b) modes                              | DXENA = 0 | CLKX int   | 0          |      | ns  |
|            |                              |  |           | CLKX ext   | 6          |      |     |
| М8         |                              |  | DXENA = 1 | CLKX int   | 2P         |      |     |
|            |                              |  |           | CLKX ext   | 2P+6       |      |     |
|            | <sup>†</sup> d(FXH–DXV)      | Delay time, FSX high to DX valid¶  Only applies to first bit transmitted when in Data Delay 0 (XDATDLY=00b) mode.              | DXENA = 0 | FSX int    |            | 1    |     |
| М9         |                              |  |           | FSX ext    |            | 7    | ns  |
|            |                              |  | DXENA = 1 | FSX int    |            | 2P+1 |     |
|            |                              |  |           | FSX ext    |            | 2P+7 |     |
|            | <sup>t</sup> en(FXH-DX)      | Enable time, FSX high to DX driven¶  Only applies to first bit transmitted when in Data Delay 0 (XDATDLY=00b) mode             | DXENA = 0 | FSX int    | 0          |      | ns  |
|            |                              |  |           | FSX ext    | 6          |      |     |
| M10        |                              |  | DXENA = 1 | FSX int    | 2P         |      |     |
|            |                              |  |           | FSX ext    | P+6        |      |     |

<sup>†</sup> Polarity bits CLKRP = CLKXP = FSRP = FSXP = 0. If the polarity of any of the signals is inverted, then the timing references of that signal are also inverted.

<sup>‡</sup> P = (Divider2 Ratio)/(CPU Clock Frequency) in ns. For example, when running parts at 300 MHz with the slow peripheral domain at 1/2 the CPU clock frequency, use P = 2/300 MHz = 6.66 ns.

<sup>§</sup> T=CLKRX period = (1 + CLKGDV) \* P

C=CLKRX low pulse width = T/2 when CLKGDV is odd or zero and = (CLKGDV/2) \* P when CLKGDV is even

D=CLKRX high pulse width = T/2 when CLKGDV is odd or zero and = (CLKGDV/2 + 1) \* P when CLKGDV is even

<sup>¶</sup> See the *TMS320C55x DSP Peripherals Reference Guide* (literature number SPRU317) for a description of the DX enable (DXENA) and data delay features of the McBSP.

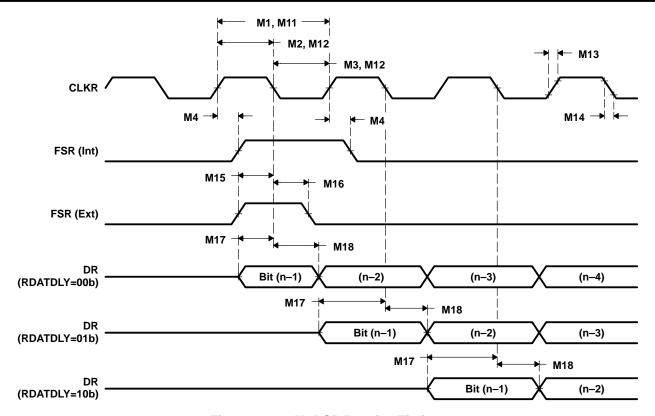
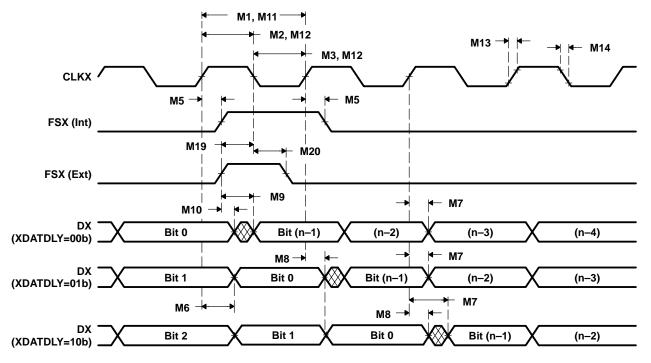


Figure 6-28. McBSP Receive Timings



NOTE A: This figure does not include first or last frames. For first frame, no data will be present before frame synchronization.

For last frame, no data will be present after frame synchronization.

Figure 6-29. McBSP Transmit Timings

## 6.16.2 McBSP General-Purpose I/O Timing

Table 6–28 and Table 6–29 assume testing over recommended operating conditions (see Figure 6–30).

Table 6-28. McBSP General-Purpose I/O Timing Requirements

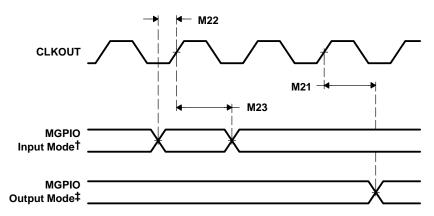
| NO. |                             |   | MIN | MAX | UNIT |
|-----|-----------------------------|---|-----|-----|------|
| M22 | t <sub>su</sub> (MGPIO-COH) | Setup time, MGPIOx input mode before CLKOUT high <sup>†</sup> | 4   |     | ns   |
| M23 | th(COH-MGPIO)               | Hold time, MGPIOx input mode after CLKOUT high†               | 0   |     | ns   |

<sup>†</sup> MGPIOx refers to CLKRx, FSRx, DRx, CLKXx, or FSXx when configured as a general-purpose input.

Table 6-29. McBSP General-Purpose I/O Switching Characteristics

| NO. | PARAMETER   | MIN | MAX | UNIT |
|-----|---|-----|-----|------|
| M21 | t <sub>d</sub> (COH-MGPIO) Delay time, CLKOUT high to MGPIOx output mode <sup>‡</sup> | 0   | 4   | ns   |

<sup>‡</sup> MGPIOx refers to CLKRx, FSRx, CLKXx, FSXx, or DXx when configured as a general-purpose output.



† MGPIOx refers to CLKRx, FSRx, DRx, CLKXx, or FSXx when configured as a general-purpose input. ‡ MGPIOx refers to CLKRx, FSRx, CLKXx, FSXx, or DXx when configured as a general-purpose output.

Figure 6-30. McBSP General-Purpose I/O Timings

## 6.16.3 McBSP as SPI Master or Slave Timing

Table 6–30 to Table 6–37 assume testing over recommended operating conditions (see Figure 6–31 through Figure 6–34).

Table 6-30. McBSP as SPI Master or Slave Timing Requirements (CLKSTP = 10b, CLKXP = 0)<sup>†‡</sup>

| NO  |                           |                                      | MASTER |     | SLA    | VE  |      |
|-----|---------------------------|--------------------------------------|--------|-----|--------|-----|------|
| NO. |                           |                                      | MIN    | MAX | MIN    | MAX | UNIT |
| M30 | t <sub>su(DRV-CKXL)</sub> | Setup time, DR valid before CLKX low | 3      |     | 2 – 6P |     | ns   |
| M31 | th(CKXL-DRV)              | Hold time, DR valid after CLKX low   | 1      |     | 6 + 6P |     | ns   |
| M32 | t <sub>su(FXL-CKXH)</sub> | Setup time, FSX low before CLKX high |        |     | 10     |     | ns   |
| M33 | t <sub>C</sub> (CKX)      | Cycle time, CLKX                     | 2P     |     | 16P    |     | ns   |

<sup>†</sup> For all SPI slave modes, CLKG is programmed as 1/2 of the CPU clock by setting CLKSM = CLKGDV = 1.

Table 6-31. McBSP as SPI Master or Slave Switching Characteristics (CLKSTP = 10b, CLKXP = 0)†\$

| NO. |                          | PARAMETER   |       | MASTER |        | SLAVE   |      |
|-----|--------------------------|---|-------|--------|--------|---------|------|
| NO. |                          | PARAMETER   | MIN   | MAX    | MIN    | MAX     | UNIT |
| M24 | td(CKXL-FXL)             | Delay time, CLKX low to FSX low¶                                      | T – 1 | T + 1  |        |         | ns   |
| M25 | td(FXL-CKXH)             | Delay time, FSX low to CLKX high#                                     | C – 1 | C + 1  |        |         | ns   |
| M26 | td(CKXH-DXV)             | Delay time, CLKX high to DX valid                                     | -2    | 2      | 3P + 4 | 5P+ 10  | ns   |
| M27 | tdis(CKXL-DXHZ)          | Disable time, DX high impedance following last data bit from CLKX low | C – 2 | C +10  |        |         | ns   |
| M28 | tdis(FXH-DXHZ)           | Disable time, DX high impedance following last data bit from FSX high |       |        | 2P+ 4  | 4P + 10 | ns   |
| M29 | t <sub>d</sub> (FXL-DXV) | Delay time, FSX low to DX valid                                       |       |        | 2P + 4 | 4P + 10 | ns   |

<sup>†</sup> For all SPI slave modes, CLKG is programmed as 1/2 of the CPU clock by setting CLKSM = CLKGDV = 1.

<sup>‡</sup> P = (Divider2 Ratio)/(CPU Clock Frequency) in ns. For example, when running parts at 300 MHz with the slow peripheral domain at 1/2 the CPU clock frequency, use P = 2/300 MHz = 6.66 ns.

<sup>‡</sup> P = (Divider2 Ratio)/(CPU Clock Frequency) in ns. For example, when running parts at 300 MHz with the slow peripheral domain at 1/2 the CPU clock frequency, use P = 2/300 MHz = 6.66 ns.

<sup>§</sup>T = BCLKX period = (1 + CLKGDV) \* 2P

C = BCLKX low pulse width = T/2 when CLKGDV is odd or zero and = (CLKGDV/2) \* 2P when CLKGDV is even

<sup>¶</sup> FSRP = FSXP = 1. As a SPI master, FSX is inverted to provide active-low slave-enable output. As a slave, the active-low signal input on FSX and FSR is inverted before being used internally.

CLKXM = FSXM = 1, CLKRM = FSRM = 0 for master McBSP

CLKXM = CLKRM = FSXM = FSRM = 0 for slave McBSP

<sup>#</sup>FSX should be low before the rising edge of clock to enable slave devices and then begin a SPI transfer at the rising edge of the master clock (CLKX).

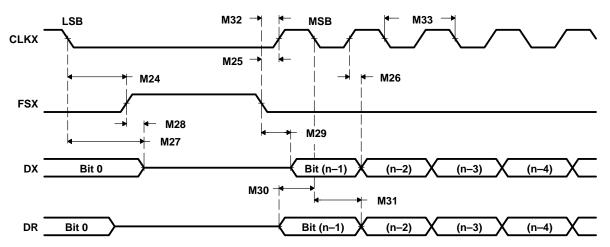


Figure 6-31. McBSP Timing as SPI Master or Slave: CLKSTP = 10b, CLKXP = 0

Table 6–32. McBSP as SPI Master or Slave Timing Requirements (CLKSTP = 11b, CLKXP = 0)†‡

| No  |                            |                                       | MAS | TER | SLA    | VE  |      |
|-----|----------------------------|---------------------------------------|-----|-----|--------|-----|------|
| NO. |                            |                                       | MIN | MAX | MIN    | MAX | UNIT |
| M39 | t <sub>su(DRV-CKXH)</sub>  | Setup time, DR valid before CLKX high | 3   |     | 2 – 6P |     | ns   |
| M40 | th(CKXH-DRV)               | Hold time, DR valid after CLKX high   | 1   |     | 6 +6P  |     | ns   |
| M41 | t <sub>su</sub> (FXL–CKXH) | Setup time, FSX low before CLKX high  |     |     | 10     |     | ns   |
| M42 | t <sub>C</sub> (CKX)       | Cycle time, CLKX                      | 2P  |     | 16P    |     | ns   |

<sup>†</sup> For all SPI slave modes, CLKG is programmed as 1/2 of the CPU clock by setting CLKSM = CLKGDV = 1.

Table 6-33. McBSP as SPI Master or Slave Switching Characteristics (CLKSTP = 11b, CLKXP = 0)<sup>†‡§</sup>

| No  | DADAMETER                |   | MASTER |       | SLA    |         |      |
|-----|--------------------------|---|--------|-------|--------|---------|------|
| NO. |                          | PARAMETER   |        | MAX   | MIN    | MAX     | UNIT |
| M34 | td(CKXL-FXL)             | Delay time, CLKX low to FSX low <sup>¶</sup>                          | C – 1  | C + 1 |        |         | ns   |
| M35 | td(FXL-CKXH)             | Delay time, FSX low to CLKX high#                                     | T – 1  | T + 1 |        |         | ns   |
| M36 | td(CKXH-DXV)             | Delay time, CLKX high to DX valid                                     | -2     | 2     | 3P + 4 | 5P + 10 | ns   |
| M37 | tdis(CKXL-DXHZ)          | Disable time, DX high impedance following last data bit from CLKX low | -2     | 10    | 3P + 4 | 5P + 10 | ns   |
| M38 | t <sub>d</sub> (FXL–DXV) | Delay time, FSX low to DX valid                                       | D-2    | D +10 | 2P – 4 | 4P + 10 | ns   |

<sup>†</sup> For all SPI slave modes, CLKG is programmed as 1/2 of the CPU clock by setting CLKSM = CLKGDV = 1.

- C = CLKX low pulse width = T/2 when CLKGDV is odd or zero and = (CLKGDV/2) \* P when CLKGDV is even
- D = CLKX high pulse width = T/2 when CLKGDV is odd or zero and = (CLKGDV/2 + 1) \* P when CLKGDV is even

- CLKXM = FSXM = 1, CLKRM = FSRM = 0 for master McBSP
- CLKXM = CLKRM = FSXM = FSRM = 0 for slave McBSP

<sup>#</sup>FSX should be low before the rising edge of clock to enable slave devices and then begin a SPI transfer at the rising edge of the master clock (CLKX).

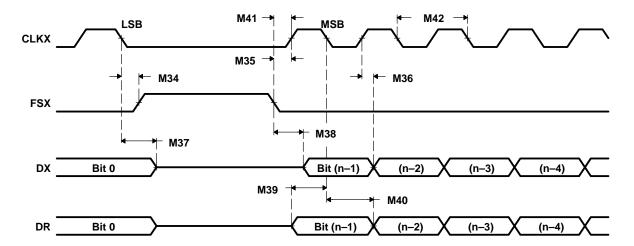


Figure 6-32. McBSP Timing as SPI Master or Slave: CLKSTP = 11b, CLKXP = 0

<sup>‡</sup> P = (Divider2 Ratio)/(CPU Clock Frequency) in ns. For example, when running parts at 300 MHz with the slow peripheral domain at 1/2 the CPU clock frequency, use P = 2/300 MHz = 6.66 ns.

<sup>‡</sup> P = (Divider2 Ratio)/(CPU Clock Frequency) in ns. For example, when running parts at 300 MHz with the slow peripheral domain at 1/2 the CPU clock frequency, use P = 2/300 MHz = 6.66 ns.

<sup>§</sup>T = CLKX period = (1 + CLKGDV) \* P

<sup>¶</sup> FSRP = FSXP = 1. As a SPI master, FSX is inverted to provide active-low slave-enable output. As a slave, the active-low signal input on FSX and FSR is inverted before being used internally.

136

Table 6-34. McBSP as SPI Master or Slave Timing Requirements (CLKSTP = 10b, CLKXP = 1)†‡

| NO  |                           |                                       | MASTER |     | SLA    |     |      |
|-----|---------------------------|---------------------------------------|--------|-----|--------|-----|------|
| NO. |                           |                                       | MIN    | MAX | MIN    | MAX | UNIT |
| M49 | tsu(DRV-CKXH)             | Setup time, DR valid before CLKX high | 3      |     | 2 – 2P |     | ns   |
| M50 | th(CKXH-DRV)              | Hold time, DR valid after CLKX high   | 1      |     | 6 + 6P |     | ns   |
| M51 | t <sub>su(FXL-CKXL)</sub> | Setup time, FSX low before CLKX low   |        |     | 10     |     | ns   |
| M52 | t <sub>C</sub> (CKX)      | Cycle time, CLKX                      | 2P     |     | 16P    |     | ns   |

<sup>†</sup> For all SPI slave modes, CLKG is programmed as 1/2 of the CPU clock by setting CLKSM = CLKGDV = 1.

Table 6-35. McBSP as SPI Master or Slave Switching Characteristics (CLKSTP = 10b, CLKXP = 1)<sup>†‡§</sup>

| NO  | DADAMETED       |  | MASTER |       | SLA    |         |      |
|-----|-----------------|--|--------|-------|--------|---------|------|
| NO. |                 | PARAMETER  | MIN    | MAX   | MIN    | MAX     | UNIT |
| M43 | td(CKXH-FXL)    | Delay time, CLKX high to FSX low¶                                      | T – 1  | T + 1 |        |         | ns   |
| M44 | td(FXL-CKXL)    | Delay time, FSX low to CLKX low#                                       | D – 1  | D + 1 |        |         | ns   |
| M45 | td(CKXL-DXV)    | Delay time, CLKX low to DX valid                                       | -2     | 2     | 3P + 4 | 5P + 10 | ns   |
| M46 | tdis(CKXH-DXHZ) | Disable time, DX high impedance following last data bit from CLKX high | D – 2  | D +10 |        |         | ns   |
| M47 | tdis(FXH-DXHZ)  | Disable time, DX high impedance following last data bit from FSX high  |        |       | 2P + 4 | 4P + 10 | ns   |
| M48 | td(FXL-DXV)     | Delay time, FSX low to DX valid  |        |       | 2P – 4 | 4P + 10 | ns   |

<sup>†</sup> For all SPI slave modes, CLKG is programmed as 1/2 of the CPU clock by setting CLKSM = CLKGDV = 1.

<sup>#</sup>FSX should be low before the rising edge of clock to enable slave devices and then begin a SPI transfer at the rising edge of the master clock (CLKX).

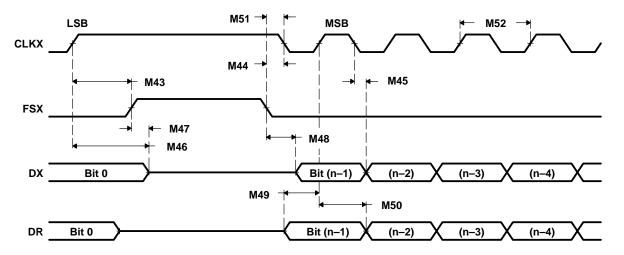


Figure 6-33. McBSP Timing as SPI Master or Slave: CLKSTP = 10b, CLKXP = 1

<sup>&</sup>lt;sup>‡</sup> P = (Divider2 Ratio)/(CPU Clock Frequency) in ns. For example, when running parts at 300 MHz with the slow peripheral domain at 1/2 the CPU clock frequency, use P = 2/300 MHz = 6.66 ns.

<sup>‡</sup> P = (Divider2 Ratio)/(CPU Clock Frequency) in ns. For example, when running parts at 300 MHz with the slow peripheral domain at 1/2 the CPU clock frequency, use P = 2/300 MHz = 6.66 ns.

<sup>§</sup>T = CLKX period = (1 + CLKGDV) \* P

D = CLKX high pulse width = T/2 when CLKGDV is odd or zero and = (CLKGDV/2 + 1) \* P when CLKGDV is even

<sup>¶</sup> FSRP = FSXP = 1. As a SPI master, FSX is inverted to provide active-low slave-enable output. As a slave, the active-low signal input on FSX and FSR is inverted before being used internally.

CLKXM = FSXM = 1, CLKRM = FSRM = 0 for master McBSP

CLKXM = CLKRM = FSXM = FSRM = 0 for slave McBSP

Table 6–36. McBSP as SPI Master or Slave Timing Requirements (CLKSTP = 11b, CLKXP = 1)†‡

| No  |                           |                                      | MASTER |     | SLA    |     |      |
|-----|---------------------------|--------------------------------------|--------|-----|--------|-----|------|
| NO. |                           |                                      | MIN    | MAX | MIN    | MAX | UNIT |
| M58 | t <sub>su(DRV-CKXL)</sub> | Setup time, DR valid before CLKX low | 3      |     | 2 – 6P |     | ns   |
| M59 | th(CKXL-DRV)              | Hold time, DR valid after CLKX low   | 1      |     | 6 + 6P |     | ns   |
| M60 | t <sub>su(FXL-CKXL)</sub> | Setup time, FSX low before CLKX low  |        |     | 10     |     | ns   |
| M61 | t <sub>C</sub> (CKX)      | Cycle time, CLKX                     | 2P     |     | 16P    |     | ns   |

<sup>†</sup> For all SPI slave modes, CLKG is programmed as 1/2 of the CPU clock by setting CLKSM = CLKGDV = 1.

Table 6-37. McBSP as SPI Master or Slave Switching Characteristics (CLKSTP = 11b, CLKXP = 1)<sup>†‡§</sup>

|     | DADAMETER                |  | MASTER |       | SLA    |         |      |
|-----|--------------------------|--|--------|-------|--------|---------|------|
| NO. |                          | PARAMETER  |        | MAX   | MIN    | MAX     | UNIT |
| M53 | td(CKXH-FXL)             | Delay time, CLKX high to FSX low <sup>¶</sup>                          | D – 1  | D + 1 |        |         | ns   |
| M54 | td(FXL-CKXL)             | Delay time, FSX low to CLKX low#                                       | T – 1  | T + 1 |        |         | ns   |
| M55 | td(CKXH-DXV)             | Delay time, CLKX high to DX valid                                      | -2     | 2     | 3P + 4 | 5P + 10 | ns   |
| M56 | tdis(CKXH-DXHZ)          | Disable time, DX high impedance following last data bit from CLKX high | -2     | 10    | 3P + 4 | 5P + 10 | ns   |
| M57 | t <sub>d</sub> (FXL–DXV) | Delay time, FSX low to DX valid  | C – 2  | C +10 | 2P – 4 | 4P + 10 | ns   |

<sup>†</sup> For all SPI slave modes, CLKG is programmed as 1/2 of the CPU clock by setting CLKSM = CLKGDV = 1.

- C = CLKX low pulse width = T/2 when CLKGDV is odd or zero and = (CLKGDV/2) \* P when CLKGDV is even
- D = CLKX high pulse width = T/2 when CLKGDV is odd or zero and = (CLKGDV/2 + 1) \* P when CLKGDV is even

- CLKXM = FSXM = 1, CLKRM = FSRM = 0 for master McBSP
- CLKXM = CLKRM = FSXM = FSRM = 0 for slave McBSP

<sup>#</sup>FSX should be low before the rising edge of clock to enable slave devices and then begin a SPI transfer at the rising edge of the master clock (CLKX).

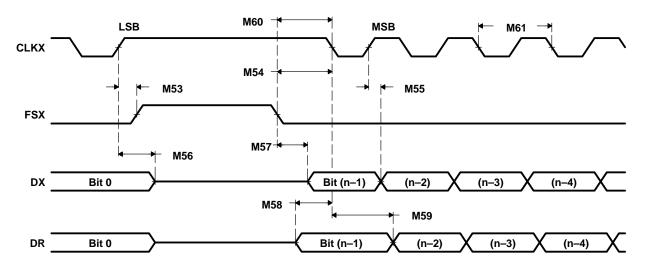


Figure 6-34. McBSP Timing as SPI Master or Slave: CLKSTP = 11b, CLKXP = 1

<sup>‡</sup> P = (Divider2 Ratio)/(CPU Clock Frequency) in ns. For example, when running parts at 300 MHz with the slow peripheral domain at 1/2 the CPU clock frequency, use P = 2/300 MHz = 6.66 ns.

<sup>‡</sup> P = (Divider2 Ratio)/(CPU Clock Frequency) in ns. For example, when running parts at 300 MHz with the slow peripheral domain at 1/2 the CPU clock frequency, use P = 2/300 MHz = 6.66 ns.

<sup>§</sup>T = CLKX period = (1 + CLKGDV) \* P

<sup>¶</sup> FSRP = FSXP = 1. As a SPI master, FSX is inverted to provide active-low slave-enable output. As a slave, the active-low signal input on FSX and FSR is inverted before being used internally.

### 6.17 HPI Timings

Table 6–38 and Table 6–39 assume testing over recommended operating conditions (see Figure 6–35 through Figure 6–39).

Table 6-38. HPI Timing Requirements†‡

| NO. |                            |   | MIN | MAX | UNIT |
|-----|----------------------------|---|-----|-----|------|
| Н9  | tsu(HASL-HDSL)             | Setup time, HAS low before DS falling edge    | 5   |     | ns   |
| H10 | th(HDSL-HASL)              | Hold time, HAS low after DS falling edge      | 2   |     | ns   |
| H11 | t <sub>su(HBV-HASL)</sub>  | Setup time, HAD valid before HAS falling edge | 5   |     | ns   |
| H12 | th(HASL-HBV)               | Hold time, HAD valid after HAS falling edge   | 5   |     | ns   |
| H13 | tw(HDSL)                   | Pulse duration, DS low                        | 10  |     | ns   |
| H14 | tw(HDSH)                   | Pulse duration, DS high                       | 2P  |     | ns   |
| H15 | tsu(HBV-HDSL)              | Setup time, HAD valid before DS falling edge  | 5   |     | ns   |
| H16 | th(HDSL-HBV)               | Hold time, HAD valid after DS falling edge    | 5   |     | ns   |
| H17 | t <sub>su(HDV-HDSH)W</sub> | Setup time, HD valid before DS rising edge    | 10  |     | ns   |
| H18 | th(HDSH-HDV)W              | Hold time, HD valid after DS rising edge      | 0   |     | ns   |

<sup>†</sup> P = (Divider1 Ratio)/(CPU Clock Frequency) in ns. For example, when running parts at 300 MHz with the fast peripheral domain at 1/2 the CPU clock frequency, use P = 2/300 MHz = 6.66 ns.

#### Table 6-39. HPI Switching Characteristics‡§

| NO. |                            | PARAMETE                                     | R  | MIN | MAX     | UNIT |
|-----|----------------------------|--|--|-----|---------|------|
|     |                            |  | Case 1. Read Data present in FIFO.                           | 3   | 20      | ns   |
| H1  | <sup>t</sup> d(HDSL-HDV)   | Delay time, DS low to HD valid               | Case 2. FIFO is Empty; No other DMA/MEM activity is present. |     | n*2H+20 | ns   |
|     |                            |  | Case 3. HPIC or Unobstructed HPIA Read.                      | 3   | 20      | ns   |
| H2  | td(HDSH-HDV)R              | Delay time, DS rising edge to HD valid, read |  |     | 10      | ns   |
| Н3  | td(HDSL-HDD)               | Delay time, DS low to HD driven              |  |     | 20      | ns   |
| H4  | td(HDSL-HRDYL)             | Delay time, DS low to HRDY low               | ı  |     | 12      | ns   |
| H5  | td(HDSH-HRDYL)             | Delay time, DS high to HRDY lo               | w  |     | 12      | ns   |
|     |                            | Delay time, DS high to HRDY                  | Case 1. FIFO is Empty; No other DMA/MEM activity present.    |     | n*2H+20 | ns   |
| H6  | <sup>t</sup> d(HDSH–HRDYH) | high   | Case 2. FIFO is Full; No other DMA/MEM activity is present.  |     | n*2H+20 | ns   |
| H7  | t <sub>V</sub> (HRDYH–HDV) | Valid time, HD valid after HRDY              | high   |     | 7       | ns   |
| Н8  | td(COH-HINT)               | Delay time, CLKOUT rising edge               | e to HINT change   |     | 3       | ns   |

<sup>&</sup>lt;sup>‡</sup> DS refers to logical OR of HCS, HDS1, and HDS2. HD refers to HPI Data Bus. HDS refers to HDS1 or HDS2. HAD refers to HCNTL0, HCNTL1, and HR/W.

DS refers to logical OR of HCS, HDS1, and HDS2. HD refers to HPI Data Bus. HDS refers to HDS1 or HDS2. HAD refers to HCNTL0, HCNTL1, and HR/W.

<sup>§</sup> H is half the CPU clock cycle.

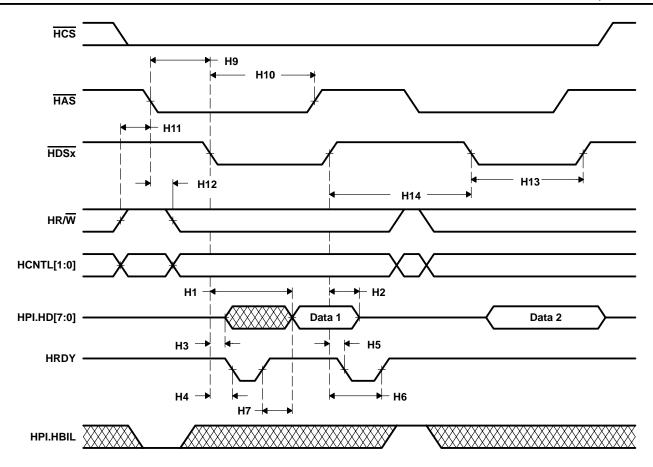


Figure 6–35. Multiplexed Read Timings Using HAS

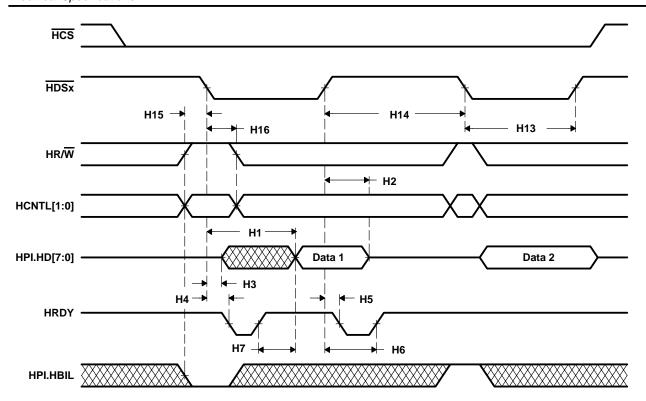


Figure 6–36. Multiplexed Read Timings With HAS Held High

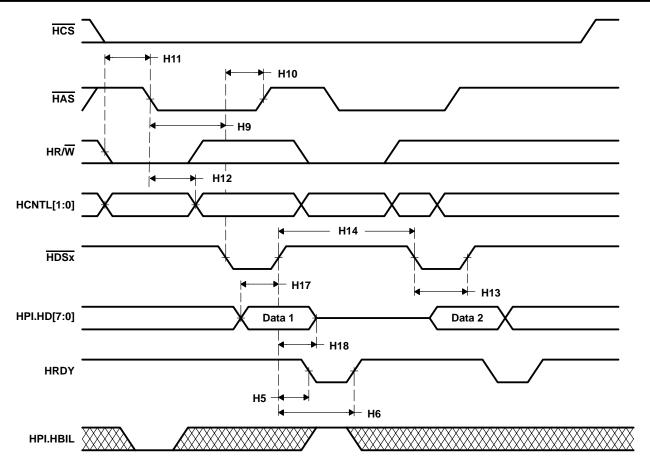


Figure 6–37. Multiplexed Write Timings Using HAS

142

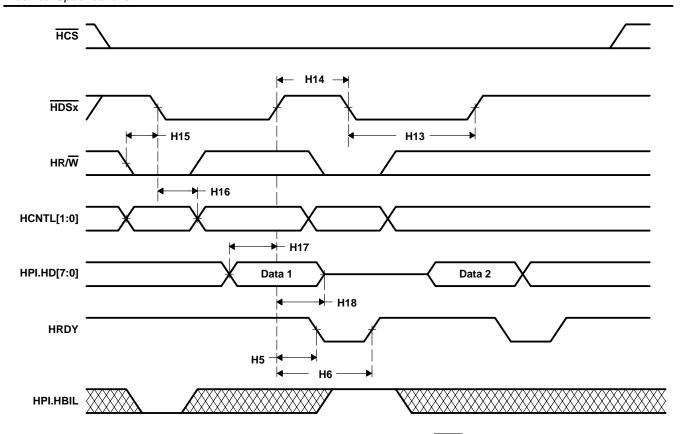


Figure 6–38. Multiplexed Write Timings With HAS Held High

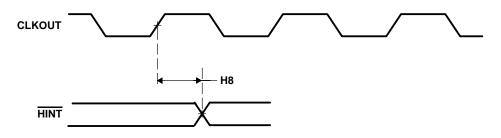


Figure 6–39. HINT Timing

# 6.18 I<sup>2</sup>C Timing

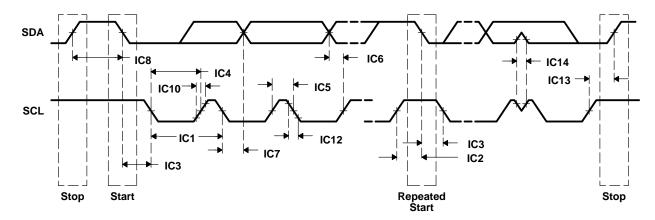
Table 6-40 assumes testing over recommended operating conditions (see Figure 6-40).

Table 6-40. I<sup>2</sup>C Signals (SDA and SCL) Switching Characteristics

| NO.  |                            | PARAMETER  |                                       | STAN |      | FAS<br>MOD | -   | UNIT |
|------|----------------------------|--|---------------------------------------|------|------|------------|-----|------|
|      |                            |  |                                       | MIN  | MAX  | MIN        | MAX |      |
| IC1  | t <sub>c(SCL)</sub>        | Cycle time, SCL  |                                       | 10   |      | 2.5        |     | μs   |
| IC2  | t <sub>su(SCLH-SDAL)</sub> | Setup time, SCL high before SDA low for a START and a repeated START condition |                                       |      |      | 0.6        |     | μs   |
| IC3  | <sup>t</sup> h(SCLL-SDAL)  | Hold time, SCL low after SDA low for a START and a repeated START condition    |                                       |      |      | 0.6        |     | μs   |
| IC4  | tw(SCLL)                   | ulse duration, SCL low   |                                       |      |      | 1.3        |     | μs   |
| IC5  | tw(SCLH)                   | Pulse duration, SCL high   |                                       |      |      | 0.6        |     | μs   |
| IC6  | tsu(SDA-SCLH)              | Setup time, SDA valid before S0  | Setup time, SDA valid before SCL high |      |      | 100        |     | ns   |
| 107  |                            | Hold time, SDA valid after SCL   | For CBUS compatible masters           | 5    |      |            |     |      |
| IC7  | th(SDA-SCLL)               | low  | For I <sup>2</sup> C bus devices      | 0    |      | 0          | 0.9 | μs   |
| IC8  | tw(SDAH)                   | Pulse duration, SDA high between   | en STOP and START conditions          | 4.7  |      | 1.3        |     | μs   |
| IC9  | tr(SDA)                    | Rise time, SDA   |                                       |      | 1000 |            | 300 |      |
| IC10 | tr(SCL)                    | Rise time, SCL   |                                       |      | 1000 |            | 300 | ns   |
| IC11 | tf(SDA)                    | Fall time, SDA   |                                       |      | 300  |            | 300 |      |
| IC12 | tf(SCL)                    | Fall time, SCL   |                                       |      | 300  |            | 300 | ns   |
| IC13 | tsu(SCLH-SDAH)             | Setup time, SCL high before SD   | 4.0                                   |      | 0.6  |            | μs  |      |
| IC14 | tw(SP)                     | Pulse duration, spike (must be s   | suppressed)                           |      |      | 0          | 50  | μs   |
| IC15 | C <sub>b</sub> ‡           | Capacitive load for each bus line  | e                                     |      | 400  | _          | 400 | pF   |

<sup>†</sup> The maximum th(SCLL-SDAL) has only to be met if the device does not stretch the low period (tw(SCLL)) of the SCL signal.

 $<sup>^{\</sup>ddagger}$ C<sub>b</sub> = The total capacitance of one bus line in pF.



- NOTES: A. A device must internally provide a hold time of at least 300 ns for the SDA signal (referred to the V<sub>IHmin</sub> of the SCL signal) to bridge the undefined region of the falling edge of SCL.
  - B. The maximum  $t_{h(SCLL-SDAL)}$  has only to be met if the device does not stretch the LOW period  $[t_{W(SCLL)}]$  of the SCL signal.
  - C. A Fast-mode I<sup>2</sup>C-bus device can be used in a Standard-mode I<sup>2</sup>C-bus system, but the requirement t<sub>su(SDA-SCLH)</sub> 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line t<sub>r</sub> max + t<sub>su(SDA-SCLH)</sub> = 1000 + 250 = 1250 ns (according to the Standard-mode I<sup>2</sup>C-bus specification) before the SCL line is released.
  - D. Ch = total capacitance of one bus line in pF. If mixed with HS-mode devices, faster fall-times are allowed.

Figure 6–40. I<sup>2</sup>C Timings



# 6.19 UART Timing

Table 6–41 to Table 6–42 assume testing over recommended operating conditions (see Figure 6–41).

Table 6-41. UART Timing Requirements

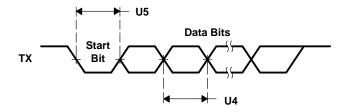
| NO. |          |                                | MIN                | MAX                | UNIT |
|-----|----------|--------------------------------|--------------------|--------------------|------|
| U1  | tw(UDB)R | Pulse width, receive data bit  | 0.99U <sup>†</sup> | 1.01U <sup>†</sup> | ns   |
| U2  | tw(USB)R | Pulse width, receive start bit | 0.99U†             | 1.01U†             | ns   |

tu = UART baud time = 1/programmed baud rate

### Table 6-42. UART Switching Characteristics

| NO. | PARAMETER   | MIN MAX                               | UNIT |
|-----|---|---------------------------------------|------|
| U3  | f <sub>baud</sub> Maximum programmable baud rate      | 5                                     | MHz  |
| U4  | t <sub>W</sub> (UDB)X Pulse width, transmit data bit  | U – 2 <sup>†</sup> U + 2 <sup>†</sup> | ns   |
| U5  | t <sub>W</sub> (USB)X Pulse width, transmit start bit | U – 2 <sup>†</sup> U + 2 <sup>†</sup> | ns   |

†U = UART baud time = 1/programmed baud rate



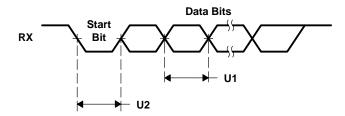


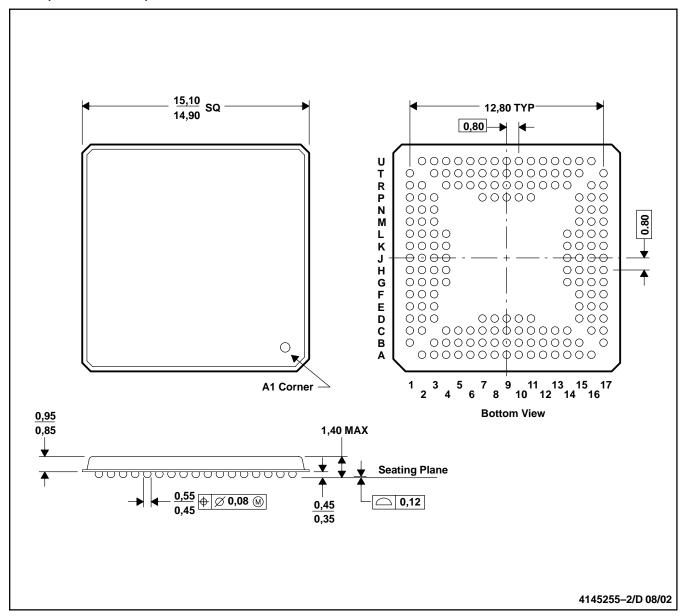
Figure 6-41. UART Timings

### 7 Mechanical Data

## 7.1 Ball Grid Array Mechanical Data

#### GGW (S-PBGA-N176)

#### PLASTIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice
- C. MicroStar BGA™ configuration.

Figure 7–1. TMS320VC5501 176-Ball MicroStar BGA™ Plastic Ball Grid Array Package

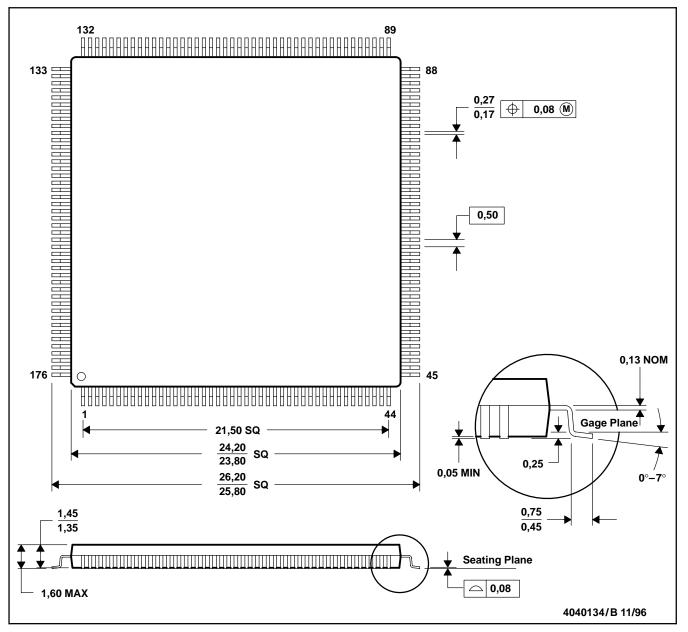
MicroStar BGA is a trademark of Texas Instruments.

December 2002

# 7.2 Low-Profile Quad Flatpack Mechanical Data

### PGF (S-PQFP-G176)

#### PLASTIC QUAD FLATPACK



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-026

Figure 7-2. TMS320VC5501 176-Pin Low-Profile Quad Flatpack